# Toshiba Personal Computer Qosmio X500 Maintenance Manual

# **TOSHIBA CORPORATION**

File Number 960-Q08

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Toshiba Personal Computer Qosmio X500 Maintenance Manual

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The information presented in this manual has been reviewed and validated for accuracy. The included set of instructions and descriptions are accurate for the Qosmio X500 series at the time of this manual's production. However, succeeding computers and manuals are subject to change without notice. Therefore, Toshiba assumes no liability for damages incurred directly or indirectly from errors, omissions, or discrepancies between any succeeding product and this manual.

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## **Preface**

This maintenance manual describes how to perform hardware service maintenance for the Toshiba Personal Computer Qosmio X500 Series.

The procedures described in this manual are intended to help service technicians isolate faulty Field Replaceable Units (FRUs) and replace them in the field.

# **SAFETY PRECAUTIONS**

Four types of messages are used in this manual to bring important information to your attention. Each of these messages will be italicized and identified as shown below.

**DANGER:** "Danger" indicates the existence of a hazard that could result in death or serious bodily injury, if the safety instruction is not observed.

**WARNING:** "Warning" indicates the existence of a hazard that could result in bodily injury, if the safety instruction is not observed.

**CAUTION:** "Caution" indicates the existence of a hazard that could result in property damage, if the safety instruction is not observed.

**NOTE:** "Note" contains general information that relates to your safe maintenance service.

Improper repair of the computer may result in safety hazards. To shib a requires service technicians and authorized dealers or service providers to ensure the following safety precautions are adhered to strictly.

- ☐ Be sure to fasten screws securely with the right screwdriver. If a screw is not fully fastened, it could come loose, creating a danger of a short circuit, which could cause overheating, smoke or fire.
- ☐ If you replace the battery pack or RTC battery, be sure to use only the same model battery or an equivalent battery recommended by Toshiba. Installation of the wrong battery can cause the battery to explode.

The manual is divided into the following parts:

Chapter 1	Hardware Overview describes the Qosmio X500 system unit and each FRU.
Chapter 2	Troubleshooting Procedures explains how to diagnose and resolve FRU problems.
Chapter 3	Test and Diagnostics describes how to perform test and diagnostic operations for maintenance service.
Chapter 4	Replacement Procedures describes the removal and replacement of the FRUs.
Appendices	The appendices describe the following:
	<ul> <li>□ Handling the LCD Module</li> <li>□ Board layout</li> <li>□ Pin assignments</li> <li>□ Keyboard scan/character codes</li> <li>□ Key layout</li> <li>□ Wiring diagrams</li> </ul>

### Conventions

This manual uses the following formats to describe, identify, and highlight terms and operating procedures.

### **Acronyms**

On the first appearance and whenever necessary for clarification acronyms are enclosed in parentheses following their definition. For example:

Read Only Memory (ROM)

### Keys

Keys are used in the text to describe many operations. The key top symbol as it appears on the keyboard is printed in **boldface** type.

# Key operation

Some operations require you to simultaneously use two or more keys. We identify such operations by the key top symbols separated by a plus (+) sign. For example, **Ctrl + Pause** (**Break**) means you must hold down **Ctrl** and at the same time press **Pause** (**Break**). If three keys are used, hold down the first two and at the same time press the third.

### User input

Text that you are instructed to type in is shown in the boldface type below:

### **DISK COPY A: B:**

# The display

Text generated by the computer that appears on its display is presented in the typeface below:

Format complete
System transferred

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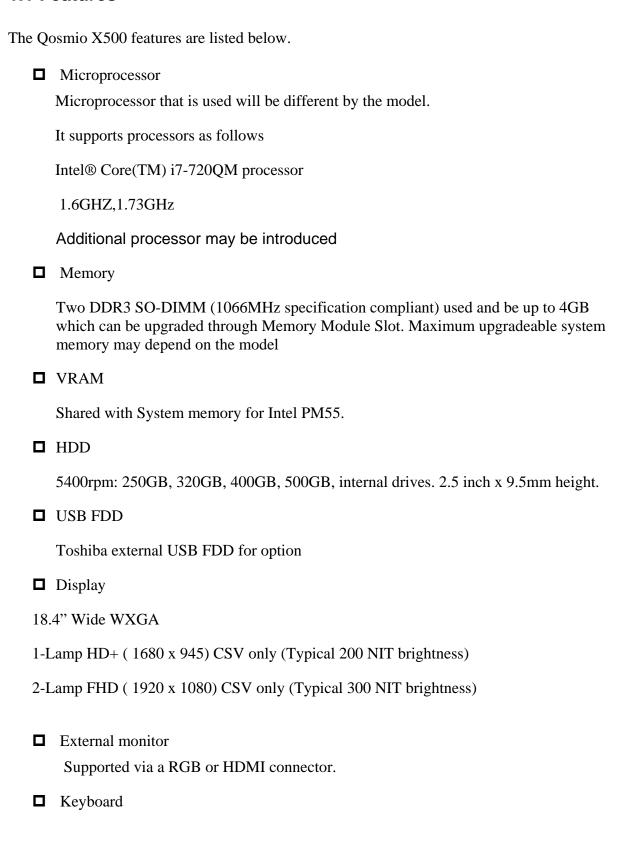
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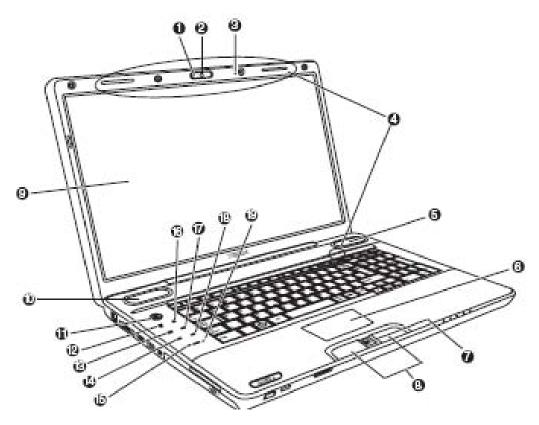
Features

# 1.1 Features



Keyboard module has 104/105/109 keys. It supports Windows keys and application keys.
New Dummy card slot
The new card slot (dummy card) accommodates express card.
Optical devices
A DVD Super Multi drive is equipped.
Battery
The RTC battery is equipped inside the computer. The main battery is a detachable lithium ion battery.
12 cell Li-Ion 10.8v
USB (Universal Serial Bus)
4 USB ports are provided. The ports comply with the USB2.0 standard, USB Sleep and Charge function can be supported by only one port of the left side.(mode 1-4)  If USB Sleep and Charge function is enabled, the computer's battery will discharge during hibernation or when the computer is turned off. It is recommended that user connect the AC adaptor to the computer when enabling the USB Sleep and Charge function.ESATA
One ESATA port is equipped.
Sound system
Internal stereo speaker, Internal MIC external monaural microphone connector, stereo headphone connector.
Wireless LAN
Some computers in this series are equipped with a Wireless LAN card.
LAN/MODEM
Connectors for LAN and Modem are separately mounted.
1394
One 1394 port is equipped.

Bridge media slot
XD/MS/MS pro/SD/MMC are supported
Bluetooth
Some computers in this series offer Bluetooth wireless communication functionality. This module is Version 2.1+EDR.
Security
Kensington Lock,
Fingerprint –Enhanced Lock is also equipped.
HDD password
HDD security function



- 1. Web Camera LED\*
- 3. Built-in microphone\*
- 5. Speaker
- 7. Fingerprint Sensor\*
- 9. Display Screen
- 11. Power Button\*
- 13. CD/ DVD Button\*
- 15. Volume Down Button\*
- 17. Play/Pause Button\*

- 2. Web Camera\*
- 4. Wireless LAN/Wireless WAN Antennas (Not shown)
- 6. Touch Pad
- 8. Touch Pad Control Buttons
- 10. Speaker
- 12. Internet Button\*
- 14. Previous Button\*
- 16. Mute Button\*
- 18. Next Button\* 19. Volume Up Button\*

Figure 1-1-1 Front of the computer

# 1.2 System Block Diagram

Figure 1-2-1 shows the system block diagram.

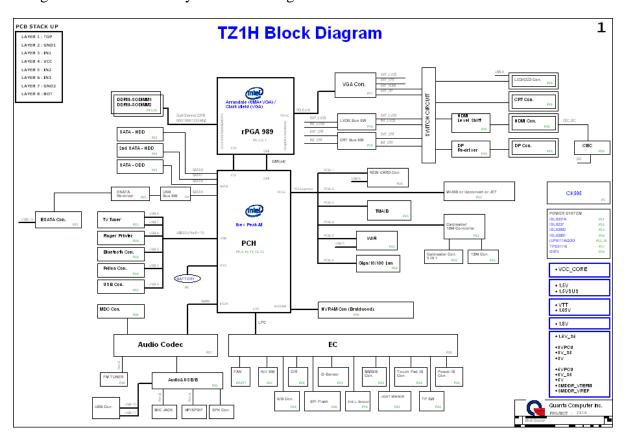


Figure 1-2-1 System block diagram for Intel Platform

The PC contains the following components.

### **CPU**

Intel® Core(TM) i7-720QM processor

1.6GHz, 1.73GHz

Memory

DDR3-1066MHz 1GB, 2GB or 4GB memory modules

- 200-pin SO-DIMM
- 1.8V operation

BIOS ROM (Flash memory)

• 16Mbit

### Chipset

- North Bridge
- Penryn processor System Bus support
  - DRAM Controller : DDR3 1066MHz support
  - DMI
  - 1299-ball 35 x 35mm Mirco FC-BGA Package
- South Bridge
  - Direct Media Interface (DMI)
  - PCI Express
  - Serial ATA Controller
  - PCI Interface
  - Low Pin count (LPC) interface
  - Serial Peripheral Interface (SPI)
  - DMA controller
  - Advanced Programmable Interrupt Controller (APIC)
  - USB Controllers
  - Gigabit Ethernet Controller
  - RTC
  - GPIO
  - Enhanced Power Management
  - SMBus 2.0
  - High Definition Audio Controller
  - 676-pin 31mmx31mm mBGA Package

# Other main system chips

- Clock Generator
- EC/KBC –[W/CIR(Winbond WPCE775CA0DG)] –[WO/CIR(Winbond WPCE775LA0DG)]
- HD Audio (CONEXANT CX20583-10Z)
- Card Reader controller (O2 OZ888GS0LN)
- 10/100 LAN controller (Atheros AR8132M)
- Giga LAN controller (Atheros AR8131M)

### Mini Card

Wireless LAN (BTO)

DSSS/OFDM LAN card is equipped. Conformity with IEEE 802.11b/g, IEEE 802.11 a/g/n or IEEE 802.11a/b/g..

MODEM (Conexant x 1)

Supported by on board Modem + DAA daughter card.

Data and FAX transmission is available.

Supports ITU-TV.92.

The transfer speed of data receiving is 56kbps, of data sending is 33.6kbps and of FAX is 14.4kbps. Actual speed depends on the quality of the line used.

Connected to telephone line through RJ11 MOD

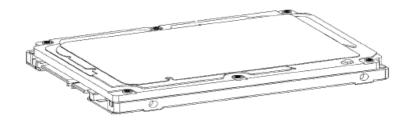
Bluetooth

Bluetooth V2.1+EDR. (BTO)

# 1.3 2.5-inch Hard Disk Drive

A compact, high-capacity HDD with a height of 9.5mm. Contains a 2.5-inch magnetic disk and magnetic heads.

Figure 1-3-1 shows a view of the 2.5-inch HDD and Tables 1-3-2 and 1-3-3 list the specifications.



*Figure 1-3-1 2.5-inch HDD* 

Table 1-3-2 2.5-inch HDD dimensions

			Standard value						
Parameter		TOSHIBA MK1655G SX	TOSHIBA MK2555G SX	TOSHIBA MK3255G X	-	TOSHIBA MK4055G SX	TOSHIBA MK3263G SX	TOSHIB A MK5055 GSX	
	Width (mm)	69.85 +/- 0.25							
Outline	Height (mm)	9.5							
dimens	Depth (mm)		100.2 +/- 0.25						
ions	Weight (g)	97/98	101						

Parameter		Standard value					
		FUJITSU MJA2160B H	FUJITSU MJA2250BH	FUJITSU MJA2320B H	FUJITSU MJA240 0BH	FUJITSU MJA2500BH	
Outline	Width (mm)			100			
dimensi ons	Height (mm)	9.5					
	Depth (mm)	70					
	Weight (g)	101(Max)					

Parai	neter	Standard value						
		HITACHI	HITACHI	HITACHI	HITACHI	HITACHI		
		HTS545016B9A 300	HTS545025B9 A300	HTS54503 B9A300	2 HTS545040 B9A300	HTS545050B9A 300		
	Width (mm)	69.85 +/- 0.25						
Outlin e	Height (mm)	9.5						
dimen sions	Depth (mm)		25					
	Weight (g)	95 (max.)	95 (max.)	) 10	02 (max.)	102 (max.)		

Table 1-3-3 2.5-inch HDD specifications

	Specification					
Parameter	TOSHIBA MK1655GSX	TOSHIBA MK2555GS X	TOSHIBA MK3255G SX	TOSHIBA MK4055G SX	TOSHIBA MK5055G SX	
Storage size (formatted)	160GB	250GB	320GB	400 GB	500GB	
Speed (RPM)	5,400					
Data transfer Rate - To/From Media - T0/From Host	363~952 typical 3Gbps (150MB/s)					
bus transfer rate (MB/s)	3Gbps(150MB/s)					
Average random seek time (read) (ms)	12					
Power-on-to-ready (sec)		3.5(ty	p)/9.5(Max)			

	Specification						
Parameter	FUJITSU MJA2160BH	FUJITSU MJA2250BH	FUJITSU MJA2320BH	FUJITSU MJA2400BH	FUJITSU MJA2500BH		
Storage size (formatted)	160GB	250GB	320GB	400GB	500GB		
Speed (RPM)			5,400				
Data transfer Rate - To/From Media - T0/From Host	363~952 typical 3Gbps (150MB/s)						
bus transfer rate (MB/s)			3Gbps(150MB/s)				
Average random seek time (read) (ms)	12.0ms/14.0ms						
Power-on-to-ready (sec)			4.0(typ9.5(Max)				

		Specification			
Parameter	HITACHI	HITACHI	HITACHI	HITACHI	HITACHI
	HTS545016B 9A300	HTS545025B9 A300	HTS545032 B9A300	HTS545040 B9A300	HTS545050B9A 300
Storage size (formatted)	160GB	250GB	320GB	400GB	500GB
Speed (RPM)			5,400		
Data transfer Rate - To/From Media - T0/From Host	875MB/s Max. 3Gbps				
bus transfer rate (MB/s)	875MB/s Max. 3Gbps				
Average random seek time (read) (ms)	11				
Power-on-to-ready (sec)	3.5 sec				

# 1.4 Optical Drive (HD DVD-ROM & CD-R/RW Drive)

The DVD Super Multi drive accommodates either 12 cm (4.72-inch) or 8 cm (3.15-inch) CD/DVD-ROM, CD-R/RW, DVD±R/±RW and DVD-RAM. It is a high-performance drive that reads DVD-ROM at maximum 8-speed and CD at maximum 24-speed. Write speed of DVD±R/±RW and DVD-RAM is different depending on the drive.

The DVD Super Multi drive is shown in Figure 1-4-1. The dimensions and specifications of the DVD Super Multi drive are described in Table 1-4-2, Table 1-4-3, Table 1-4-4, Table 1-4-5.

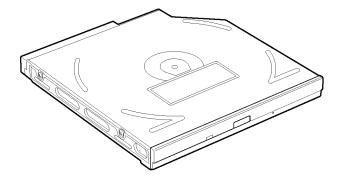


Figure 1-4-1 DVD Super Multi drive

Table 1-4-2 DVD Super Multi drive outline dimensions

Parameter		Standard value			
	Maker	HLDS (GT20N-ATAK7N7 )	HLDS (GT20F-ATAK7N7)		
Outline	Width (mm)	128			
dimensions	Height (mm)	12.7			
	Depth (mm)	127			
	Mass (g)	168			

Parameter		Standard value				
	Maker	Panasonic (UJ240/J890ADTJR-A)	Panasonic (UJ141/UJ890EDTJR-A)			
Outline	Width (mm)	128				
dimensions	Height (mm)	12.7				
	Depth (mm)	129				
	Mass (g)	185				

Para	ameter	Standar	d value			
	Maker	TSST (TS-L633C)	TSST (TS-L633Y)			
Outline	Width (mm)	128				
dimensions	Height (mm)	12.7				
	Depth (mm)	127				
	Mass (g)	165				

Table 1-4-3 HLDS DVD Super Multi drive specifications

Parameter		HLDS Drive Sp	ecification	
Parame	itei	GT20N-ATAK7N7	GT20F-ATAK7N7	
Label Flash Function		No support	Support	
	Read	DVD+R(SL/DL)       8x/4         DVD-RW       8x m         DVD+RW       8x m         DVD-RAM (Ver.1.0)       2x         (Ver.2.2)       2x, 3         DVD-Video       4x max	x max. x max. nax. nax. Sx, 5x . (Single/Dual layer)	
Data transfer speed	Write	(16x Media: No DVD+R 2.4x CLV, 4x Z DVD+R DL 2.4x CLV, 4x Z DVD+RW .4x, 3.3x CLV,	ELV s, 6x ZCLV 5x PCAV(Ver.2.2) ot support) ZCLV, 8x CAV ZCLV 4x ZCLV, 8x ZCLV o: 3.3x CLV, 8x ZCLV)	
	Burst Transfer mode	PIO mode4/Multi word mod	de2/Ultra DMA mode2	
Access time	CD-ROM	130ms (T	¬yp.)	
(ms) (Random)	DVD-ROM	135ms (T	¬yp.)	
Buffer me	mory	2MB		

Table 1-4-4 Panasonic DVD Super Multi drive specifications

Parar	mata#	Panasonic Driv	e Specification		
Parai	neter	UJ240/UJ890ADTJR-A	UJ141/UJ890EDTJR-A		
Label Flasi	h Function	No support	Support		
	Read	DVD-ROM :Max 8X CAV CD-ROM :Max 24X CAV			
Data transfer speed	Write	CD-R:Max24X CAV CD-RW:4X CLV High Speed CD-RW:10XCLV Ultra Speed CD-RW:Max 16: DVD-R:Max.8X CAV DVD-R DL:Max.4X Zone CLV DVD-RW:Max.6X Zone CLV DVD+R:Max.8X CAV DVD+R DL:Max.4X Zone CLV DVD+R DL:Max.4X Zone CLV DVD+RW:Max.8X Zone CLV DVD-RAM:3-5X ZCLV (4.70)	X Zone CLV V .V		
	Burst Transfer mode	PIO mode4/Multi word mode2/Ultra DMA mode2			
Access time	CD-ROM	150ms	(Typ.)		
(ms) (Random)	DVD-ROM	180ms (Typ.)			
Buffer n	nemory	2MB			

Table 1-4-5 TSST DVD Super Multi drive specifications

Parameter			TSST Drive Specific	ation	
		TS-L633C	TS-L63	3Y	
Label Flash I	Function		No support	Support	•
		CD-ROM	Max. 24X (3,600 KB/sec)		CAV 24X
		CD-R	Max. 24X (3,600 KB/sec)		CAV 24X
		CD-RW	Max. 24X (3,600 KB/sec)		CAV 24X
	READ Speed	DVD-ROM 5	Max 8X (10,800 KB/sec)		CAV 8X
		DVD-ROM 9	Max 8X (10,800 KB/sec)		CAV 8X
		DVD±R DUAL	Max 8X (10,800 KB/sec)		CAV 8X
		DVD-RAM	Max 5X (6,750 KB/sec)		PCAV 5X/ CLV3X/2X
		CD-R	Max. 24X (3,600 KB/sec)		PCAV 24X/20X/16X/ CLV 10X/8X/4X
Data		MS CD-RW	Max. 4X (600 KB/sec)		CLV 4X
transfer		HS CD-RW	Max. 10X (1,500 KB/sec)		CLV 10X
speed		US CD-RW	Max. 24X (3,600 KB/sec)		ZCLV 24X/20X/16X/10X
		US+ CD-RW	Not Support		Not Support
	WRITE	DVD+R	Max 8X (10,800 KB/sec)		PCAV 8X/6X/ CLV3.3X/CLV2.4X,
	Speed	DVD-R	Max 8X (10,800 KB/sec)		PCAV 8X/6X/ CLV3.3X/CLV2X
		DVD+RW	Max 8X (10,800 KB/sec)		ZCLV 8X/6X/4X/ CLV3.3X/ 2.4X,
		DVD-RW	Max 6X (8,100 KB/sec)		ZCLV 8X/6X/4X/ CLV3.3X/ 2X
		DVD+R DUAL	Max 6X (8,100KB/sec)		ZCLV 6X/4X/ CLV3X/2.4X,
		DVD-R DUAL	Max 6X (8,100KB/sec)		ZCLV 6X/4X/ CLV3X/2X
	Burst Transfer mode	SATA GEN1	( Max 1.5GB/sec)	•	
Access time (	(ms) (Random)	CD-ROM	130ms(typ)	·	
		DVD-ROM	130ms( <u>typ</u> )		
	Buffer memor	у	2MB		

# 1.5 Keyboard

The Qosmio X500 keyboard has two different kinds of placement, one is for US style and the other is for UK style.

Figure 1-5-1 is a view of the keyboard for US style

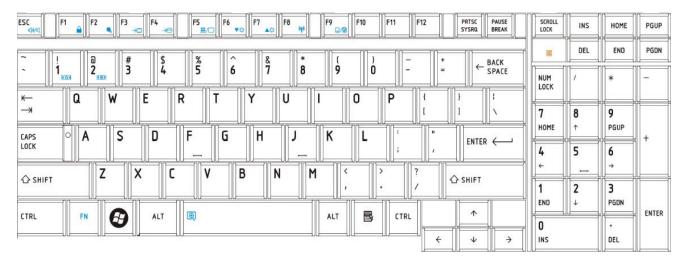


Figure 1-5-1 Keyboard for US style

Figure 1-5-2 is a view of the keyboard for UK style

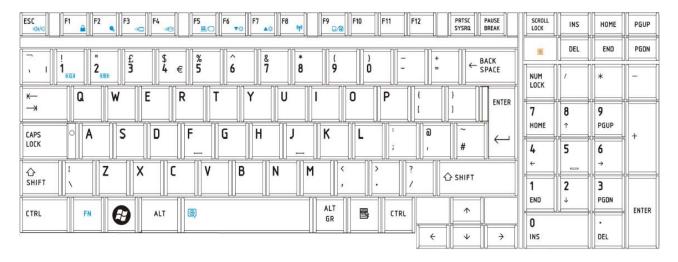


Figure 1-5-2 Keyboard for UK style

See Appendix E for details of the keyboard layout

# 1.6 TFT Color Display

The Qosmio X500 Ganel use CCFL to control backlight.

# 1.6.1 LCD Module with CCFL Backlight

Figure 1-6-1 shows a view of the LCD module and Table 1-6-2 lists the specifications.

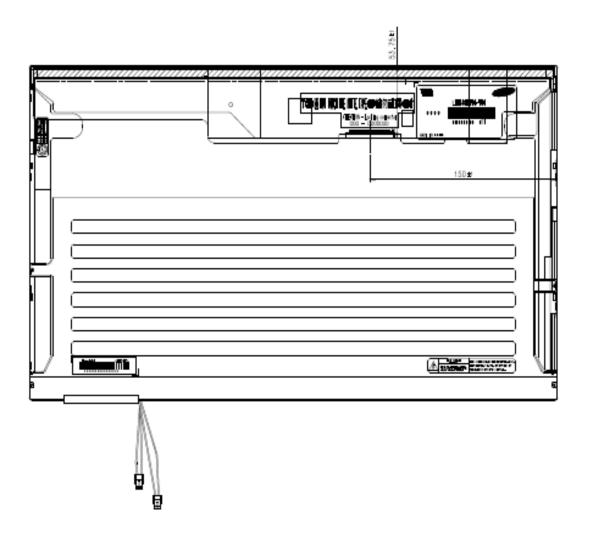


Figure 1-6-1 SAMSUNG LCD Module

Table 1-6-2 LCD module specifications

	Specifications(WXGA+)			
Item	Samsung LTN184KT02-T01	Samsung LTN184HT04-T01		
Number of Pixel	1680 x 945	1920 x 1080		
Dot spacing (mm)	0.243 (H)× 0.243 (V)	0.213 (H)× 0.213 (V)		
Display Colors	262,144 colors	262,144 colors		

# 1.6.2 CCFL Inverter Board

Table 1-10 lists the FL inverter board specifications.

Table 1-6-3 FL inverter board specifications

ltem		Specifications		
		SUMIDA TWS-449-341	Ampower T18I107.00	TDK TBD573NR
Input	Voltage (V)	8~21	8~21	8~21
	Power (W)	7.5W	7.5W	7.5W
Output	Voltage (Vrms)	612~945	612~945	612~945
	Current (f=55KHz)(mArms)	2.3±0.4 ~ 6.5±0.3		

# 1.7 Power Rails

Table 1-7-1 lists the power rail output specifications.

Table 1-7-1 Power supply output rating

Name	Power supply (Yes/No)					
	Voltage [V]	Power OFF Suspend mode	Power OFF Boot mode	No Main Battery (with RTC Battery)		
+5VPCU	5	Yes	Yes	No		
+5V	5	No	No	No		
+3VPCU	3.3	Yes	Yes	No		
+3V_\$5	3.3	Yes	No	No		
+3VSUS	3.3	Yes	No	No		
+3V	3.3	No	No	No		
+1.8VSUS	1.8	Yes	No	No		
+SMDDR_VTERM	1.8	Yes	No	No		
+SMDDR_VREF	1.8	Yes	No	No		
+1.8V	1.8	No	No	No		
+1.5V	1.5	No	No	No		
+1.2V	1.25	No	No	No		
+1.05v	1.05	No	No	No		
+NB_CORE	1.0~1.2	No	No	No		
VCC_CORE	0.7~1.2	No	No	No		
+VCCRTC	3.266	Yes	Yes	Yes		

### 1.8 Batteries

The PC has the following two batteries.

Main battery Real time clock (RTC) battery

Table 1-8-1 lists the specifications for these two batteries.

Table 1-8-1 Battery specifications

Battery Name		Battery Element	Output Voltage
Main Battery	12 Cells	Li-ion	10.8 v
RTC Battery	Coin type	Li-ion	3.0v

#### 1.8.1 Main Battery

The main battery is the primary power supply for the computer when the AC adapter is not connected.

#### 1.8.2 Battery Charging Control

Battery charging is controlled by a power supply microprocessor. The power supply microprocessor controls power supply and detects a full charge when the AC adaptor and battery are connected to the computer.

#### **Battery Charge**

When the AC adapter is connected, normal charging is used while the system is turned on and quick charge is used while the system is turned off. Refer to the following Table 1-13.

*Table 1-8-2 Time required for charges of main battery* 

	Power ON	Power OFF
12 cell	$5 \sim 10 \text{ hours}$	about 4 hours

Charge is stopped in the following cases.

- 1. The main battery is fully charged
- 2. The main battery is removed
- 3. Main battery or AC adapter voltage is abnormal
- 4. Charging current is abnormal

#### Data retaining time

When turning off the power in being charged fully, the retaining time is as following Table 1-8-3.

Table 1-8-3 Data retaining time

# Retaining data Time with power off (days) (when USB Sleep and Charge function is Disabled.)

	Sleep	Shut down
12 cell	about 3 days	about 47 days

<sup>\*</sup> If USB Seep and Charge function is enabled, the computer's battery will discharge during hibernation or when the computer is turned off.

# 1.8.3 RTC Battery

The RTC battery provides the power supply to maintain the date, time, and other system information in memory.

Table 1-8-4 lists the Time required for charges of RTC battery and data preservation time.

Table 1-8-4 Time required for charges of RTC battery

Condition	Time
Charging time	about 24 hours
Data retaining time	about 30 days

# 1.9 AC Adapter

Table 1-9-1 lists the AC adapter specifications.

Table 1-9-1 AC adapter specifications

Parameter₽	Specification₽	4
With Led-	DELTA/ LITE-ON€	4
Power₽	120W <i>₽</i>	4
Input voltage∂	AC 100V~240V₽	4
Input frequency∂	47Hz~63Hz₽	4
Input current∂	<u>≨</u> 1.8A₽	4
Output voltage∂	18.5V~20.0V₽	4
Output current∂	6.32 A₽	4

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# 2.1 Troubleshooting

Chapter 2 describes how to determine which Field Replaceable Unit (FRU) in the computer is causing the computer to malfunction.

The FRUs covered are:

1. Power supply	6. Touch pad	11. Wireless LAN
2. System Board	7. Display	12. Sound
3. USB FDD	8. Optical Disk Drive	13, Finger Print Board
4. 2.5" HDD	9. Modem	14, Bluetooth
5. Keyboard	10. LAN	·

The Test Program operations are described in Chapter 3. Detailed replacement procedures are described in Chapter 4.

**NOTE:** After replacing the system board or CPU, it is necessary to execute the subtest 01 initial configuration of the 3.3 Setting of the hardware configuration in Chapter 3. Also update with the latest BIOS

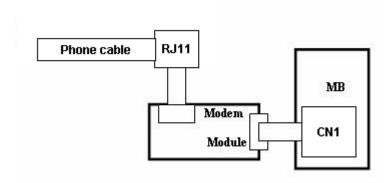
After replacing the LCD, update with the latest EC/KBC.

The implement for the Diagnostics procedures is referred to Chapter 3. Also, following implements are necessary:

- 1. Phillips screwdrivers (For replacement procedures)
- 2. Implements for debugging port check
  - Toshiba Free-DOS system FD

There are following two types of connections in the figure of board and module connection in and after 2.3 Power Supply Troubleshooting.

- (1) Cable connection is described in the figure as line.
- (2) Pin connection is described in the figure as arrow.
- <e.g.> Connection of modem



# 2.2 Troubleshooting Flowchart

the flowchart in Figure 2-1-1 as a guide for determining which troubleshooting dures to execute. Before going through the flowchart steps, verify the following:
Ask customer to enter the password if a password is registered.
Verify with the customer that Toshiba Windows is installed on the hard disk. Non-Windows operating systems can cause the computer to malfunction.
Make sure all optional equipment is removed from the computer.

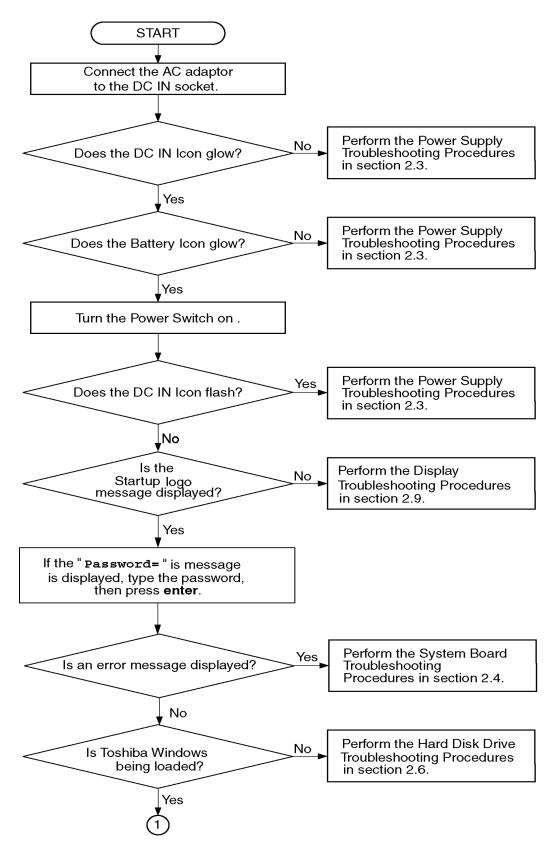
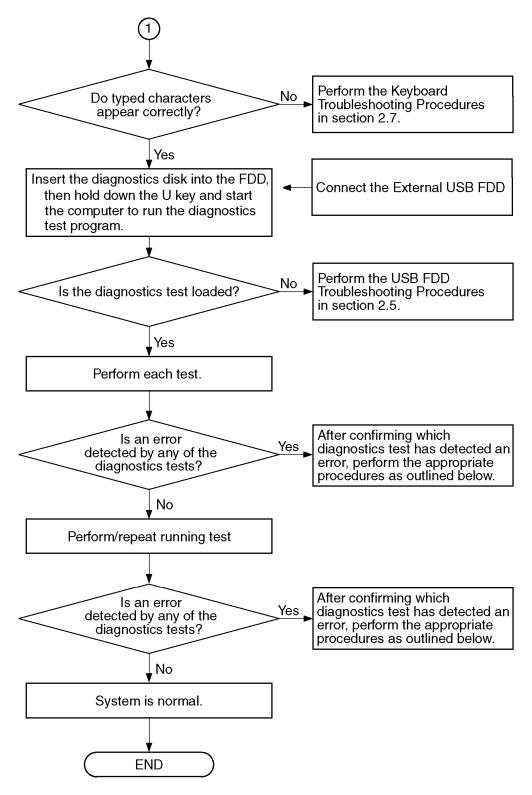


Figure 2-1-1 Troubleshooting flowchart (1/2)



*Figure 2-1-2 Troubleshooting flowchart (2/2)* 

If the diagnostics program cannot detect an error, the problem may be intermittent. The Test program should be executed several times to isolate the problem. Check the Log Utilities

function to confirm which diagnostic test detected an error(s), and then perform the appropriate troubleshooting procedures as follows:

- 1. If an error is detected on the system test, memory test, display test, CD-ROM/DVD-ROM test, expansion test, real timer test, sound test or Modem/LAN/Bluetooth /IEEE1394 test, perform the System Board Troubleshooting Procedures in Section 2.4.
- 2. If an error is detected on the floppy disk test, perform the USB FDD Troubleshooting Procedures in Section 2.5.
- 3. If an error is detected on the hard disk test, perform the HDD Troubleshooting Procedures in Section 2.6.
- 4. If an error is found on the keyboard test and pressed key display test, perform the Keyboard Troubleshooting Procedures in Section 2.7.
- 5. If an error is found on the touch pad test, perform the touch pad Troubleshooting Procedures in Section 2.8.
- 6. If an error is detected on the display test, perform the Display Troubleshooting Procedures in Section 2.9.
- 7. If an error is detected on the CD-ROM/DVD-ROM test, perform the Optical Disk Drive Troubleshooting Procedures in Section 2.10.
- 8. If an error is detected on the modem test, perform the Modem Troubleshooting Procedures in Section 2.11.
- 9. If an error is detected on the LAN test, perform the LAN Troubleshooting Procedures in Section 2.12.
- 10. If an error is detected on the wireless LAN test, perform the Wireless LAN Troubleshooting Procedures in Section 2.13.
- 11. If an error is detected on the sound test, perform the Sound Troubleshooting Procedures in Section 2.14.
- 12. If an error is detected on the fingerprint test, perform the fingerprint Troubleshooting Procedures in Section 2.15.
- 13. If an error is detected on the Bluetooth test, perform the Bluetooth Troubleshooting Procedures in Section 2.16.

# 2.3 Power Supply Troubleshooting

The power supply controller controls many functions and components. To determine if the power supply is functioning properly, start with Procedure 1 and continue with the other Procedures as instructed. The procedures described in this section are:

Procedure 1: Power Status Check
Procedure 2: Connection Check
Procedure 3: Charging Check
Procedure 4: Replacement Check

#### Procedure 1 Power Status Check

The following LED indicates the power supply status:

☐ Battery LED

☐ DC IN LED

The Power Supply control displays the power supply status with the Battery LED and the DC IN LED as listed in the tables below.

Table 2-1 Battery icon

Battery icon	Power supply status
Lights orange	Battery is charged and the AC adapter is connected. It has no relation with ON/OFF of the system power.
Lights red	Battery is fully charged and the AC adapter is connected. It has no relation with ON/OFF of the system power.
Blinks orange (even intervals)	The battery level is low while the system power is ON.
Blinks orange once (at being switched on)	The system is driven by only a battery and the battery level is low.
Doesn't light	Any condition other than those above.

Table 2-2 DC IN icon

DC IN icon	Power supply status
Lights red	DC power is being supplied from the AC adapter.
Blinks orange	Power supply malfunction <sup>*1</sup>
Doesn't light	Any condition other than those above.

<sup>\*1</sup> When the power supply controller detects a malfunction, the DC IN icon blinks orange.

When the icon is blinking, perform the following procedure.

- 1. Remove the battery pack and the AC adapter.
- 2. Re-attach the battery pack and the AC adapter.

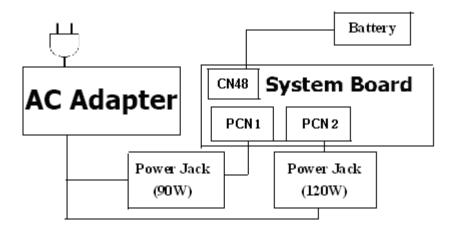
If the icon is still blinking after the operation above, check the followings:

- Check 1 If the DC IN icon blinks orange, go to Procedure 2.
- Check 2 If the DC IN icon does not light, go to Procedure 3.
- Check 3 If the battery icon does not light orange or green, go to Procedure 4.

**NOTE**: Use a supplied AC adapter.

#### Procedure 2 Connection Check

The wiring diagram related to the power supply is shown below:



Any of the connectors may be disconnected. Perform Check 1.

- Check 1 Make sure the AC adapter and the AC power cord is firmly plugged into the DC IN connector PCN3 and wall outlet. If these cables are connected firmly, go to Check 2.
- Check 2 Replace the AC adapter and the AC power cord with new ones.
  - If the DC IN icon does not light, go to Procedure 4.
  - If the battery icon does not light, go to Check 3.
- Check 3 Make sure the main battery pack is installed in the computer correctly. If the battery is properly installed and the battery icon still does not light, go to Procedure 4.

#### Procedure 3 Charging Check

Check if the power supply controller charges the battery pack properly. Perform the following procedures:

- Check 1 Make sure the AC adapter is firmly plugged into the DC IN socket.
- Check 2 Make sure the battery pack is properly installed. If it is properly installed, go to Check 3.
- Check 3 The battery pack may be completely discharged. Wait a few minutes to charge the battery pack while connecting the battery pack and the AC adapter. If the battery pack is still not charged, go to Check 4.
- Check 4 The battery's temperature is too high or low. Leave the battery for a while to

adjust it in the right temperature. If the battery pack is still not charged, go to Check 5.

Check 5 Replace the battery pack with a new one. If the battery pack is still not charged, go to Procedure 4.

#### Procedure 4 Replacement Check

The power is supplied to the system board by the AC adapter. If either the AC adapter or the system board was damaged, perform the following Checks.

To disassemble the computer, follow the steps described in Chapter 4, *Replacement Procedures*.

When AC adapter is connected;

Check 1 AC adapter may be faulty. Replace the AC adapter with a new one. If the problem still occurs, perform Check 2.

Check 2 System board may be faulty. Replace the system board with a new one.

When AC adapter is not connected;

(When driving with battery pack)

Check 1 Battery pack may be faulty. Replace it with a new one. If the problem still occurs, perform Check 2.

Check 2 System board may be faulty. Replace it with a new one.

# 2.4 System Board Troubleshooting

This section describes how to determine if the system board is malfunctioning or not. Start with Procedure 1 and continue with the other procedures as instructed. The procedures described in this section are:

Procedure 1: Message Check

Procedure 2: Diagnostic Test Program Execution Check

Procedure 3: Replacement Check

#### Procedure 1 Message Check

When the power is turned on, the system performs the Power On Self Test (POST) installed in the BIOS ROM. The POST tests each IC on the system board and initializes it.

- ☐ If an error message is shown on the display, perform Check 1.
   ☐ If there is no error message, go to Procedure 2.
   ☐ If Free-DOS or Windows is properly loaded, go to Procedure 3.
- Check 1 If one of the following error messages is displayed on the screen, press the **F2** key as the message instructs. These errors occur when the system configuration preserved in the RTC memory (CMOS type memory) is not the same as the actual configuration or when the data is lost.

If you press the **F2** key as the message instructs, the SETUP screen appears to set the system configuration. If error message (b) appears often when the power is turned on, replace the RTC battery.

#### Procedure 2 Diagnostic Test Program Execution Check

Execute the following tests from the Diagnostic Test Menu. These tests check the system board. Refer to Chapter 3, *Tests and Diagnostic*, for more information on how to perform these tests.

- 1. System test
- 2. Memory test
- 3. Keyboard test
- 4. Display test
- 5. Floppy Disk test
- 6. VGA test
- 7. VGA Memory test
- 8. Hard Disk test
- 9. CPU Temperature test
- 10. Main Battery test
- 11. BIOS test
- 12. CD-ROM/DVD-ROM test
- 13. System Status LED test
- 14. Wireless LAN test
- 15. LAN/Modem/Sound test
- 16. UUID test-DMI Information (Write DMI)

If an error is detected during these tests, go to Procedure 3.

#### **Procedure 3** Replacement Check

System board may be faulty. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and replace system board with a new one.

## 2.5 USB FDD Troubleshooting

To check if the USB FDD is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: FDD Head Cleaning Check

Procedure 2: Diagnostic Test Program Execution Check Procedure 3: Connector Check and Replacement Check

#### Procedure 1 FDD Head Cleaning Check

FDD head cleaning is one option available in the Diagnostic Program.

After connecting USB FDD, insert the Diagnostics Disk in the floppy disk drive. Turn on the computer and run the test. And then clean the FDD heads using the cleaning kit. If the FDD still does not function properly after cleaning, go to Procedure 2.

Detailed operation is given in Chapter 3, Tests and Diagnostics.

If the test program cannot be executed on the computer, go to Procedure 3.

#### Procedure 2 Diagnostic Test Program Execution Check

Insert the Diagnostics Disk in the USB FDD, turn on the computer and run the test. Refer to Chapter 3, *Tests and Diagnostics*, for more information about the diagnostics test procedures.

Make sure the floppy disk is formatted correctly and that the write protect tab is disabled. Floppy disk drive test error codes and their status names are listed in Table 2-7. If any other errors occur while executing the FDD diagnostics test, go to Check 1.

Code **Status** 01h Bad command 02h Address mark not found 03h Write protected 04h Record not found 06h Media replaced 08h DMA overrun error 09h DMA boundary error 10h CRC error FDC error 20h 40h Seek error 60h FDD not drive 80h Time out error (Not ready) EEh Write buffer error FFh Data compare error

Table 2-7 FDD error code and status

Check 1 If the following message is displayed, disable the write protect tab on the floppy disk by sliding the write protect tab to "write enable". If any other message appears, perform Check 2.

Write protected

Check 2 Make sure the floppy disk is formatted correctly. If it is, go to Procedure 3.

#### **Procedure 3** Connector Check and Replacement Check

USB FDD is connected to USB port on system board and US board. US board is also connected to system board by cable. The connection of cable and board may be defective. Otherwise, they may be faulty. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and perform the following checks.

USB FDD can be connected to the following 4 ports on system board.

Check 1 Make sure USB FDD is firmly connected to USB port. If the connection is loose, connect firmly and repeat Procedure 2. If the problem still occurs, go to Check 2.

**NOTE:** When checking the connection, be sure to check it with care for the followings.

- 1. Cable can not be disconnected from the connector.
- 2. Cable is connected straight to the connector.
- 3. Cable is connected all the way seated in the connector.
- 4. Cable can not be broken.

- Check 2 USB FDD may be faulty. Replace it with a new one. If the problem still occurs, perform Check 3.
- Check 3 Connect USB FDD to each port embedded on system board.

  If it does not work properly, perform Check 4.
- Check 4 System board may be faulty. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*.

# 2.6 2.5" HDD Troubleshooting

To check if 2.5" HDD is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Partition Check
Procedure 2: Message Check

Procedure 3: Format Check

Procedure 4: Diagnostic Test Program Execution Check Procedure 5: Connector Check and Replacement Check

CAUTION: The contents of the hard disk will be erased when the 2.5" HDD troubleshooting procedures are executed. Transfer the contents of the hard disk to other storage drive(s). For the backup, refer to the User's Manual.

#### Procedure 1 Partition Check

Insert the Toshiba Free-DOS system disk and start the computer. Perform the following checks:

- Check 1 Input **C:** and press **Enter**. If you cannot change to drive C, go to Check 2. If you can change to drive C, go to Procedure 2.
- Check 2 Input **FDISK** and press **Enter**. Choose Display Partition Information from the FDISK menu. If drive C is listed in the Display Partition Information, go to Check 3. If drive C is not listed, return to the FDISK menu and choose the option to create a DOS partition or a logical DOS drive on drive C. If the problem still occurs, go to Procedure 2.
- Check 3 If drive C is listed as active in the FDISK menu, go to Check 4. If drive C is not listed as active, return to the FDISK menu and choose the option to set the active partition for drive C. Then go to Procedure 2.
- Check 4 Remove the system disk from the FDD and reboot the computer. If the problem still occurs, go to Procedure 2. Otherwise, the 2.5" HDD is operating normally.

#### Procedure 2 Message Check

When the power is turned on, the system performs the Initial Reliability Test (IRT) installed in the BIOS ROM. When the test detects an error, an error message is displayed on the screen.

Make sure no floppy disk is in the FDD. Turn on the computer and check the message on the screen. When an OS starts from the 2.5" HDD, go to Procedure 3. Otherwise, start with Check 1 below and perform the other checks as instructed.

Check 1 If either of the following messages appears, go to Check 3. If the following messages do not appear, perform Check 3.

```
Insert system disk in drive
Press any key when ready ....

or

Non-System disk or disk error
Replace and press any key when ready
```

Check 2 Using the SYS command of the Free-DOS, transfer the system to the 2.5" HDD. If the system is not transferred, go to Procedure 3. Refer to the Free -DOS Manual for detailed operation.

If the following message appears on the display, the system program has been transferred to the HDD.

```
System Transferred
```

If an error message appears on the display, perform Check 3.

Check 3 2.5" HDD(s) and the connector(s) of system board may be defective (Refer to the steps described in Chapter 4, *Replacement Procedures* for disassembling.). Insert HDD(s) to the connector(s) firmly. If it is (or they are) firmly connected, go to Procedure 3.

#### Procedure 3 Format Check

The computer's HDD is formatted using the Free-DOS FORMAT program or the physical format program of the test program. To format the HDD, start with Check 1 below and perform the other steps as required.

Refer to the Free-DOS Manual for the operation of Free-DOS. For the format by the test program, refer to the Chapter 3.

- Check 1 Format an 2.5" HDD using Free-DOS FORMAT command. Type as **FORMAT** C:/S/U.
  - If 2.5" HDD can not be formatted, perform Check 2.
- Check 2 Using the Free -DOS FDISK command, set the 2.5" HDD partition. If the partition is not set, go to Check 3. If it is set, format 2.5" HDD using Free-DOS FORMAT command.
- Check 3 Using the Diagnostic Disk, format 2.5" HDD with a format option (physical format). If HDD is formatted, set the 2.5" HDD partition using Free-DOS FDISK command.

If you cannot format 2.5" HDD using the Tests and Diagnostic program, go to Procedure 4.

#### Procedure 4 Diagnostic Test Program Execution Check

The HDD test program is stored in the Diagnostics Disk. Perform all of the HDD tests in the Hard Disk Drive Test. Refer to Chapter 3, *Tests and Diagnostics*, for more information about the HDD test program.

If an error is detected during the HDD test, an error code and status will be displayed. The error codes and statuses are described in Table 2-8. If an error code is not displayed but the problem still occurs, go to Procedure 5.

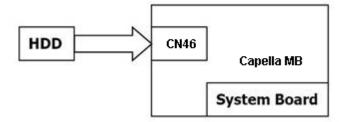
Table 2-5-1 2.5" Hard disk drive error code and status

Code	Status
01	Bad Command Error
02	Bad Address Mark Error
04	Record Not Found
05	HDC Not Reset Error
07	Drive Not Initialized
09	DMA Boundary Error
0A	Bad Sector
0B	Bad Track Error
10	ECC Error
11	ECC Recover Enabled
20	HDC Error
40	Seek Error
80	Time Out Error
AA	Dri∨e Not Ready
вв	Undefined Error
СС	Write Fault
E0	Status Error
F0	No Sense Error
??	Other Error

#### Procedure 5 Connector Check and Replacement Check

HDD(s) is/are connected to the connector(s) on the system board. The connection of HDD(s) and board may be defective. Otherwise, they may be faulty. Disassemble the computer following instructions in Chapter 4, *Replacement Procedures* and perform the following checks.

Check 1 Make sure HDD(s) is/are firmly connected to the connector(s) on the system board.



If any of the connections are loose, reconnect firmly and repeat Procedure 1. If the problem still occurs, go to Check 2.

- Check 2 (One of) HDD(s) may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures* and check the operation. If the problem still occurs, perform Check 3.
- Check 3 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

# 2.7 Keyboard Troubleshooting

To check if the computer's keyboard is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector and Replacement Check

# Procedure 1 Diagnostic Test Program Execution Check

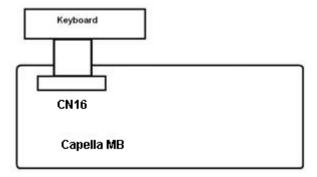
Execute the Keyboard Test (DIAGNOSTIC TEST) and Pressed key display test in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics*, for more information on how to perform the test program.

If an error occurs, go to Procedure 2. If an error does not occur, keyboard is functioning properly.

#### **Procedure 2** Connector and Replacement Check

The connection of cable and board may be defective. Otherwise, they may be faulty. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure keyboard cable is firmly connected to system board.



If the connection is loose, reconnect firmly and repeat Procedure 1. If the problem still occurs, go to Check 2.

- Check 2 Keyboard may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 3.
- Check 3 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

# 2.8 Touch pad Troubleshooting

To check if the computer's touch pad is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector and Replacement Check

#### Procedure 1 Diagnostic Test Program Execution Check

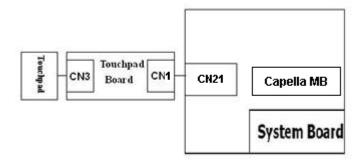
Execute the Touch pad test in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics*, for more information on how to perform the test program.

If an error occurs, go to Procedure 2. If an error does not occur, touch pad is functioning properly.

#### **Procedure 2** Connector and Replacement Check

The connection of cable and board may be defective. Otherwise, they may be faulty. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure the cable is firmly connected to system board.



If the connection is loose, reconnect firmly and repeat Procedure 1. If the problem still occurs, go to Check 2.

- Check 2 Touch Pad or the cable may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 3.
- Check 3 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*

# 2.9 Display Troubleshooting

To check if the computer's display is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: External Monitor Check

Procedure 2: Diagnostic Test Program Execution Check

Procedure 3: Connector and Cable Check

Procedure 4: Replacement Check

#### Procedure 1 External Monitor Check

Connect an external monitor to the computer's external monitor port, and then boot the computer. The computer automatically detects the external monitor when "Power on Display" setting is "Auto-Selected" (Default) in BIOS Setup Menu. If this setting is "System LCD only", external monitor cannot be displayed.

If the external monitor works correctly, the internal LCD may be faulty. Go to Procedure 3.

If the external monitor appears to have the same problem as the internal monitor, system board may be faulty. Go to Procedure 2.

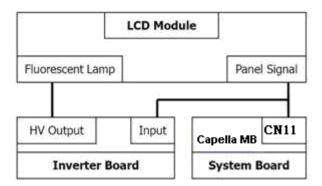
#### Procedure 2 Diagnostic Test Program Execution Check

The Display Test program is stored in Diagnostics disk. This program checks the display controller on system board. Insert the Diagnostics disk in the USB FDD, turn on the computer and run the test. Refer to Chapter 3, *Tests and Diagnostics* for details. If an error is detected, go to Procedure 3.

#### **Procedure 3** Connector and Cable Check

LCD Module is connected to system board by an LCD/FL cable. FL inverter board is also connected to system board by an LCD/FL cable. And, fluorescent lamp is connected to FL inverter board by HV cable. Their cables may be disconnected from system board or FL inverter board. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*.

If the connection is loose, reconnect firmly and restart the computer. If the problem still occurs, go to Procedure 4.



#### Procedure 4 Replacement Check

Fluorescent lamp, FL inverter, LCD module, HV cable and LCD/FL cable are connected to display circuits. Any of these components may be faulty. Refer to Chapter 4, *Replacement Procedures*, for instructions on how to disassemble the computer and then perform the following checks:

If LED backlight does not light, perform Check 1.

If characters or graphics on the internal display are not displayed clearly, perform Check 3.

If some screen functions do not operate properly, perform Check 3.

If LED backlight remains lit when the display is closed, perform Check 4.

- Check 1 LCD/FL cable may be faulty. Replace FL/LCD cable with a new one following the instructions in Chapter 4, *Replacement Procedure* and test the display again. If the problem still occurs, perform Check 2.
- Check2 FL inverter may be faulty. Replace FL inverter with a new one following the instructions in Chapter 4, *Replacement Procedure* and test the display again. If the problem still occurs, perform Check 3.
- Check 3 LCD module may be faulty. Replace LCD module with a new one following the instructions in Chapter 4, *Replacement Procedure* and test the display again. If the problem still occurs, perform Check 4.
- Check 4 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedure*.

# 2.10 Optical Disk Drive Troubleshooting

To check if optical disk drive is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector Check and Replacement Check

### Procedure 1 Diagnostic Test Program Execution Check

Execute the CD-ROM/DVD-ROM Test in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to perform the test program.

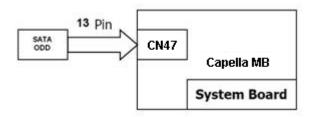
Prepare the tools before the test.

If any error is detected by the test, go to Procedure 2.

#### Procedure 2 Connector Check and Replacement Check

The connection of optical disk drive and system board may be defective. Otherwise, they may be faulty. Disassemble the computer following the steps described in Chapter 4 and perform the following checks:

Check 1 Make sure optical disk drive is firmly connected to the connector on system board.



If the connection is loose, reconnect it firmly and return to Procedure 2. If the problem still occurs, perform Check 2.

- Check 2 Optical disk drive may be faulty. Replace it with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 3.
- Check 3 System board may be faulty. Replace it with new one following the instructions in Chapter 4.

# 2.11 Modem Troubleshooting

To check if modem is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check Procedure 2: Connector Check and Replacement Check

## Procedure 1 Diagnostic Test Program Execution Check

Execute Modem test in the LAN/Modem/Bluetooth/IEEE1394 test program. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to perform the test program.

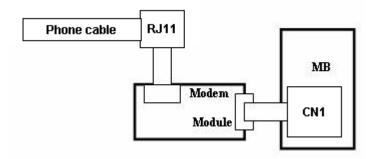
If any error is detected, perform Procedure 2.

#### **Procedure 2** Connector Check and Replacement Check

MDC (Modem Daughter Card) is used as the modem for this computer. MDC is connected to system board by connector. And also, MDC is connected to system and LAN board by modem cable. If modem malfunctions, the connection of cable, board and module may be defective. Otherwise, they may be faulty.

Disassemble the computer following the steps described in Chapter 4 and perform the following checks:

Check 1 Make sure the following connections are firmly connected.



If any connector is disconnected, connect it firmly and return to Procedure 1. If the problem still occurs, perform Check 2.

- Check 2 Modem cable may be faulty. Replace it with a new one. If the problem still occurs, perform Check 3.
- Check 3 MDC may be faulty. Replace it with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 4.
- Check 4 Cable between MDC and system board may be faulty. Replace it with a new one following the instructions in Chapter 4. If the problem still occurs, perform Check 5.
- Check 5 System board may be faulty. Replace it with a new one following the instruction in Chapter 4.

# 2.12 LAN Troubleshooting

To check if the computer's LAN is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check Procedure 2: Connector Check and Replacement Check

#### Procedure 1 Diagnostic Test Program Execution Check

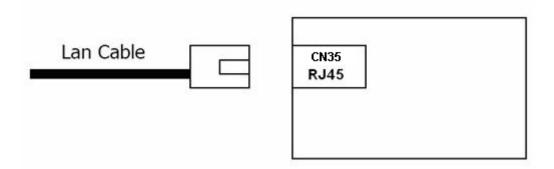
Execute LAN test in the LAN/Modem test program. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to perform the test program.

If any error is detected by the test, go to Procedure 2.

#### **Procedure 2** Connector Check and Replacement Check

The LAN function is embedded on system board. If LAN malfunctions, its connection is defective or LAN cable and system board may be faulty.

Check 1 Make sure LAN cable is firmly connected to the connector CN1. If the problem still occurs, perform Check 2.



- Check 2 LAN cable may be faulty. Replace it with a new one. If the problem still occurs, perform Check 3.
- Check 3 System board may be faulty. Replace it with a new one following the instruction in Chapter 4.

# 2.13 Wireless LAN Troubleshooting

To check if the computer's Wireless LAN is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Transmitting-Receiving Check

Procedure 2: Antennas' Connection Check

Procedure 3: Replacement Check

# Procedure 1 Transmitting-Receiving Check

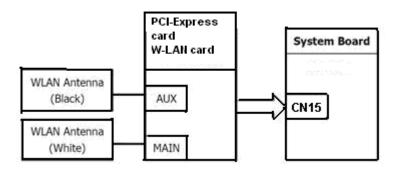
Before starting the test, make sure the wireless communication is Enabled in BIOS setup

Check 1 Execute Wireless LAN test program to check the transmitting-receiving function of wireless LAN. You will need a second computer that can communicate by wireless LAN. Perform the test following the instructions described in Chapter 3.

If the computer passes the test, the function is correctly working. If the computer does not pass the test, perform Procedure 2.

#### Procedure 2 Antennas' Connection Check

The wireless LAN function-wiring diagram is shown below:



Any of the connections may be defective. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

- Check 1 Make sure the wireless communication is Enabled in BIOS setup

  If the Wireless communication is "Disabled", change it to "Enabled". If the problem still occurs, perform Check 2.
- Check 2 Make sure wireless LAN card is firmly connected to the CN15 on system board. If the connector is defective, connect it firmly and perform Procedure 1. If the problem still occurs, perform Check 3.
- Check 3 Make sure that wireless LAN antenna cables (black and white) are firmly connected to the connectors on Wireless LAN card. If wireless LAN antenna cables are not connected properly, connect them firmly and perform Procedure 1. If the problem still occurs, go to the procedure 3.

#### Procedure 3 Replacement Check

Wireless LAN card, wireless LAN antenna or system board may be faulty. Refer to Chapter 4, *Replacement Procedures*, for instructions on how to disassemble the computer and then perform the following checks:

- Check 1 Wireless LAN antenna may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 2.
- Check 2 Wireless LAN card may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 3.
- Check3 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

# 2.14 Sound Troubleshooting

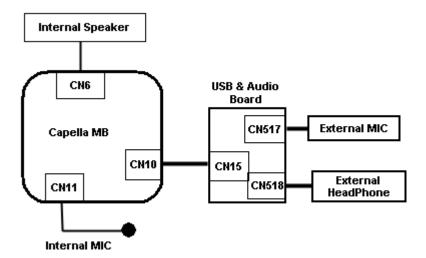
To check if the sound function is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Connector Check

Procedure 2: Replacement Check

#### Procedure 1 Connector Check

The connection of sound system is shown in the following figure.



As the connection may be defective, disassemble the PC and check each connection.

If the problem still occurs, go to Procedure 2.

Pr	ocedur	e 2 Replacement Check		
	If External microphone/Headphone does not work properly, perform check 1.			
	If Inter	nal microphone /Speaker does not work properly, perform check 2.		
	If HP o	out does not work properly, perform check 3.		
	If Volume control does not work properly, perform check 4.			
Ch	eck 1	External microphone/Headphone may be faulty. Replace it with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 5.		
Ch	eck 2	Internal microphone /Speaker may be faulty. Replace it with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 5.		
Ch	eck 3	HP out may be faulty. Replace it with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 5.		
Ch	eck 4	Volume control may be faulty. Replace it with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 6.		
Ch	eck 5	Flat cable between AD board/Speaker and system board may be faulty. Replace it with new cable following the instructions in Chapter 4. If the problem still occurs, perform Check 6.		

Audio board/System board may be faulty. Replace it with a new one following the

instructions in Chapter 4.

Check 6

# 2.15 Fingerprint Troubleshooting

To check if the computer's Fingerprint is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Connector Check and Replacement Check

#### Procedure 1 Diagnostic Test Program Execution Check

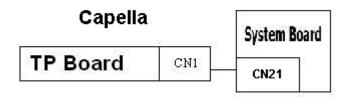
Execute Fingerprint test in the test program. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to perform the test program.

If any error is detected, perform Procedure 2.

#### **Procedure 2** Connector Check and Replacement Check

The Fingerprint function is embedded on system board. If Fingerprint malfunctions, its connection is defective or Fingerprint cable and system board may be faulty.

Check 1 Make sure Fingerprint cable is firmly connected to the connector. If the problem still occurs, perform Check 2.



- Check 2 Fingerprint cable may be faulty. Replace it with a new one. If the problem still occurs, perform Check4.
- Check 3 Fingerprint may be faulty. Replace it with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 4.
- Check 4 System board may be faulty. Replace it with a new one following the instruction in Chapter 4.

# 2.16 Bluetooth Troubleshooting

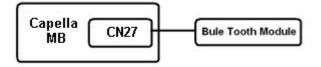
To check if the computer's Bluetooth is malfunctioning or not, follow the troubleshooting procedure below as instructed.

Procedure 1: Connector Check and Replacement Check

#### **Procedure 1** Connector Check and Replacement Check

The Bluetooth module is connected to system board. If Bluetooth malfunctions, its connection is defective or Bluetooth cable and system board may be faulty.

Check 1 Make sure Bluetooth cable is firmly connected to the connector CN27. If the problem still occurs, perform Check 2.



- Check 2 Bluetooth cable may be faulty. Replace it with a new one. If the problem s till occurs, perform Check 3.
- Check 3 Bluetooth may be faulty. Replace it with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 4.
- Check 4 System board may be faulty. Replace it with a new one following the instruction in Chapter 4.

# **Chapter 3 Diagnostic Programs**

# **Chapter 3 Contents**

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# 3.1 Tests and Diagnostics Software Overview

This chapter explains how to use the Tests and Diagnostics Software for the Satellite P500 and Satellite Pro P500 computer systems.

NOT	ES: Be	efore starting the Tests and Diagnostics software:
		Check all cables for loose connections.
	2.	Exit any application and close Windows.
The Di	iagnosti	ics Menu consists of the following options:
	Diagn	ostic Test
		ng Test
		nformation
	Log U	tilities
	•	n Configuration
	Option	1
The	Diagno	ostic Test Menu consists of the following functional tests:
	Systen	n Test
	Memo	bry Test
	Keybo	pard Test
	Displa	y Test
	Floppy	y Disk Test
	Hard I	Disk Test
	Real T	Fime Clock Test
	Cache	Memory Test
	High I	Resolution Display Test
	Multir	media Test
	Memo	ory2 Test
	FDD 8	& HDD Error Retry Count Set
The fo	llowing	g equipment is required to perform some of the diagnostic test programs:
	The D	iagnostics Disk (all tests)
		natted working disk for the floppy disk drive test (all tests)
		test media (Toshiba Backup CD ROM for the CD-ROM test)
		g sections detail the tests contained within the Diagnostic Test Menu. Refer to
		3.19, 3.20 and, 3.21 for detailed information on the remaining functions of the
		gnostics software.

# 3.2 Executing the Diagnostic Test

DOS is required to run the Diagnostics Program. To start the programs follow these steps:

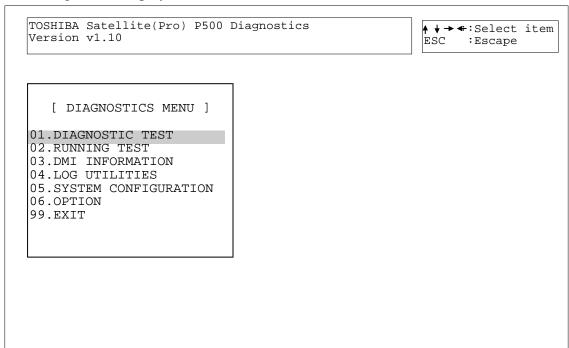
- 1. Create a DOS bootable disk and copy all the files from the Tests and Diagnostics software to the disk.
- 2. Insert the boot disk into the computer's floppy disk drive and turn on the computer.

NOTES: If error message display "Sorry. This Model Type Not Match This Machine":

#### Please Check:

- 1. You test disk is match this model, ex. disk is 14" but machine is 13".
- 2. The M/B EEPROM project type is math your test disk, if not, please use WDMI3.EXE to modify with right LCD size.

The following screen displays:



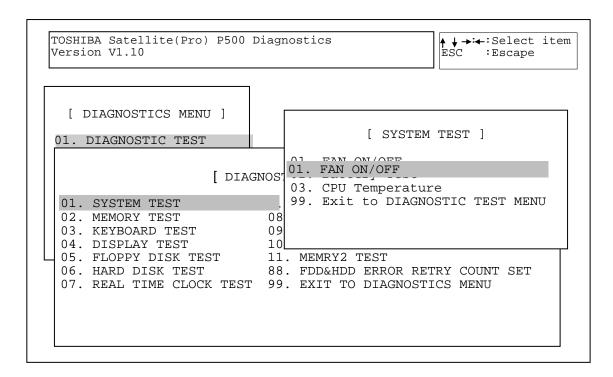
3. To select the Diagnostic Test from the Diagnostics Menu use the arrow keys to set the highlight bar to **01** and press **Enter**.

The following menu displays:

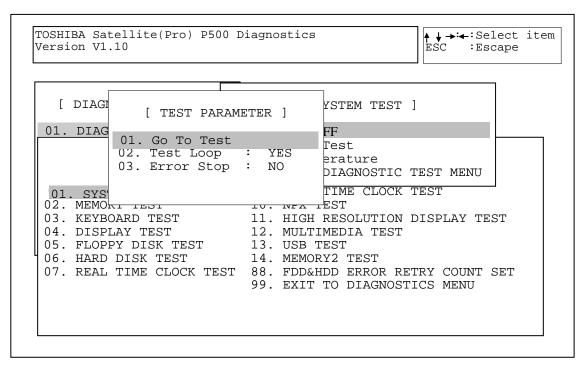
```
↑ ↓ → ←: Select item
ESC :Escape
TOSHIBA Satellite(Pro) P500 Diagnostics
Version V1.10
                                                          :Escape
  [ DIAGNOSTICS MENU ]
01. DIAGNOSTIC TEST
                     [ DIAGNOSTIC TEST MENU ]
                            08. CACHE MEMORY TEST
01. SYSTEM TEST
                            09. HIGH RESOLUTION DISPLAY TEST
    MEMOKI IESI
03. KEYBOARD TEST
                            10. MULTIMEDIA TEST
04. DISPLAY TEST
                            11. MEMORY2 TEST
05. FLOPPY DISK TEST
                            88. FDD&HDD ERROR RETRY COUNT SET
                            99. EXIT TO DIAGNOSTICS MENU
06. HARD DISK TEST
07. REAL TIME CLOCK TEST
```

Refer to Sections 3.4 through 3.14 for detailed descriptions of Diagnostics Tests 1 through 11. Item 88 sets the floppy disk drive and hard disk drive error retry count. Item 99 exits the submenu of the Diagnostic Test and returns to the Diagnostics Menu.

4. Select the subtest you want to execute and press **Enter**. The following menu displays:



5. Select the desired test from the subtest menu and press **Enter**. The following Test Parameter menu displays:



Use the arrow keys to highlight the desired option and press **Enter**.

**NOTES**: The Item2 and 3 of Test Parameter are not used by some tests.

#### Go To Test

Move the highlight bar to Go To Test and press Enter to start executing the test.

#### **Test Loop**

Select **NO** to return the screen to the subtest menu after the test is complete. Select **YES** to set the test to run continuously until it is halted by the user.

#### **Error Stop**

Select **NO** to keep the test running even if an error is found.

Select **YES** to stop the test program when an error is found and display the HALT OPERATION screen as shown below:

```
[[ HALT OPERATION ]]
  1: Test end
  2: Continue
  3: Retry
```

These three selections have the following functions:

- 1: Terminates the test program and exits to the subtest menu.
- 2: Continues the test from the error.
- 3: Restarts the test from the beginning.

Use the arrow keys to move the cursor to the desired option and press **Enter**. Table 3-1 in Section 3.3 lists the function of each test on the subtest menu. Table 3-2 in Section 3.15 lists the error codes and error status for each error.

# 3.3 Subtest names

Table 3-1 lists the subtest names for each test program in the Diagnostic Test menu.

Table 3-1 Subtest Names(1/3)

No.	Test Name	No.	Subtest Name
01	SYSTEM TEST	01	FAN ON/OFF check
		02	Battery TEST
		03	CPU Temperature
		04	3D HDD Protection Test (90d)
02	MEMORY TEST	01	Conventional Memory
		02	Protected Mode
		03	Protected Mode (32MB-MAX)
		04	RAM Refresh
		05	Stress Test
03	KEYBOARD TEST	01	Pressed Key Display [109 KBD]
		02	Pressed Key Display [105 KBD]
		03	Pressed Key Display [104 KBD]
		04	Hot Key Display [9 KBD]
		05	Hot Key Display [1 KBD]
		06	PS/2 Mouse (Pointing 2Button)
04	DISPLAY TEST	01	Character Attributes
		02	Character Set
		03	80* 25 Character Display
		04	320* 200 Graphics Display
		05	640* 200 Graphics Display
		06	640* 480 Graphics Display
		07	Display Page
		08	"H" Pattern Display
		09	Video DAC Register W/R/C
		10	Color Graphics Display
		11	Color Attributes Display
		12	Color Tiling

Table 3-1 Subtest Names(2/3)

No.	Test Name	No.	Subtest Name
05	FLOPPY DISK TEST	01	Sequential Read
		02	Sequential W/R/C
		03	Random Address/Data
		04	Write Specified Address
		05	Read Specified Address
06	HARD DISK TEST	01	Sequential Read
		02	Address Uniqueness
		03	Random Address Data
		04	Cross Talk and Peek Shift
		05	Write Specified Address
		06	Read Specified Address
		07	Sequential Write
		08	W-R-C Specified Address
07	REAL TIME CLOCK	01	Real Time Test
	TEST	02	Backup Memory Test
		03	Real Time Carry Test
08	CACHE MEMORY TEST	01	Constant Data Test
		02	Address Pattern Test
		03	Increment/Decrement Test
		04	Bit Shift Pattern Test
		05	*Write Disturb Test
		06	Checker Board Test
		07	Marching Test
		08	Working Data Test
09	HIGH RESOLUTION	01	VRAM W/R/C Test
	DISPLAY TEST	02	640* 480 Mode Display
		03	800* 600 Mode Display
		04	1024* 768 Mode Display
		05	"H" Pattern Display
		06	Focus Test ("E" Pattern)

Table 3-1 Subtest Names(3/3)

No.	Test Name	No.	Subtest Name
10	MULTIMEDIA TEST	01	Sequential Read Test
		02	Random Read Test
		03	Read Specified Address Test
		04	1 point W/R/C Test
11	MEMORY2	01	All one/zero Test
		02	Walking 1/Walking 0 Test(Left)
		03	Walking 1/Walking 0 Test(Right)
		04	Walking 1/Walking 0 Test(Left /Right)

<sup>\*</sup>This test cannot support.

# 3.4 System Test

To execute the System Test select **01** from the Diagnostic Test Menu, press **Enter** and follow the directions on the screen. The System Test contains three subtests. Move the highlight bar to the subtest you want to execute and press **Enter**.

#### Subtest 01 FAN ON/OFF Checking

Select 1,2,3 to control FAN on/off, 1=Fan on, 2=Fan off, 3=Exit.

[BOIFAN2.EXE] Program Version: 1.0

1: Fan On 2: Fan Off 3: Exit

Fan1 Status On Fan1RPM: 5000 or Fan1 Status OFF Fan1RPM: 0 Fan2 Status On Fan2RPM: 2500 or Fan2 Status OFF Fan2RPM: 0

#### Subtest 02 Battery Test

This will display battery information for check, press [ESC] to exit.

[DOIDON EVELD				
[BOIPCU.EXE] Program Version: 1.0 03-27-2007				
voltage	: 12522 mV	Remaining capacity alarm	: 400 mAh	
temperature	: 24.4 'C	Remaining time alarm	: 10 min	
current	: 1330 mA	Battery mode	: 0	
average current	: 1327 mA	AtRate	: 0 mA	
relative state of charge	: 93 %	At rate time to full	: 65535 min	
absolute state of charge	: 89 %	At rate time to empty	: 65535 min	
remaining capacity	: 3546 mAh	At rate O. K.	: FFFF	
full charge capacity	: 3800 mAh	Maximun error	: 2 %	
run time to empty	: -1 min.	Charging current	: 2800 mA	
average time to empty	: -1 min.	Charging voltage	: 12600 mA	
average time to full	: 101 min.	Manufacturer name	: SANYO	
cycle count	: 10 times	Device name	: NS2P3SZDNVWR	
design capacity	: 4000 mAh	Device chemistry	: LION	
design voltage	: 11100 mV	Manufacturer data	: 0	
specification informatio	n: 2.1	Manufacture date	: 9/13/2005	
serial no.	: 32009			
STATUS	: INIT			

Press [ESC] KEY to exit

#### Subtest 03 CPU Temperature

This will display CPU Temperature for check, press [ESC] to exit.

[CPU\_TEMP.EXE] Program Version: 1.3 03-09-2009

CPU Temperature : XX GPU Temperature : XX

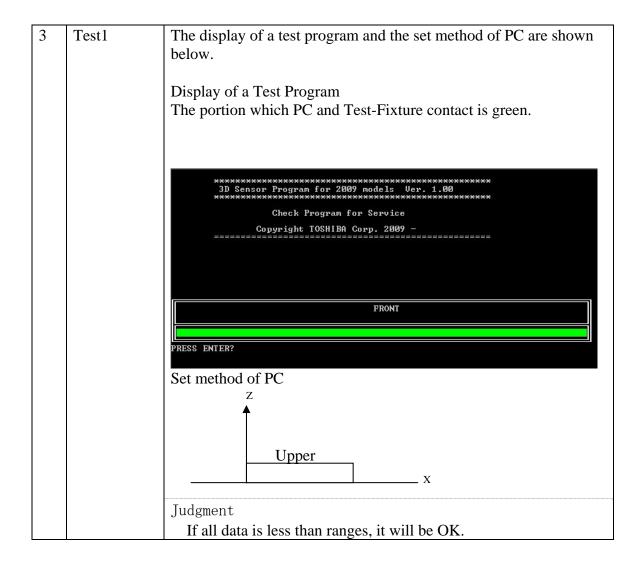
NOTES: If no external Graphics, GPU not report temperature.

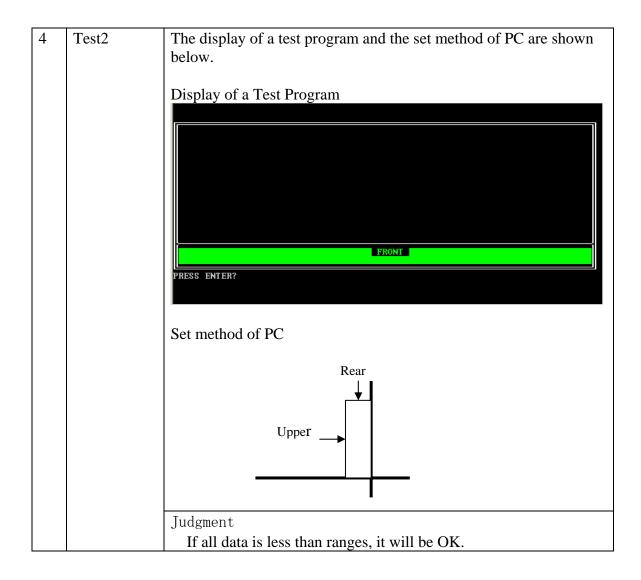
# Subtest 04 3D HDD Protection Test (90d)

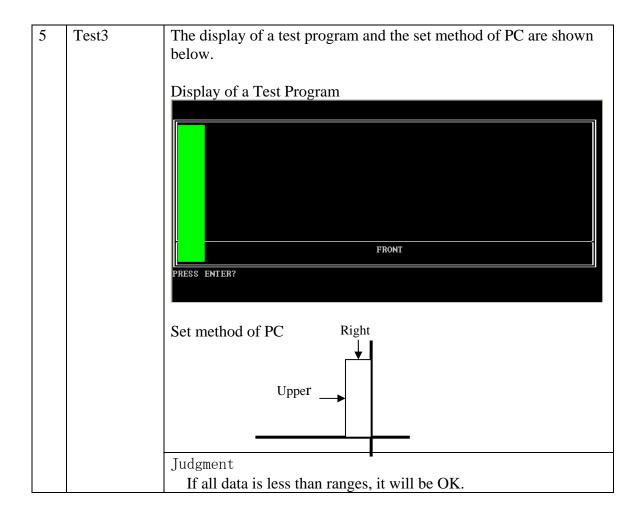
1. For Field inspection T&D.

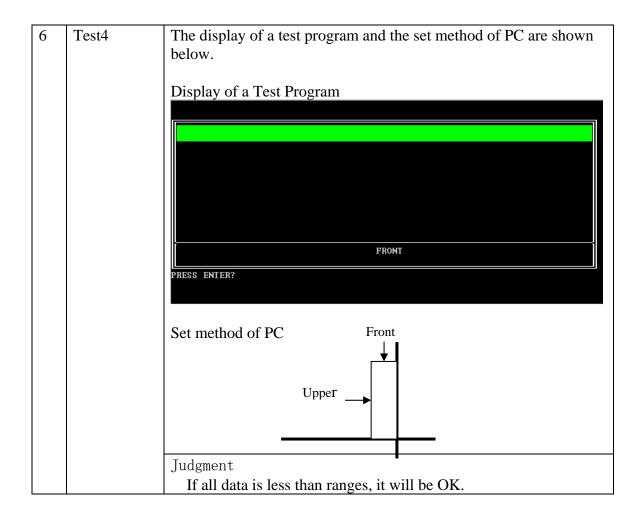
This program judges by sampling five kinds of data shown below.

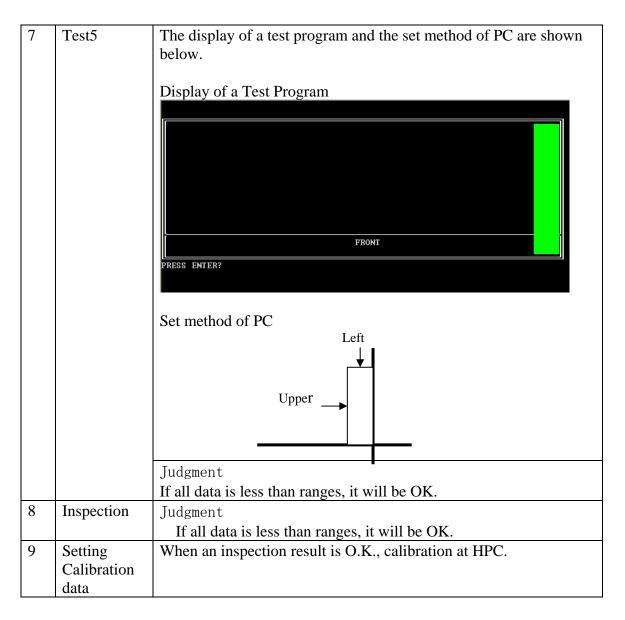
No	Item	Contents
1	Access	An access platform is leveling.
	platform.	
2	Test Fixture	The Fixture which fixes PC by 90 degree inclination is used.
		Vibration/shock doesn't take a PCB at the time of T&D inspection.











#### 2. Test Result

A test result is displayed when a test is completed. A display of result is O.K. or NG. And an error flag is returned at the end of a program.

OK is 0.

NG is 1.

# 3.5 Memory Test

To execute the Memory Test select **02** from the Diagnostic Test Menu, press **Enter** and follow the directions on the screen. The Memory Test contains five subtests that test the computer's memory. Move the highlight bar to the subtest you want to execute and press **Enter**.

**NOTE**: If **NO** is selected for Test Loop on the Test Parameter menu, the Test Status screen displays while the test is executing. When the test is complete the Memory Test menu displays.

If **YES** is selected for Test Loop on the Test Parameter menu, the Test Status screen displays while the test is executing. Press **Ctrl** + **break** to return to the Memory Test menu.

#### Subtest 01 Conventional Memory

This subtest first writes test data patterns to conventional memory (0 to 640 KB), then reads the new data and compares the result with the original data patterns.

If a compare error occurs, the write data, read data, and test address display on the screen. Addresses are displayed in 4KB increments during the test.

#### **Test Process:**

1. Byte Enable Test

One bit write/8 bit read" is executed and the new data is compared with the original data.

Test data = CCAA5533H, 80000000H

2. Byte Enable Test

"One bit write/16 bit read" is executed and the new data is compared with the original data.

Test data = CCAA5533H, 80000000H

3. Data bus test

"One bit write/16 bit read" is executed and the new data is compared with the original data.

Test data = 1H, 2H, 4H, 8H, 10H, through 80000000H.

4. Fixed data test.

"16 bit write/ 16 bit read" is executed and the new data is compared to the original data.

Test data = FFFFFFFH, 00000000H, 80018001H

#### 5. Address pattern test

"16 bit write and 16 bit read" of address pattern data is executed and the new data is compared with the original data.

Test data = 0000H, 0004H, 0008H, 000CH,...8000H, 8004H, through FFECH

#### Subtest 02 Protected Mode

This subtest first writes data patterns and address data from 1 to 32 MB, then reads the new data and compares the result with the original data patterns. Addresses are displayed in 64KB increments during the test.

#### Test Process:

#### 1. Byte Enable Test

One bit write/8 bit read" is executed and the new data is compared with the original data.

Test data = CCAA5533H, 80000000H

#### 2. Byte Enable Test

"One bit write/16 bit read" is executed and the new data is compared with the original data.

Test data = CCAA5533H, 80000000H

#### 3. Data bus test

"One bit write/16 bit read" is executed and the new data is compared with the original data.

Test data = 1H, 2H, 4H, 8H, 10H, through 80000000H.

#### 4. Fixed data test

"16 bit write/ 16 bit read" is executed and the new data is compared to the original data.

Test data = FFFFFFFH, 00000000H, 80018001H

#### 5. Address pattern test

"16 bit write and 16 bit read" of address pattern data is executed and the new data is compared with the original data.

Test data = 0000H, 0004H, 0008H, 000CH,...8000H, 8004H, through FFECH

#### Subtest 03 Protected Mode [32MB - MAX]

This subtest first writes data patterns and address data from 32MB to the maximum installed memory, reads the new data, and then compares the result

with the original data patterns. Addresses are displayed in 64KB increments during the test.

#### **Test Process:**

1. Byte Enable Test

One bit write/8 bit read" is executed and the new data is compared with the original data.

Test data = CCAA5533H, 80000000H

#### 2. Byte Enable Test

"One bit write/16 bit read" is executed and the new data is compared with the original data.

Test data = CCAA5533H, 80000000H

#### 3. Data bus test

"One bit write/16 bit read" is executed and the new data is compared with the original data.

Test data = 1H, 2H, 4H, 8H, 10H, through 80000000H.

#### 4. Fixed data test

"16 bit write/ 16 bit read" is executed and the new data is compared to the original data.

Test data = FFFFFFFH, 00000000H, 80018001H

#### 5. Address pattern test

"16 bit write and 16 bit read" of address pattern data is executed and the new data is compared with the original data.

Test data = 0000H, 0004H, 0008H, 000CH,...8000H, 8004H, through FFECH

#### Subtest 04 RAM Refresh

This subtest writes a data pattern (CCAA5533H) in 4KB from 0 to the maximum installed memory, then waits for a memory refresh cycle (16 ms or more), reads the new data, and compares the result with the original data pattern.

#### **Test Process:**

- 1. Checks the memory size to determine the maximum size of installed memory.
- 2. Tests memory addresses 0 to the maximum installed.
- 3. Writes, reads, and compares test data after a memory refresh cycle (16ms or more).

**NOTE:** There may be a short delay between write and read operations, depending on the memory size.

#### Subtest 05 Stress Test

This subtest writes the following 16KB data patterns to the Write/Read Buffer in conventional memory.

data:

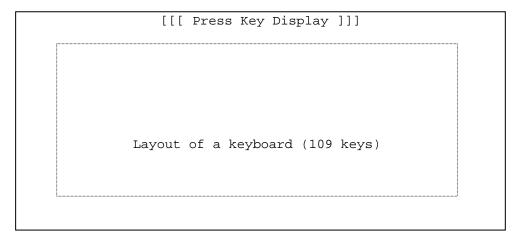
# 3.6 Keyboard Test

To execute the Keyboard Test select **03** from the Diagnostic Test Menu, press **Enter** and follow the directions on the screen. The Keyboard Test contains five subtests that test the computer's keyboard and mouse actions. Move the highlight bar to the subtest you want to execute and press **Enter**.

**NOTE**: The Test Loop and Error Stop parameters are not enabled for the Keyboard test.

#### Subtest 01 Pressed Key Display [109 Keyboard]

When you execute this subtest, the keyboard layout is drawn on the display. When any key is pressed, the corresponding key on the screen changes from light to dark. Holding a key down enables the auto-repeat function which causes the key's display character to blink.



Subtest 02 Pressed Key Display [105 Keyboard]

This subtest is used for the 105 keyboard and functions the same as Subtest 1.

Subtest 03 Pressed Key Display [104 Keyboard]

This subtest is used for the 104 keyboard and functions the same as Subtest 1.

Subtest 04 Hot Key Display [9 Key]

This subtest is used for the 9 hot key and functions the same as Subtest 1.

ECO MUTE MUSIC PLAY BACK NEXT VOL- VOL+ WLAN

Subtest 05 Hot Key Display [1 Key]

This subtest is used for the 1 hot key and functions the same as Subtest 1.

**WLAN** 

Subtest 06 PS/2 Mouse (Pointing)

This subtest checks the function of mouse as shown below.

A) Pointing device (mouse)

B) Mouse buttons

Please move cursor to upper left and press left button, screen will display <PRESS> in left rectangle, move cursor to lower right and press right button, screen will display <PRESS> in right rectangle, the program exit.

If left and right button short , screen will display <Left and Right Button maybe short > , the program exit .

LEFT
PRESS

TOUCH\_PAD TEST

RIGHT
PRESS

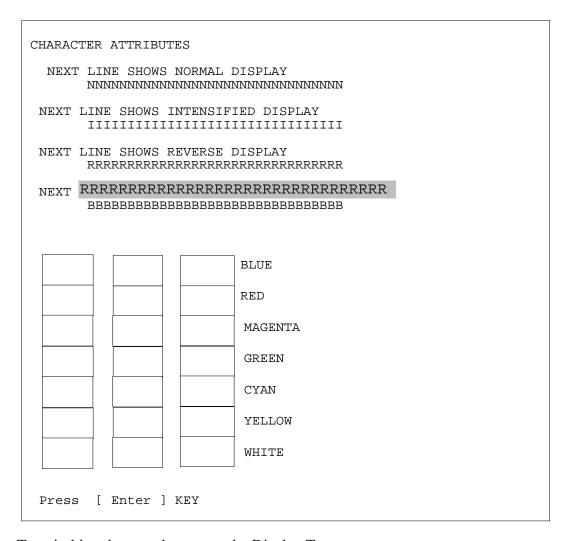
Please Do Not Press the Left and Right Button At The Same Time

# 3.7 Display Test

To execute the Display Test select **04** from the Diagnostic Test Menu, press **Enter** and follow the directions displayed on the screen. The Display Test contains twelve subtests that test the display in various modes. Move the highlight bar to the subtest you want to execute and press **Enter**.

#### Subtest 01 Character Attributes

This subtest displays character attributes and color attributes. The character attributes are: normal, intensified, reverse, and blinking. The color attributes are: blue, red, magenta, cyan, yellow, and white. These seven colors each display a background color, foreground color and high resolution color. The screen below displays when this subtest is executed.



To exit this subtest and return to the Display Test menu:

Press **Enter** if **NO** was selected for *Test Loop* on the Test Parameter Menu. Press **Ctrl** + **break** if **YES** was selected for *Test Loop* on the Test Parameter Menu.

#### Subtest 02 Character Set

This subtest displays the character codes 00H - FFH, using Mode 01H (40\*25). The screen below displays when this subtest is executed.

CHARACTER SET IN 40\*25

Press [Enter] Key

To exit this subtest and return to the Display Test menu:

### Subtest 03 80 \* 25 Character Display

This subtest uses 80\*25 video resolution to display character codes 20H - 7EH using Mode 03H (80\*25). The data displayed is shifted 1 byte to the left for each line as shown below.

```
80*25 CHARACTER DISPLAY
012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789001234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890123456789012345678901234567890
```

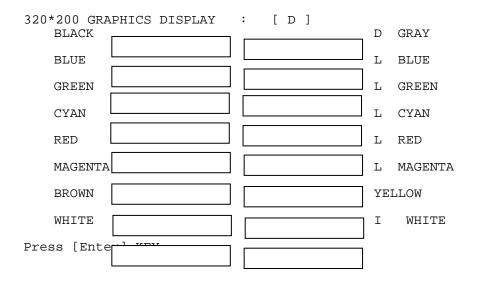
To exit this subtest and return to the Display Test menu:

# Subtest 04 320 \* 200 Character Display

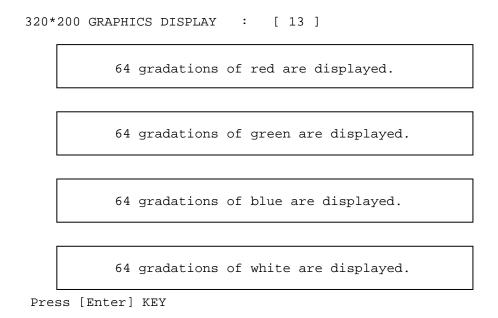
This subtest uses 320\*200 video resolution to display green, red and yellow followed by cyan, magenta, and white. The screen below shows the displays when this subtest is executed.

320 * 200 GRAPHICS		D.	IS:	PLAY					
CC	DLOR	SET	0	:	[	4	]		
		GRE Cy <i>i</i>		1				RED MAGENTA	YELLOW WHITE

Press **ENTER** to display the following sixteen colors: black, blue, green, cyan, red, magenta, brown, white, dark gray, light blue, light green, light cyan, light red, light magenta, yellow, and intensified white.



Press **ENTER** to display 64 gradations of red, green, blue and white on the screen



To exit this subtest and return to the Display Test menu:

## Subtest 05 640 \* 200 Character Display

This subtest uses 640\*200 video resolution to display three windows, each window drives a different set of dots: even dots, odd dots and all dots. The screen below displays when this subtest is executed.

640 \* 200 GRAPHICS DISPLAY : [ 6 ]

E	<b>J</b> EN	DOTS	ODD	DOTS	ALL	DOTS
	DRIV	EN	DR	IVEN	DRI	VEN

Press **ENTER** to display the following 16 colors: black, blue, green, cyan, red, magenta, brown, white, dark gray, light blue, light green, light cyan, light red, light magenta, yellow, and intensified white.

640*200 GRAPHICS DISPLAY :	[ E ]	
BLACK		DARK GRAY
BLUE		LIGHT BLUE
GREEN		LIGHT GREEN
CYAN		LIGHT CYAN
RED		LIGHT RED
MAGENTA		LIGHT MAGENTA
BROWN		YELLOW
WHITE		INTENSIFIED WHITE
Press [Enter] KEY		

To exit this subtest and return to the Display Test menu:

# Subtest 06 640 \* 480 Character Display

This subtest uses 640\*350 video resolution to display 16 colors: black, blue, green, cyan, red, magenta, brown, white, dark gray, light blue, light green, light cyan, light red, light magenta, yellow, and intensified white. The screen below displays when this subtest is executed.

640*350 GRA	PHICS DISPLAY	:	[10 ]			
BLACK					DARK	GRAY
BLUE				7	LIGHT	BLUE
GREEN				]	LIGHT	GREEN
CYAN				- ]	LIGHT	CYAN
RED I				] ]	LIGHT	RED
MAGENTA				]	LIGHT	MAGENTA
BROWN					YELLOW	Ī
WHITE					INTENS	SIFIED WHITE
Press [Ente						

Press **ENTER** to display the following 16 colors: black, blue, green, cyan, red, magenta, brown, white, dark gray, light blue, light green, light cyan, light red, light magenta, yellow, and intensified white using 640\*480 video resolution.

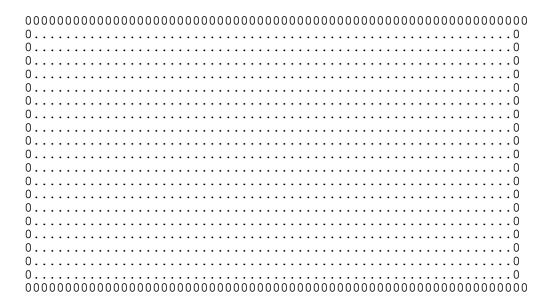
640*480 GRAI	PHICS DISPLAY	: [12]	
BLACK			DARK GRAY
BLUE			LIGHT BLUE
GREEN			LIGHT GREEN
CYAN			LIGHT CYAN
RED			LIGHT RED
MAGENTA			LIGHT MAGENTA
BROWN			YELLOW
WHITE			INTENSIFIED WHITE
Press [Enter]			

To exit this subtest and return to the Display Test menu:

## Subtest 07 Display Page

This subtest displays video pages zero through seven.

DISPLAY PAGE 0



To exit this subtest and return to the Display Test menu:

#### Subtest 08 "H" Pattern Display

This subtest displays a full screen of "H" patterns.

To exit this subtest and return to the Display Test menu:

Press **Enter** if **NO** was selected for *Test Loop* on the Test Parameter Menu. Press **Ctrl** + **break** if **YES** was selected for *Test Loop* on the Test Parameter Menu.

#### Subtest 9 Video DAC Register W/R/C

This subtest writes data patterns to the Video DAC register lookup table (PEL Address register), then reads the new data, and compares the result to the original data patterns. The original content of the Video DAC register is saved in RAM and restored after the test is completed.

The test data patterns are 00H,15H, 2AH and 3FH.

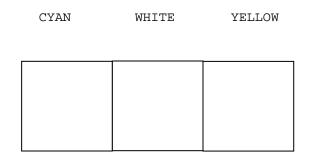
**NOTE**: If **NO** is selected for Test Loop on the Test Parameter menu, "Screen will remain blank" displays on the screen while the test is executing. When the test is complete the Display Test menu displays.

If **YES** is selected for Test Loop on the Test Parameter menu, "The Screen will remain blank" displays on the screen and then the screen flickers due to the fast screen refresh while the test is executing. Press **Ctrl** + **break** to return to the Display Test menu.

# Subtest 10 Color Graphics Display

This subtest displays three colors, cyan, white and yellow on the screen as shown below.

640 \* 480 GRAPHICS DISPLAY

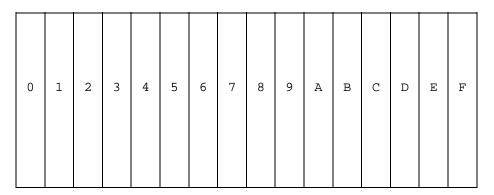


To exit this subtest and return to the Display Test menu:

## Subtest 11 Color Attributes Display

This subtest displays 16 colors: black, blue, green, cyan, red, magenta, brown, white, dark gray, light blue, light green, light cyan, light red, light magenta, yellow, and intensified white. The screen below displays when this subtest is executed.

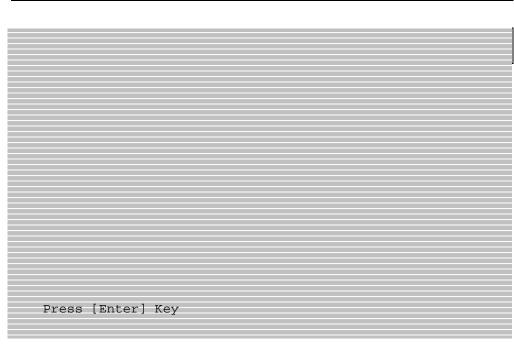
640\*480 COLOR ATTRIBUTE DISPLAY



Press [Enter] Key

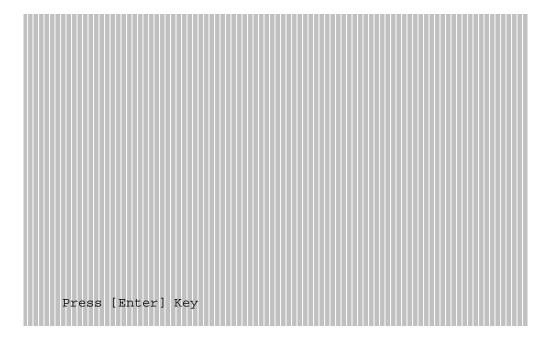
Pressing **Enter** executes VRAM mapping test which indicates vertical lines

Press **Enter** to execute the VRAM mapping test which displays a horizontal line at one dot intervals using Mode 12.



**NOTE:** The following screen does not display correctly. It will be amended in the next version.

Press **Enter** to execute the VRAM mapping test which displays a vertical line at four dot intervals using Mode 12.



Press **Enter** to display VRAM mapping test using the all dots Mode.

Press [Enter] Key

To exit this subtest and return to the Display Test menu:

# Subtest 12 Color Tiling

This subtest displays black, gray, white, and 3 gradations of red, green, and blue as shown in the following display.

Black	Red	Green	Blue
Gray	Red	Green	Blue
	Gradation	Gradation	Gradation
White	Red	Green	Blue
	Gradation	Gradation	Gradation

To exit this subtest and return to the Display Test menu:

# 3.8 Floppy Disk Test

**CAUTION**: Before running the floppy disk test, prepare a formatted work disk. Remove the diagnostics disk and insert the work disk into the FDD. The contents of the floppy disk will be erased.

To execute the Floppy Disk Test select 05 from the Diagnostic Test Menu, press **Enter** and follow the directions on the screen. The Floppy Disk Test contains five subtests that test the FDD. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 Sequential Read

This subtest sequentially reads all the tracks (Tracks 0 to 79) on the floppy disk.

Subtest 02 Sequential W/R/C

This subtest continuously writes the data pattern B5ADADh to all the specified tracks selected in Subtest 01. The data pattern is then read and compared to the original data.

Subtest 03 Random Address/Data

This subtest writes random data to random addresses on all tracks defined in Subtest 01. The data is then read and compared to the original data.

### Subtest 04 Write Specified Address

**NOTE**: The first two digits of the ADDRESS indicate which track is being tested, the next two digits indicates the head, and the last two digits indicate the sector.

This subtest allows you to verify the errors from Subtest 02. It writes specified data to a specified track and head. Use the Log Utilities (see Section 3.21) to specify the track number and head number where the error(s) occurred during Subtest 02. The following message displays on the screen to enter the test data, track number, and head number.

```
TEST DATA ??
TRACK NO (00~79) ??
HEAD NO (0~1) ?
```

## Subtest 05 Read Specified Address

This subtest reads data from a specified track and head.

The following message displays on the screen to enter the test track number and head number.

```
TRACK NO (00~79) ?? HEAD NO (0~1) ?
```

#### 3.9 Hard Disk Test

To execute the Hard Disk Test select **06** from the Diagnostic Test Menu, press **Enter** and follow the directions on the screen. The Hard Disk Test contains eight subtests that test the functions of the hard disk drive. Move the highlight bar to the subtest you want to execute and press **Enter**.

**NOTES**: The contents of the hard disk will be erased when subtest 02, 03, 04, 05, 07 or 08 is executed. Before running the test, transfer the contents of the hard disk to other disk.

A password is necessary to execute the Hard Disk Test. The password is: hard disk

## Subtest 01 Sequential Read

This subtest sequentially reads all the tracks on the HDD starting at track 0. When all tracks have been read, the test starts at the maximum track and reads sequentially back to track 0.

## Subtest 02 Address Uniqueness (This subtest need very long time)

This subtest writes unique address data to each sector of the HDD track-by-track. The data written to each sector is then read and compared with the original data. There are three ways the HDD can be read:

- Forward sequential
- Reverse sequential
- Random

#### Subtest 03 Random Address Data

This subtest writes random data to 1000 different random addresses on the HDD. This data is then read and compared to the original data.

#### Subtest 04 Cross Talk and Peak Shift

This subtest writes eight of the most likely to fail data patterns (shown below) to a cylinder on the HDD, then reads the data while moving from cylinder to cylinder.

# Data Pattern B5ADADH 4A5252H EB6DB6H 149249H 63B63BH 9C49C4H 2DB6DBH

## Subtest 05 Write Specified Address

D24924H

**NOTE:** This subtest is designed to run with the Test Loop set to **NO**. This subtest is a debug tool and the operator should enter the Test Parameters each time.

This subtest allows you to verify the errors from Subtest 01. It writes specified data to a specified LBA. Use the Log Utilities (see Section 3.18) to specify the LBA number where the error(s) occurred during Subtest 01. The following

message displays on the screen to enter the test data, and Sector count.

```
TEST DATA ??
SECTOR COUNT (01~39) ??
START ADDRESS (00000000~MAX Address) ?
```

### Subtest 06 Read Specified Address

**NOTE:** This subtest is designed to run with the Test Loop set to **NO**. This subtest is a debug tool and the operator should enter the Test Parameters each time.

This subtest allows you to verify the errors from Subtest 01. It reads specified data (Subtest 06) from a specified LBA. Use the Log Utilities (see Section 3.18) to specify the LBA number where the error(s) occurred during Subtest 01. The following message displays on the screen to enter the test sector count.

```
SECTOR COUNT (01~39) ??
START ADDRESS (00000000~MAX Address) ?
```

## Subtest 07 Sequential Write

This subtest writes specified data to all cylinders on the HDD. The following message displays on the screen to enter the test data.

```
TEST DATA ????(=37b3H)
```

## Subtest 08 W-R-C Specified Address

This subtest writes specified data to a specified sector count, then reads and compares the result. The following message displays on the screen to enter the test data, sector count.

```
TEST DATA ????(=37b3H)
SECTOR COUNT (01~39) ??
START ADDRESS (00000000~Max Address) ?
```

#### 3.10 Real Time Clock Test

To execute the Real Time Clock Test select **07** from the Diagnostic Test Menu, press **Enter** and follow the directions on the screen. The Real Time Clock Test contains three subtests that test the computer's real time functions. Move the highlight bar to the subtest you want to execute and press **Enter**.

#### Subtest 01 Real Time

This subtest allows you to change the date and time. To execute the Real Time Subtest, follow these steps:

1. Select Subtest **01** and the following displays:

```
[ REAL TIME TEST ]

Current date : mm-dd-yyyy

Current time : hh:mm:ss

Enter new date : mm-dd-yyyy

Enter new time : hh:mm:ss

Press [Enter] key to exit test
```

2. If the current date is not correct, enter the correct date at the "Enter new date" prompt and press **Enter**. The following prompt displays:

```
Enter new time :
```

3. If the current time is not correct, enter the correct time using a 24-hour format and press **Enter**.

**NOTE**: If **NO** is selected for Test Loop on the Test Parameter menu, the Real Time Clock Test menu displays.

If **YES** is selected for Test Loop on the Test Parameter menu, the screen above displays and the test is executed again. Press **Ctrl** + **break** to return to the Real Time Clock Test menu.

## Subtest 02 Backup Memory

This subtest writes 50 bytes of test data (FFH, AAH, 55H, and 00H) to the CMOS 14<sup>th</sup> address, then reads the new data and compares it to the original data.

### Subtest 03 Real Time Carry

**CAUTION**: When this subtest is executed, the current date and time are reset.

This subtest checks the clock's carry function.

```
[ REAL TIME CARRY TEST ]

Current date : 12-31-1999

Current time : 23:59:55

Press [Enter] key to exit test
```

The following is the display after the date carry function is executed.

```
[ REAL TIME CARRY TEST ]

Current date : 01-01-2000

Current time : 00:00:01

Press [Enter] key to exit test
```

To exit this subtest and return to the Real Time Clock menu:

# 3.11 Cache Memory Test

To execute the Cache Memory Test select **08** from the Diagnostic Test Menu, press **Enter** and follow the directions on the screen. The Cache Memory Test contains eight subtests that test the computer's cache memory. Move the highlight bar to the subtest you want to execute and press **Enter**.

**NOTE**: If **NO** is selected for Test Loop on the Test Parameter menu, the screen will remain blank while the subtest is executing. When the test is complete the Cache Memory Test menu displays.

If **YES** is selected for Test Loop on the Test Parameter menu, the Test Status screen displays while the subtest is executing. Press **Ctrl** + **break** to return to the Cache Memory Test menu.

#### Subtest 01 Constant Data Test

This subtest reads the contents of cache memory and saves it into RAM. The subtest then writes constant data (FFFFH, AAAAH, 5555H, 0101H, 0000H), reads the new data and compares the result with the original data pattern. The original cache memory content is then restored to the cache memory.

### Subtest 02 Address Pattern Test

This subtest reads the contents of cache memory and saves it into RAM. The subtest then writes address data patterns (0000H, 0001H, 0002H, through 3FFDH, 3FFEH, 3FFFH), reads the new data and compares the result with the original data. The original cache memory content is then restored to the cache memory.

#### Subtest 03 Increment/Decrement Test

This subtest reads the contents of cache memory and saves it into RAM. The subtest then writes the increment data (00H, 01H, 02H, through FDH, FEH, FFH), reads the new data and compares the result with the original data. After comparing the incremental data, decrement data (FFH, FEH, FEH, through 02H, 01H, 00H) is written and the new data is read and compared with the original data. The original cache memory content is then restored to the cache memory.

#### Subtest 04 Bit Shift Pattern Test

This subtest reads the contents of cache memory and saves it into RAM. The subtest then writes the bit shift data patterns (1 bit shifted every 4 bytes), reads the new data and compares the result with the original data. The original cache memory content is then restored to the cache memory.

### Subtest 05 Write Disturb Test (We can't support this time)

This subtest reads the contents of cache memory and saves it into RAM. The subtest then writes the "write disturb data," reads the new data and compares the result with the original data. The original cache memory content is then restored to the cache memory.

### Subtest 06 Checker Board Test

This subtest reads the contents of cache memory and saves it into RAM. The subtest then writes the "checker board data," (data which is inverted front/back and left/right) reads the new data and compares the result with the original data. The original cache memory content is then restored to the cache memory.

## Subtest 07 Marching Test

This subtest reads the contents of cache memory and saves it into RAM. The subtest then writes the "marching data," (00H through 01H and 01H through 00H) reads the new data and compares the result with the original data. The original cache memory content is then restored to the cache memory.

### Subtest 08 Working Data Test

This subtest reads the contents of cache memory and saves it into RAM. The subtest then writes the "working data," reads the new data and compares the result with the original data. The original cache memory content is then restored to the cache memory.

# 3.12 High Resolution Display Test

To execute the High Resolution Display Test select **09** from the Diagnostic Test Menu, press **Enter** and follow the directions on the screen. The High Resolution Display Test contains six subtests that test the computer's high resolution video display. Move the highlight bar to the subtest you want to execute and press **Enter**.

#### Subtest 01 VRAM W/R/C Test

This subtest writes address and data patterns to Video RAM, then reads the values from the Video RAM and compares them to the original test patterns. During the execution of this test 13 different color screens display: black, green, green, blue, blue, red, red, red, black, white, pink, cyan, and black.

#### **Test Process:**

- 1. Sets the video display to 1024\*768 mode
- 2. Bank change test
  Writes 1 byte data in order 0.1 through Fh. an
  - Writes 1 byte data in order 0, 1, through Fh, and compares the result, at every bank, to the original data patterns.
- 3. Bit shift data test

Writes 01h data into addresses A000:0000h through A000:FFFFh for each bank, reads the new data and, then compares the results with the original data. Data is then shifted 1 bit to the left, and all bits (01h, 02h, 04h, 08h, through 80h) are tested again.

4. Fixed data test

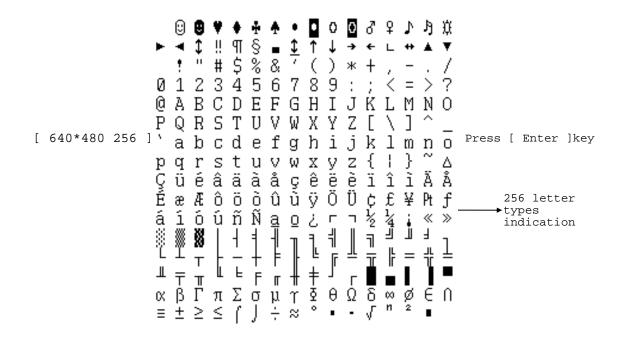
Writes test data (in order FFh, AAh, 55h, 00h) into addresses A000:0000h through A000:FFFFh for each bank by, reads the new data and, then compares the results with the original data. Data is then shifted 1 bit to the left, and all bits are tested again

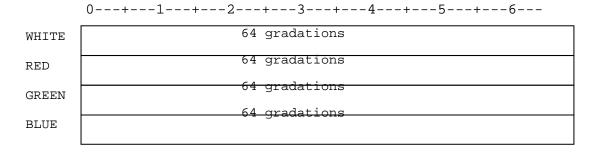
**NOTE:** If **NO** is selected for Test Loop on the Test Parameter menu, the screen displays the colors listed above and then the High Resolution Display Test menu displays.

If **YES** is selected for Test Loop on the Test Parameter menu, the screen displays the colors listed above. Press **Ctrl** + **break** to return to the High Resolution Display Test menu.

## Subtest 02 640\*480 Mode Display

This subtest uses 640\*480 video resolution to display a high resolution white frame, 256 letter types (8\*16 pixels) and 64 gradations of white, red, green, and blue as shown below.

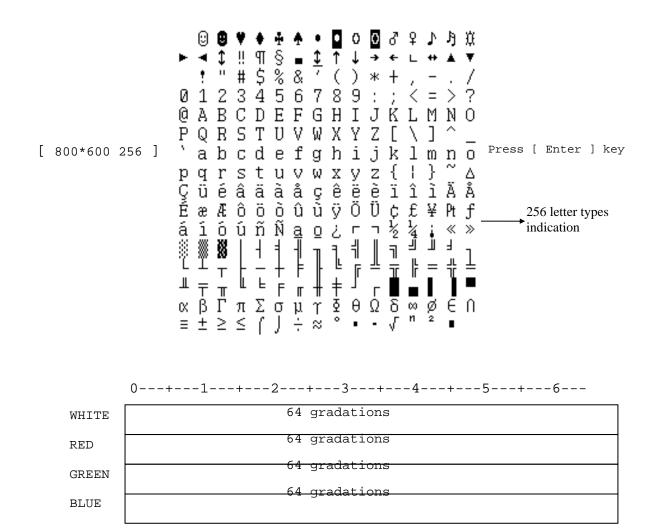




To exit this subtest and return to the High Resolution Display Test menu:

Subtest 03 800 \* 600 Mode Display

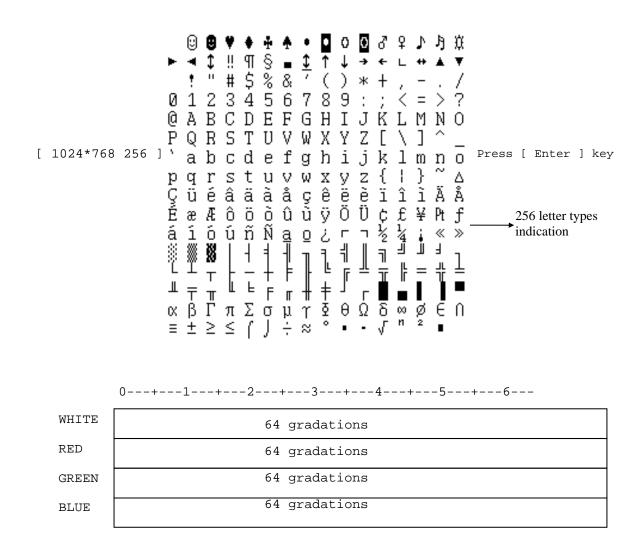
This subtest uses 800\*600 video resolution to display a high resolution white frame, 256 letter types (8\*16 pixels) and 256 gradations of white, red, green, and blue as shown below.



To exit this subtest and return to the High Resolution Display Test menu:

## Subtest 04 1024\* 768 Mode Display

This subtest uses 1024\*768 video resolution to display a high resolution white frame, 256 letter types (8\*16 pixels) and 64 gradations of white, red, green, and blue as shown below.



To exit this subtest and return to the High Resolution Display Test menu:

## Subtest 05 "H" Pattern Display

This subtest uses the 1024\*768 Mode to display a high resolution white frame, "H" letters (8\*16 pixels fonts), at 128 letters by 48 lines.

To exit this subtest and return to the High Resolution Display Test menu:

### Subtest 06 Focus Test ("E" Pattern)

This subtest sets the 1024\*768 Mode and displays "E" patterns (18\*18 dot fonts), at 56 letters \*42 lines surrounded by a high resolution white frame.

IEMEMEMEMEMEMEMEMEMEMEMEME ıEmEmEmEmEmEmEmEmEmEmEmEmE W3W3W3W3W3W3W3W3W3W3W3W3W3W3W ·Em Em E W3W3W3W3W3W3W3W3W3W3W3W3W3W W3W3W3W3W3W3W3W3W4W4W4W4W **ШЗШЗШЗШЗШЗШЧШЧШЧШЧШЧШЧШЧШ** ıEmEmEmEmEmEmEmEmEmEmEmEmE M3M3M3M3M3M3M3M3M3M3M3M3M3M ı Em Em Em Em Em Em Em Em Em Fm Fm Fm F M3M3M3M3M3M3M3M3M3M3M3M3M3M M3M3M3M3M3M3M3M3M3M3M3M3M3M M3M3M3M3M3M3M3M3M3M3M3M3M3M3M 1EmEmEmEmEmEmEmEmEmEmEmEmEmE <u> МЭМЭМЭМЭМЭМЭМЭМЭМЭМЭМЭМЭМ</u> <u> ШЭШЭШЭШЭШЭШЭШЭШЭШЭШЭШЭШ</u> 1EmEmEmEmEmEmEmEmEmEmEmEmEmE M3M3M3M3M3M4M4M4M4M4M4M4M4M 1EMEMEMEMEMEMEMEMEMEMEMEMEME

To exit this subtest and return to the High Resolution Display Test menu:

### 3.13 Multimedia Test

To execute the Multimedia Test select **10** from the Diagnostic Test Menu, press **Enter** and follow the directions on the screen. The Multimedia Test contains four subtests that test the computer's multimedia functions. Move the highlight bar to the subtest you want to execute and press **Enter**.

NOTE: Use the Toshiba Backup CD-ROM for Subtests 01, 02, and 03.

Because CDROM driver issue, the Multimedia function can't test, this is limitation.

## Subtest 01 Sequential Read Test

This subtest sequentially reads one block unit (2K bytes) of all logical addresses from the test CD.

**NOTE**: If **NO** is selected for Test Loop on the Test Parameter Menu, the screen will remain blank while the subtest is executing. When the test is complete the Multimedia Test menu displays.

If **YES** is selected for Test Loop on the Test Parameter Menu, the Test Status screen displays while the subtest is executing. Press **Ctrl** + **break** to return to the Multimedia Test menu.

#### Subtest 02 Random Read Test

This subtest randomly reads all addresses.

### Subtest 03 Read Specified Address Test

This subtest reads data from a specified block of addresses.

The following message displays on the screen to enter the start and end block addresses:

```
START BLOCK ADDRESS ? END BLOCK ADDRESS ?
```

#### Subtest 04 1 Point W/R/C (R/RW Media)

**NOTE**: Use CD-R or CD-RW, the CD-ROM and DVD cannot be used for this subtest, and some DVD-dual can't support this test.

This subtest writes specified data to a specified block count, then reads and compares the result.

### 3.14 MEMORY2 Test

To execute the Expansion Test select **11** from the Diagnostic Test Menu, press **Enter** and follow the directions on the screen. The MEMORY2 Test contains four subtests that test the computer's. Move the highlight bar to the subtest you want to execute and press **Enter**.

**NOTE**: If **NO** is selected for Test Loop on the Test Parameter menu, the Test Status screen displays while the test is executing. When the test is complete the Memory Test menu displays.

If **YES** is selected for Test Loop on the Test Parameter menu, the Test Status screen displays while the test is executing. Press **Ctrl** + **break** to return to the Memory Test menu

#### Subtest 01 All one/All zero test

This subtest performs pseudorandom data read/write. The data consists of "all ones"/"all zero" patterns produced by pseudorandom sequence generator. The test checks address error.

## Subtest 02 Walking 1/Walking 0 test (Left)

This subtest uses "running one"/"running zero" patterns. This test sequence allows also to checking system bus in maximum noise conditions. The following test sequence is written.

7FFF7FFF7FFF8000800080008000 BFFFBFFFBFFFBFFF4000400040004000

After all the memory being tested is filled with the pattern, it is read in descanting direction and compared with reference data. As the memory is read, the data is replaced with inverse test pattern. After all the memory is read and replaced with inverted pattern, it is read in descanting direction and compare with new reference data. As the memory is read, the data is replaced with next pattern, which is like first one shifted to right.

### Subtest 03 Walking 1/Walking 0 test (Right)

Tee test method is the same as Subtest2. However, the data to be used differs.

80008000800080007FFF7FFF7FFF7FFF 4000400040004000BFFFBFFFBFFF

#### Subtest 04 Walking 1/Walking 0 test (Left/ Right)

Tee test method is the same as Subtest2. However, the data to be used differs.

7FFF7FFF7FFF8000800080008000 BFFFBFFFBFFFBFFF4000400040004000 DFFFDFFFDFFFDFFF2000200020002000

FFFBFFFBFFFBFFFB0004000400040004 FFFDFFFDFFFDFFFD0002000200020002 FFFEFFFEFFFEFFFE0001000100010001 80008000800080007FFF7FFF7FFF 4000400040004000BFFFBFFFBFFF

 $\begin{array}{c} 0004000400040004 \\ FFBFFBFFBFFB\\ 0002000200020002 \\ FFDFFDFFFDFFFD\\ 0001000100010001 \\ \end{array}$ 

# 3.15 Error Codes and Error Status Names

The following table lists the error codes and error status names for the Diagnostic Tests.

\*Table 3-2 Error codes and error status names (1/2)\*

Device Name	Error Code	Error Status Name
(Common)	FF	Data Compare Error
Memory	02	Protected Mode Not Changed
	??	Other Error
FDD	01	Bad Command Error
	02	Address Mark Not Found
	03	Write Protected
	04	Record Not Found
	06	Media Change Line Error
	08	DMA Overrun Error
	09	DMA Boundary Error
	0C	Select Media Error
	10	CRC Error
	20	FDC Error
	40	Seek Error
	80	Time Out Error
	??	Other Error
HDD	01	Bad Command Error
	02	Bad Address Mark Error
	04	Record Not Found
	05	HDC Not Reset Error
	07	Drive Not Initialized
	09	DMA Boundary Error
	0A	Bad Sector
	0B	Bad Track Error
	10	ECC Error
	11	ECC Recover Enabled
	20	HDC Error
	40	Seek Error
	80	Time Out Error
	AA	Drive Not Ready

Table 3-2 Error codes and error status names (2/2)

Device Name	Error Code	Error Status Name
HDD	BB	Undefined Error
	CC	Write Fault
	E0	Status Error
	F0	No Sense Error
	??	Other Error
Cache Memory	02	Protect Mode Error
	03	Caching Error
	??	Other Error
Multimedia	01	Write Error
	0F	Invalid Drive
	15	Drive Not Ready
	??	Other Error

 $\it NOTE: If error status name is {\it Other Error}$ , please reference the {\it Error Code} for error information

# 3.16 Running Test

#### **NOTES**:

- 1. You may add or delete subtests using the Running Test Edit Item function, see Section 3.20.
- 2. Do not forget to insert a work disk in the FDD. If a work disk is not inserted an error will be generated during the Floppy Disk Test.
- 3. If the test completes successfully an "PASS" sign with blue letters displays on the screen.
- 4. If the test fails or is interrupted before completion an "FAIL" sign with red letters displays on the screen.
- 5. If running item not select an "NOITEM" sign with green letters display on the screen.
- 6. All errors which occur during execution of the Running Test are logged in the Log File.
- 7. This program is executed according to the Count Loop number selected in the Running Test Edit Item, see Section 3.20. To terminate the program, press Ctrl + Break.

#### 3.17 DMI INFOEMATION

Select **03** from the Diagnostics Menu and press **Enter** to Check or Write DMI Information Data:

#### 3.17.1 Check DMI Information

The Check DMI Configuration program contains the following configuration information for the computer:

**NOTE:** Please set the media of DVD before starting a test.

AHCI cannot control under the DOS

#### **System information (Type 1)**

- 1. Manufacture : TOSHIBA
- 2. Product Name: Satellite XXXXXX
- 3. Version :(TOSHIBA Part Number)
- 4. Serial Number: Serial Number
- 5. UUID Number: xxxxxxxxxxxxxxxxxxxxxxxxxxxxxxx

#### **OEM Strings (Type 11)**

1. OEM String : xxxxxxxxxxxxxxxxxxxxxxxxxxxx

#### On Board LAN MAC

1. MAC ADR: xxxxxxxxxxxx

#### **DVD Region Code**

User Change Time : X
 Region Code : X

#### 3.17.2 Write DMI Information

The Write DMI Information program contains the following information for the computer:

- 1. Manufacture Name (TOSHIBA)
- 2. Product Name (Satellite XXXXXX)
- 3. Part Number ( PSP50X-XXXXXX )
- 4. Serial Number (12345678W)
- 5. OEM String ( PSP50X-XXXXX,SXXXXXXXXX )
- 6. Model Select [1]Dyn-Jpn [2]Tos-Jpn [3]Tos-Eng [4]Tos-FR
- 7. Write UUID ( XXXXXXXXXXXXXXX )
- 8. Brightness Write (XXXXXXXX)
- a. SLP2.0 Build Sig [1]Non OS [2]OS

- b. Wireless LAN ID ( 001E4CXXXXXX )
- c. AC Adapter Select [1]65W [2]75W [3]90W [4]120W

Select  $1 \sim c$  to keyin new data, select 0 to exit program, program will compare input data length with the max length, if over will retry keyin

Note: Please Check New DMI Information After System Restart!! V3.2

- 1. \*\*\*\* Manufacture Name (TOSHIBA) (32)
- 2. \*\*\*\* Product Name (Satellite XXXXXX) (32)
- 3. \*\*\*\* Part Number ( PSP50X-XXXXXX ) (26)
- 4. \*\*\*\* Serial Number ( 12345678W ) (32)
- 5. \*\*\*\* OEM String ( PSP50X-XXXXX,SXXXXXXXXX ) (64)
- 6. \*\*\*\* Model Select [1]Dyn-Jpn [2]Tos-Jpn [3]Tos-Eng [4]Tos-FR (2)
- 7. \*\*\*\* Write UUID ( XXXXXXXXXXXXXXX ) (16)
- 8. \*\*\*\* Brightness Write (XXXXXXXXX) (8)
- a. \*\*\*\* SLP2.0 Build Sig [1]Non OS [2]OS-(2)
- b. \*\*\*\* Wireless LAN ID ( 001E4CXXXXXX ) –(12)
- c. \*\*\*\* AC Adapter Select [1]65W [2]75W [3]90W [4]120W -(1)
- 0. \*\*\*\* Exit

Please Select (1 ~ c) To Modify DMI String:

Current Data of EEPROM: Toshiba

1. Enter the Manufacture Name: TOSHIBA

Your Keyin is : TOSHIBA ..... This is your keyin data

EEPROM return: TOSHIBA ...... This is read from eeprom back

Press any key to continue

Note: Please Check New DMI Information After System Restart!!

If Keyin length too long will retry:

Current Data of EEPROM: 12345678WU
4. Enter the Serial Number: 12345678901234
Your Keyin String Length Not Correct 14 > 10!!!

Current Data of EEPROM: 12345678WU

4. Enter the Serial Number:

NOTE: The SLP2.0 is Microsoft SPEC, call "System Locked Pre-Installation" or "SLP",

It is for OEM pre install Windows and no need to Active, If you select Non OS, then you need to Active your OS before you use.

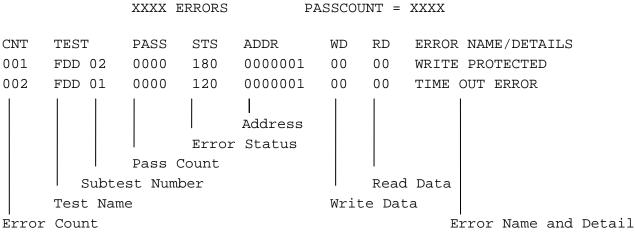
#### 3.18 Log Utilities

This function logs error information generated while a test is in progress and stores the results in RAM (Maximum error log: 500 times). This function can store data on a floppy disk. If the power switch is turned off, the error information will be lost. Error information is displayed in the following order:

- 1. Error count (CNT)
- 2. Test name and subtest number (TEST)
- 3. Pass count (PASS)
- 4. Error status (STS)
- 5. FDD/HDD or memory address (ADDR)
- 6. Write data (WD)
- 7. Read data (RD)
- 8. Error Name (ERROR NAME/DETAILS)

#### 3.18.1 Operations

1. Select **04** and press **Enter** in the Diagnostics Menu to log error information into RAM or onto a floppy disk. Error information is displayed in the following format:



[[1:Next, 2:Prev, 3:Exit, 4;Clear, 5:FD Log Read, 6:FD Log Write, 7:Log Save]]

- 2. Error information displayed on the screen can be manipulated with the following number keys:
  - The **1** key scrolls the display to the next page.
  - The 2 key scrolls the display to the previous page.
  - The 3 key returns to the Diagnostics Menu.
  - The 4 key erases all error log information in RAM.
  - The **5** key reads the log information from a floppy disk.
  - The 6 key writes the log information to a floppy disk.
  - The **7** key save the log information to a floppy disk.

The following are the test abbreviations for each Diagnostics Test.

Test Name	<b>Test Abbreviations</b>
System Test	ROM
Memory Test	RAM
Keyboard Test	KBD
Display Test	CRT
Floppy Disk Test	FDD
Hard Disk Test	HDD
Real Time Clock Test	RTM
Cache Memory Test	CAH
Height Resolution Display Test	KIF
Multimedia Test	MLT
Memory2 Test	RAM

# 3.19 System Configuration

Select **05** from the Diagnostics Menu and press **Enter** to display the following system configuration:

Press **Enter** to return to the Diagnostics Menu.

# 3.20 Running Test Edit Item

#### 3.20.1 Function Description

Function description lets you add or delete the subtests used to execute the Running Test. The following screen displays after pressing the **Tab** key to edit an item in the Running Test.

KEY OPERATION

Ursor Down
Cursor Up
PgDn Page Down
PgUp Page Up
Home Top of ITEM
End End of ITEM
Ins Insert ITEM
Del Delete ITEM
Enter End

#### 3.20.2 Operation Description

Select **05** from the Diagnostics Menu and press **Enter** to display the following:

	Test	Item Editor	[RUNNING TEST]
Loop Count	: (1-65535, 0 = infinity	00000	Error Stop NO
T-No	Test Name	S-No	Subtest Name
01	System Test	Subtest 01	ROM Checksum
02	Memory Test	Subtest 01	Conventional Memory
02	Memory Test	Subtest 02	Protect Mode
02	Memory Test	Subtest 03	Protect Mode (32MB Max)
02	Memory Test	Subtest 04	RAM Refresh
04	Display Test	Subtest 01	VRAM W/R/C
04	Display Test	Subtest 02	Character Attribute Set
04	Display Test	Subtest 03	Character Set
04	Display Test	Subtest 04	80 * 25 Character Display
04	Display Test	Subtest 05	320 * 200 Graphics Display
04	Display Test	Subtest 06	640 * 200 Graphics Display
04	Display Test	Subtest 07	640 * 480 Graphics Display
04	Display Test	Subtest 08	Display Page
05	Floppy Disk Test	Subtest 02	Sequential W/R/C
08	Hard Disk Test	Subtest 01	Sequential Read
08	Real Time Clock Test	Subtest 02	Backup Memory Test

Tab: HELP (Key Operation)

1. Enter a **number** or **0** for **Loop Count** and press **Enter**.

Select a number from 1 to 65535 to define the number of times the Running Test executes.

Select 0 to run the test continuously until halted by the user.

2. Select the **NO** or **YES** for **Error Stop** and press **Enter**.

Select **NO** to keep the test running even if an error is found. Select **YES** to stop the test program when an error is found.

**NOTE:** All errors which occur during execution of the Running Test are logged in the Log File.

- 3. Press **Insert** to add a subtest.
- 4. Press **Delete** to remove the selected subtest.
- 5. Press **Enter** when you have finished editing the Running Test list.
- 6. The following message displays:

```
Do you want to save the data?

Save to disk
Do not save
```

- 7. Select the option and press **Enter**.
- 8. Select **03** from the Diagnostics Menu and press **Enter** to execute the Running Test.

**NOTE:** If press **Ctrl+break** in the runin process, please press more one any key to exit.

#### 3.21 Common Tests and Operation

#### 3.21.1 How to operate a window

To input parameters, or open a window use the following keys.

[Enter] key : to select an item at the highlight bar

[Esc] key : to close the current window and go back to the previous

window

#### 3.21.2 How to Stop the Test Program

To stop a test:

[Ctrl]+[Break] Press the Ctrl key and the Break key simultaneously.

#### 3.21.3 Test Status Screen

**NOTE**: The Test Status Screen does not display during all the tests. See the specific test description Sections 3.4 through 3.14.

The following Test Status screen displays during most tests. See the description of each test Sections 3.4 through 3.14 for specific screen information.

Test Name Displays the name of the test being executed.

Subtest No. Displays the Subtest number in the following format:

68

Pass Count Displays the number of times the test has been executed.

Error Count Displays the number of errors which have occurred during the test.

Write Data Displays only the test data that has failed to compare during the

test while being written during the test.

Read Data Displays test data that has failed to compare during the test while

being read during the test.

Test Address Displays the Test Address. (The format differs for each test.)

Error Status Displays the error status.

Error Name Displays the name of the error.

#### 3.21.4 Test Stop Display

If an error occurs during a Subtest and YES is selected for Error Stop, the following message displays:

[HALT OPERATION]

- 1. Test end
- 2. Continue
- 3. Retry

The three selections have the following functions:

- 1: Terminates the test program and exits to the subtest menu.
- 2: Continues the test from the error.
- 3: Restarts the test from the beginning.

Use the arrow keys to move the cursor to the desired option and press Enter.

#### 3.21.5 How to enter data

Letters which must be entered are always shown in [ ]. Simultaneous entries are displayed by a "+" mark. For example:

#### [a] [Enter]

Press the "a" key, then press the [Enter] key.

#### [Ctrl] + [c]

Press the [Ctrl] key and the "c" key simultaneously.

<sup>\*</sup> Select 1, 2, or 3

# **Chapter 4 Replacement Procedures**

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#### 4.1 Overview

This chapter describes the procedure for removing and replacing the field replaceable units (FRUs) in the PC. It may not be necessary to remove all the FRUs in order to replace one. The chart below provides a guide as to which other FRUs must be removed before a particular FRU can be removed. The numbers in the chart indicate the relevant section numbers in this manual.

In all cases when removing an FRU, the battery pack must also be removed. When repairing an FRU that is the potential cause of a computer fault, use the chart to determine the order in which FRUs need to be removed.

The tilt stand, if it is installed, can be removed without any other FRUs removed.

4.3 PC Card		
4.8 Memory Module	4.12 TV Tuner Card	
4.9 Keyboard		
4.10 Wireless Lan Card	4.13 Display Assembly	
4.11 Bluetooth module		
assembly	4.19 CPU	
4.16 USB Board	4.20 LCD unit/FL invert	
4.17 B CAS Board	4.21 Web Camera modul	
4.18 System Board	4.22 Speaker Box	
	4.8 Memory Module 4.9 Keyboard 4.10 Wireless Lan Card 4.11 Bluetooth module  assembly 4.16 USB Board 4.17 B CAS Board	

#### Safety Precautions

Please read the following safety instructions before disassembling the computer and always follow the instructions while working on the computer.

#### DANGER:

- 1. In the case of the battery, always use authentic parts or equivalent parts approved by Toshiba. Other batteries may have different specifications that are incompatible with the computer and may result in fire or explosion.
  - Due to the risk of alkali fluid leaks, never attempt to heat or disassemble the battery. Similarly, due to the risk of explosion, never expose the battery to flame.
- 2. Some parts including the power supply and FL inverter generate high voltages. If you need to turn on the power while disassembling the computer, do not touch any connectors or other components due to the risk of electric shock. Also, do not disassemble individual parts when performing routine maintenance.

- **WARNING:** 1. To prevent electric shock, turn off the power unplug the AC adapter from the power source.
  - 2. As the battery installed to the computer is typically already charged, the risk of electric shock remains even when the AC adapter is unplugged from the socket. To prevent electric shock, always take off any metal jewelry or accessories such as necklaces, bracelets or rings before working on the computer. Never work with wet or moist hands.
  - 3. Take care not to injury yourself on any edges or corners.

#### **CAUTION**:

- 1. Confirm that replacement parts have compatible specifications before replacing on the computer. Never use incorrect parts as these may cause faults on the computer.
- 2. To prevent internal damage such as short circuits or burning, do not allow any screws, paper clips, or other metal objects to fall into the computer. When removing screws, always replace with the same size screws. Ensure that all screws are fully tightened. Loose screws may result in short circuits leading to overheating, smoke or flame.
- 3. To prevent electric shock, check that you have disconnected all cables from a part before removing the part.
- 4. When connecting to the AC power supply, use only an AC adapter and cable approved by Toshiba.
- 5. To prevent electric shock, ensure that all replacement parts are compatible with the computer and that all cables and connectors are securely connected.

#### **Before You Begin**

Take note of the following points before starting work. Always remove the AC adapter and battery pack before commencing any of the procedures. The procedure for removing the battery pack is described in section "4.2 Battery Pack".

- 1. Do not disassemble the computer unless it is operating abnormally.
- 2. Use the designated tools.
- 3. Ensure that the environment for working on and storing parts does not contain any of the following.
  - Dust or dirt
  - Static electricity
  - Extremely hot, cold or humid conditions
- 4. Perform the diagnostic tests described in Chapter 2 to determine which FRU is the cause of the fault.
- 5. Do not perform any unnecessary work. Always work in accordance with the disassembly and reassembly procedures in this manual.
- 6. Keep parts removed from the computer in a safe place away from the computer where they will not be damaged or interfere with your work.
- 7. Disassembling requires the removal of a large number of screws. Keep removed screws in a safe place such that you can determine which screws belong to which part.
- 8. When reassembling, ensure that you use the correct screws and fit parts in the correct position. Screw sizes are noted in the text and figures.
- 9. As all parts have sharp edges and corners, take care not to cut yourself.
- 10. After replacing an FRU, check that the computer and replaced part operate correctly.

#### **Disassembly Procedure**

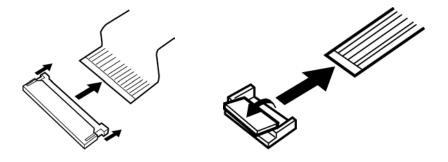
Three main types of cable connector are used.

- Pressure plate connector
- Spring connector
- Normal pin connector

When disconnecting a pressure plate connector, lift up the tag on one side of the plastic pressure plate on the connector and pull the cable out from the connector. When reconnecting a cable to a pressure plate connector, lift up the pressure plate to a suitable height and insert the cable into the connector. Press down on both sides of the pressure plate such that both sides of the plate and connector are at the same height and that the cable is fixed in the correct position. Pull the cable to ensure that it is securely connected. If the cable is disconnected from the connector, reconnect it making sure that you lift the pressure plate high enough to insert fully the cable.

For spring connectors, lifting up the stopper frees the cable and allows it to be pulled out. To reconnect, hold the stopper in the up position and insert the cable, then lower the stopper to secure the cable.

Normal pin connectors are used for all other cables. Simply pull out or push in these connectors to disconnect or reconnect.



Pressure plate connector

Spring connector

#### **Assembly Procedure**

After the computer has been disassembled and the part that caused the fault has been repaired or replaced, the computer must be reassembled.

Take note of the following general points when assembling the computer.

- Take your time and follow the instructions carefully. Hurrying the assembly work will only introduce new problems.
- Check that all cables and connectors are securely connected;
- Before fastening FRUs or other parts in place, ensure that no cables are caught on screws or the FRU.
- Check that all latches are securely closed.
- Ensure that you have installed all FRUs correctly and do not have any screws left over. Using an incorrect screw may damage the thread or screw head and result in the FRU not being securely fastened in place.

After installing FRUs, check that the computer operates correctly.

#### **Tools and Equipment**

For your safety and the safety of the people around you, it is important that you use Electrostatic Discharge (ESD) equipment. Correctly utilizing of the equipment increases the percentage of successful repairs and saves on the cost of damaged or destroyed parts. The following equipment is required for disassembly and assembly.

- One Philips screwdriver with type 0 bit (for THIN HEAD screws)
- One Philips screwdriver with type 1 bit (for screws other than above)
- Tweezers (for lifting screws)
- ESD mats (lay on work table or floor)
- An ESD wrist strap and heel grounder
- Anti-static carpet or flooring

#### **Screw Tightening Torque**

Use the following torque when tightening screws.

**CAUTION**: Overtightening may damage screws or parts. Undertightening may allow screws to loosen (and possibly fall out) causing a short circuit or other damage.

**NOTE**: To tighten screws quickly and accurately, an electric screwdriver is recommended.

• M2 (2mm) 0.167 N· m (1.7 kgf· cm)

• M2.5 (2.5mm) 0.245 N· m(2.5 kgf· cm)

• M2.5 (2.5mm) 0.392 N· m(4.0 kgf· cm) for Hinge support

• M3.0 (3mm) 0.245 N·m (2.5 kgf·cm)

**NOTE:** To prevent damage to THIN HEAD screws, press along the axis of the screwdriver while turning the screw. This is because the contact area between the screw and driver is less than for a pan head screw (standard pan-shaped screw head).





### **Grip Color**

Some screws have a colored grip area to help you determine the length of the screw.

• Even numbered length screws: Brown

• Odd numbered length screws: White

• Special length screw: Blue



"Special length screw" means screws whose length is indicated in an integral number to the first decimal places such as 2.5 mm, 2.8 mm and so on.

#### **Screw Notation**

To make maintenance of the computer easier, markings of the kinds of the screws including the types and lengths are indicated on the computer body.

#### Format:

Screw shape + Screw length (mm)

Screw shape

B: Bind screw

F: Thin head screw

S: Super thin head screw

T: Tapping screw

U: Other screws (Unique screws: pan head, stud, etc.)

Example: B6 ... 6mm bind screw

# 4.2 Battery pack

#### Removing the battery pack

The following describes the procedure for removing the battery pack (See Figure 4-2-1).

**CAUTION:** Take care not to short circuit the terminals when removing the battery pack. Similarly, do not drop, knock, scratch, disassemble, twist, or bend the battery pack.

- 1. Turn off the power of the computer.
- 2. Disconnect the AC adapter and all external devices from the computer.
- 3. Turn the computer upside down.
- 4. Slide and hold the battery release latch (2) to free the battery pack after moving the battery release latch (1) into it unlock position pick the battery pack out of the computer from fillister.

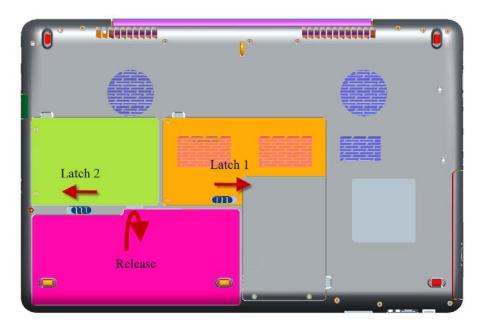


Figure 4-2-1 Remove the battery pack

**NOTE**: Dispose of the used battery pack in accordance with the laws and ordinances of your local authority.

#### Installing the battery pack

The following describes the procedure for installing the battery pack (See Figure 4-2-2).

CAUTION: There is a danger that the lithium ion battery pack may explode if not fitted, operated, handled, or disposed correctly. Dispose always the used battery pack in accordance with the laws and ordinances of your local authority. Use only the batteries approved by Toshiba.

**NOTE:** Check visually the battery terminals and clean off any dirt with a dry cloth.

- 1. Turn off the power of the computer.
- 2. Disconnect the AC adapter and all external devices from the computer.
- 3. Insert the battery pack
- 4. Ensure the battery release latch (1) is moved into its locked position

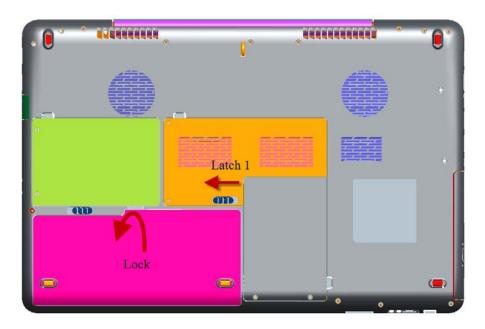


Figure 4-2-2 Install the battery pack

### 4.3 PC card

#### Removing a PC card

The following describes the procedure for removing a PC card (See Figure 4-3-1).

**CAUTION:** Insert or remove a PC card in accordance with any instructions in a PC card manual or the manuals of the computer system you are using.

- 1. Push the **PC card**. It will pop out PCMCIA Card when you release it. And NEW Card same as PC card. Then press the card once more to eject a card.
- 2. Grasp one of **PC card** and remove it.

**NOTE**: If a PC card is not inserted all the way, the eject button may not pop out. Be sure to push a PC card firmly and press the eject button again.

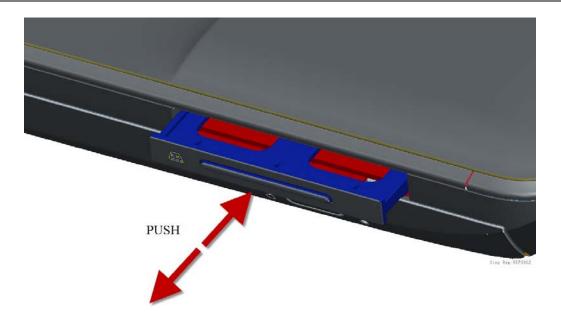


Figure 4-3-1 Remove a PC card

#### Installing a PC card

The following describes the procedure for inserting a PC card (See Figure 4-3-2).

- 1. Make sure the **PC card** does not stick out.
- 2. Insert a  ${\bf PC}$  card and press it until it is securely connected.

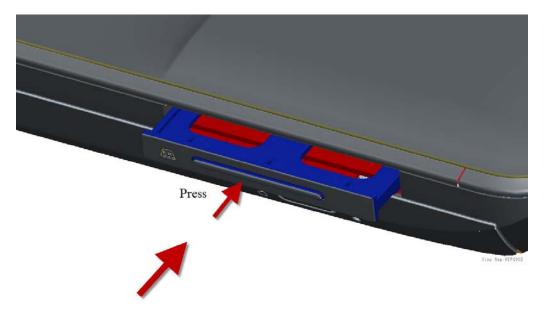


Figure 4-3-2 Insert a PC card

# 4.4 SSD/HDD (Main HDD)

#### Removing a SSD/MAIN HDD-H9.5mm / HDD-H12.5mm

The following describes the procedure for removing the SSD/main HDD (See Figure 4-4-1 to 4-4-3).

**CAUTION:** Take care not to press on the top or bottom of a SSD/HDD. Pressure may cause data loss or damage to the device.

- 1. Turn the computer upside down.
- 2. Remove the following **screws** securing a SSD/HDD slot cover and remove a **SSD/HDD slot cover**.
  - M2.5×4.0B FLAT BIND screw x2
- 3. Remove the following **screws** securing the **SSD/HDD assembly**.
  - M2.5×3.0B FLAT BIND screw x2
- 4. Disconnect the SSD/HDD assembly from the connector on the system board.

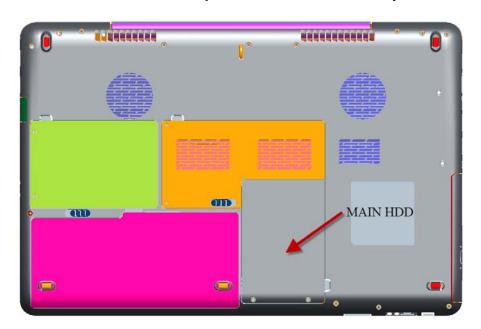


Figure 4-4-1 Turn the computer upside down

**CAUTION:** When a SSD/HDD is installed, they are installed in the position as the following figure.

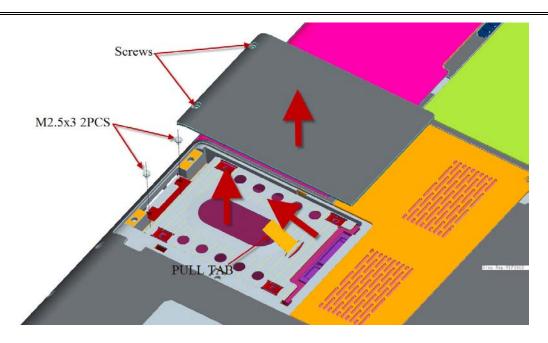


Figure 4-4-2 Remove the SSD/MAIN HDD assembly

5. Remove the following **screws** securing the SSD/HDD holder and remove the **SSD/HDD holder**.

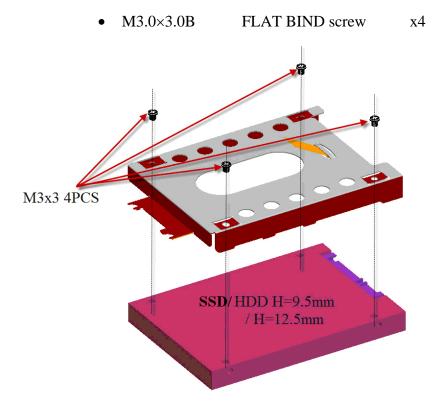


Figure 4-4-3 Remove SSD/MAIN HDD

#### Installing SSD/MAIN HDD-H9.5mm / HDD-H12.5 mm

The following describes the procedure for installing the main HDD.

- 1. Install a SSD/HDD to the **SSD/HDD holder** and secure it with the following **screws**.
  - M3.0×3.0B FLAT BIND screw x4

**NOTE:** Although they are 3mm head screws, screw torque must be set in 2.5kg-cm for four screws securing the HDD holder.

- 2. Insert the **SSD/HDD assembly** into the SSD/HDD slot and connect it carefully to the **SSD/MAIN HDD** on the system board.
- 3. Secure the **SSD/HDD assembly** with the following **screw**.
  - M2.5×3.0B FLAT BIND screw x2
  - M2.5×4.0B FLAT BIND screw x2

# 4.5 Optical disk drive

**NOTE**: Do not apply excessive force to the top of an optical disk drive.

Do not touch the shaded portion of the figure below, when the drive is removed or installed.

#### Removing an optical disk drive

The following describes the procedure for removing an optical disk drive (See Figure 4-5-1 and 4-5-2).

- 1. Remove **MAIN HDD** Slot cover and next remove the following **screws** securing an optical disk drive.
  - M2.5×3.0B FLAT BIND screw x1
- 2. Disconnect an **optical disk drive** toward the arrow direction from the connector **CN26** on the system board.

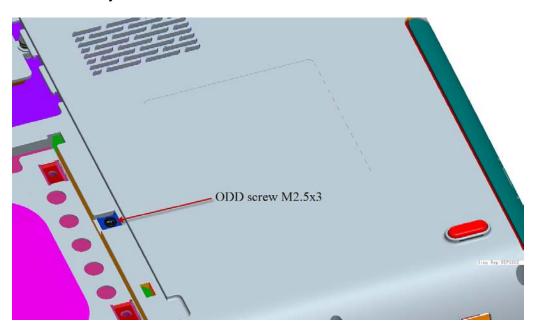


Figure 4-5-1 Remove an optical disk drive

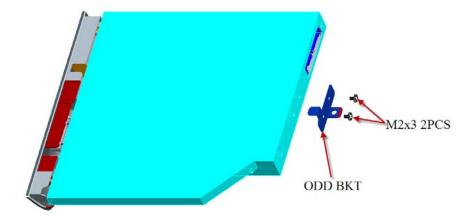


Figure 4-5-2 Disassemble the side bracket

#### Installing an optical disk drive

The following describes the procedure for installing an optical disk drive.

- 1. Attach the **ODD bracket** to an optical disk drive and secure it with the following screws.
  - $M2.0\times3.0$  Flat BIND screw x2
- 2. Insert an optical disk drive assembly into the slot and connect it to the connector **CN26** on the system board.
- 3. Secure the ODD drive with the following **screw**.
  - M2.5X5.0 Flat BIND screw x1

# 4.6 Slot in Optical disk drive

**NOTE**: Do not apply excessive force to the top of an optical disk drive.

Do not touch the shaded portion of the figure below, when the drive is removed or installed.

#### Removing an optical disk drive

The following describes the procedure for removing an optical disk drive (See Figure 4-6-1 to 4-6-3).

- 1. Remove the **screws** securing Motherboard.
  - M2.5×6.5B FLAT BIND screw x3
- 2. Remove the **Motherboard** and thermal fan.
- 3. Remove the **screws** to disconnect the slot in ODD
  - M2.0×3.0B FLAT BIND screw x2
- 4. Remove the slot in ODD bracket from right side and left side.
  - M2.0×2.0B FLAT BIND screw x4



Figure 4-6-1 Remove an optical disk drive

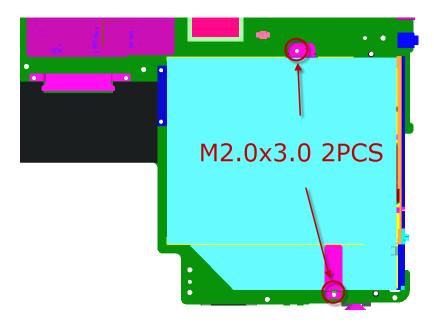


Figure 4-6-2 Disconnect the Slot in ODD from Motherboard

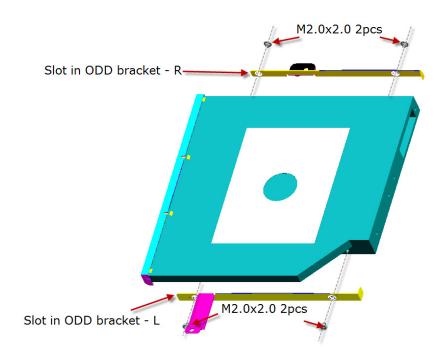


Figure 4-6-3 Disassemble the bracket from slot in ODD

#### Installing an optical disk drive

The following describes the procedure for installing an optical disk drive.

- 1. Attach the **ODD bracket** to an optical disk drive and secure it with the following screws.
  - M2.0×2.0 Flat BIND screw x4
- 2. Insert an optical disk drive assembly into the slot and connect it to the connector **CN26** on the system board and secure it with the following screws.
  - M2.0×3.0B FLAT BIND screw x2
- 3. Secure Motherboard with following screws.
  - M2.5×6.5B FLAT BIND screw x3

# 4.7 HDD (SECOND HDD)

#### Removing second HDD-H9.5mm / HDD-H12.5mm

The following describes the procedure for removing the second HDD (See Figure 4-7-1 to 4-7-3).

**CAUTION:** Take care not to press on the top or bottom of a HDD. Pressure may cause data loss or damage to the device.

- 1. Turn the computer upside down.
- 2. Remove the following **screws** securing a HDD slot cover and remove a **HDD slot cover**.
  - M2.5×4.0B FLAT BIND screw x2
- 3. Remove the following **screws** securing the **HDD assembly**.
  - M2.5×3.0B FLAT BIND screw x2
- 4. Disconnect the **HDD assembly** from the connector on the system board.

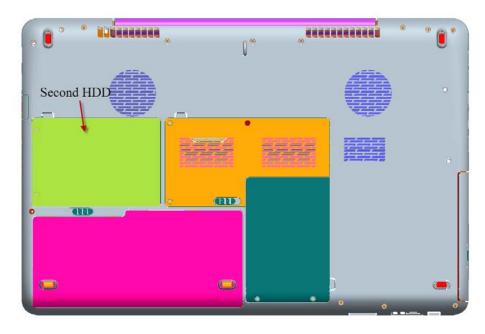


Figure 4-7-1 Turn the computer upside down

**CAUTION:** When a HDD is installed, they are installed in the position as the following figure.

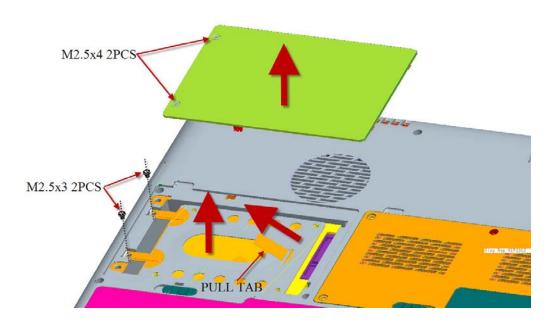


Figure 4-7-2 Remove the SECOND HDD assembly

- 5. Remove the following **screws** securing the HDD holder and remove the **HDD holder**.
  - M3.0×3.0B FLAT BIND screw x4

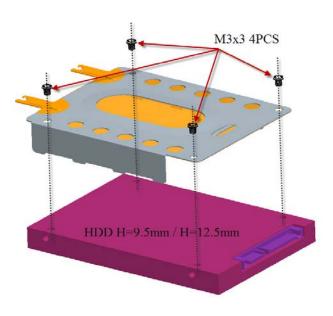


Figure 4-7-3 Remove the screws and HDD holder

### Installing Second HDD-H9.5mm / HDD-H12.5mm

The following describes the procedure for installing a HDD.

- 1. Install a HDD to the **HDD holder** and secure it with the following **screws**.
  - M3.0×3.5F FLAT BIND screw x4

**NOTE:** Although they are 3mm head screws, screw torque must be set in 2.5kg-cm for four screws securing the HDD holder.

- 2. Insert the **HDD** assembly into the HDD slot and connect it carefully to the **MAIN HDD** on the system board.
- 3. Secure the **HDD assembly** with the following **screw**.
  - M2.5×3.0B FLAT BIND screw x2
  - M2.5×4.0B FLAT BIND screw x2

# 4.8 Memory module

**CAUTION:** The power of the computer must be turned off when you remove a memory module. Remove a memory module with the power on risks damaging the module or the computer itself.

Do not touch memory module terminals. Any dirt on the terminals may cause memory access problems.

Never press hard or bend a memory module.

### Removing a memory module

To remove a memory module, confirm that the computer is in boot mode. Then perform the following procedure (See Figure 4-8-1 to 4-8-2).

- 1. Loose the **screw** securing the **memory slot cover**.
  - M2.5×4.0B FLAT BIND screw x3
- 2. Remove the **memory slot cover**.
- 3. Open the left and right **latches** and remove a **memory module**.

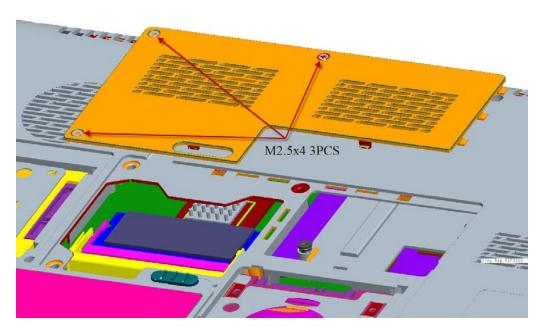


Figure 4-8-1 Remove memory slot cover

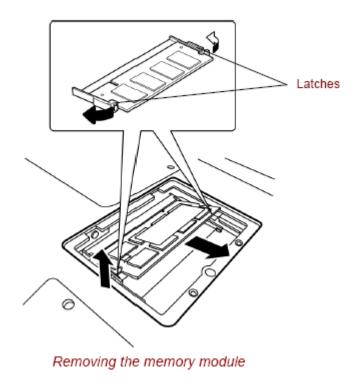


Figure 4-8-2 Remove a memory module

### Installing a memory module

To install a memory module, confirm that the computer is in boot mode. Then perform the following procedure (See Figure 4-8-3).

1. Insert a **memory module** into the connector of the computer slantwise (terminal side first) and press it to connect firmly.

**CAUTION:** The power must be turned off when you insert a memory module. Inserting a memory module with the power on might damage the module or the computer itself.

Never press hard or bend a memory module.

- 2. Install the **memory slot cover** and secure it with the **screw**.
  - M2.5×4.0B FLAT BIND screw x3
- 3. When the power of the computer is turned on, the computer checks automatically the memory size. Confirm that the new memory is detected correctly.
- 4. If the memory is not detected, check that it is connected correctly.

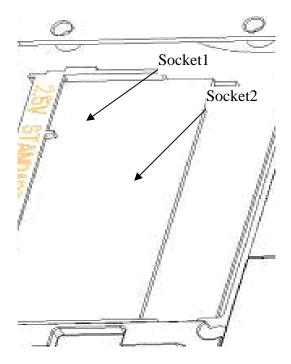


Figure 4-8-3 Insert a memory module

# 4.9 Keyboard

# Removing the keyboard

The following describes the procedure for removing the keyboard (See Figure 4-9-1).

**CAUTION:** As the keycap may fall out, when handling the keyboard always hold it by the frame and do not touch the keycap.

- 1. Upside down the computer.
- 2. Open the display.
- 3. Remove KBD holder. Insert your finger into the slot between the KBD holder and the keyboard. Then, lift up the **keyboard cover** to remove it.
- 4. Loose the **screw** securing KBD Holder.

M2.5x3.0B Flat BIND screws x4

- 5. Insert your finger into the keyboard slot and keyboard. Then lift up the keyboard to remove it.
- 6. Disconnect keyboard cable.

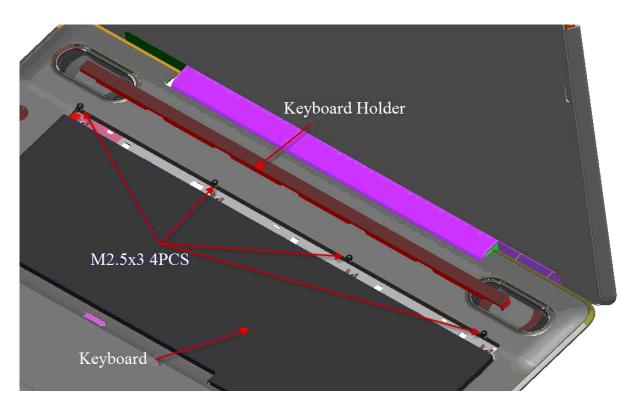


Figure 4-9-1 Remove screws for KB Holder

# Installing the keyboard

The following describes the procedure for installing the keyboard.

- 1. Turn the **keyboard** upside down and place it on the palm rest as its face down. Connect the **keyboard flexible cable** to the connector on the system board.
- 2. Slide and set the **speaker cover assembly** and secure it with the following **screw**.
  - M2.5×3.0B FLAT BIND screw x4
- 3. Install the **keyboard brace** by pressing it from the topside.

# 4.10 Wireless LAN card

### Removing a Wireless LAN card

The following describes the procedure for removing a Wireless LAN card (See Figure 4-10-1 to 4-10-2).

- 1. Remove the following **screw** of wireless cover securing **wireless LAN card cover** and remove it. And remove screw of wireless board
  - M2.5. x 3.0B BIND screw x2
- 2. Disconnect the **wireless LAN antenna cable** from the connectors on a wireless LAN card
- 3. Open the left and right latches holding a wireless LAN card and remove a **wireless** LAN card from the **connector** on the system board.

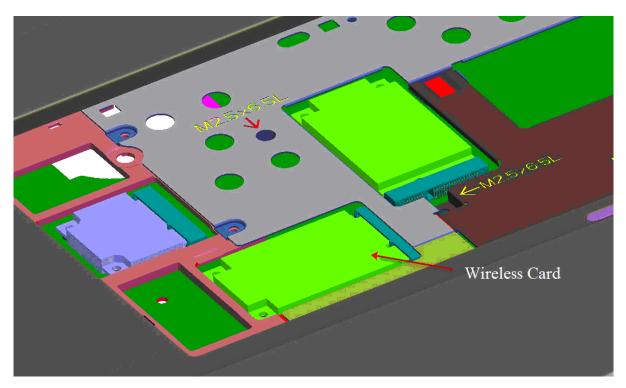


Figure 4-10-1 Wireless LAN card

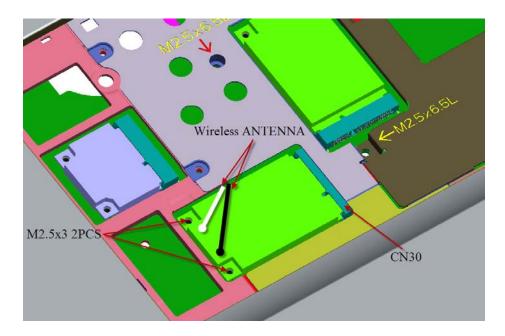


Figure 4-10-2 Remove a wireless LAN card

### Installing a Wireless LAN card

The following describes the procedure for installing a Wireless LAN card.

- 1. Insert a **wireless LAN card** terminals slantwise into the connector on the computer and press a wireless LAN card and lock the secure screws.
  - M2.5. x 3.0B BIND screw x2
- 2. Connect the wireless LAN antenna cable to the terminals on a wireless LAN card.
- 3. Put the **wireless LAN antenna cable** on the right location from the guide (Antenna cable locate top, USB cable locate bottom and FM cable locate middle). Stick the tape of cable on the surface. If fail to stick, replace tape with new adhesive tape. (see Figure 4-10-3)

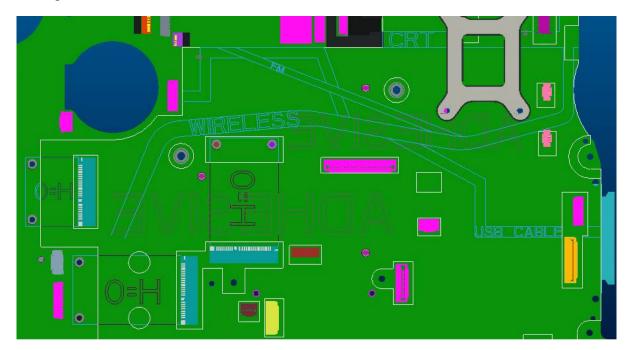


Figure 4-10-3 Cables layout on motherboard

### 4.11 Bluetooth module

### Remove a Bluetooth module

The following describes the procedure for removing a Bluetooth module(see Figure 4-11-1)

- 1. Disconnect the Bluetooth cable from motherboard side
- 2. Remove the following screw from TOP case and remove the Bluetooth bracket
  - 2.5.0 x 3.0B

BIND screw

x1

3. Remove the Bluetooth module

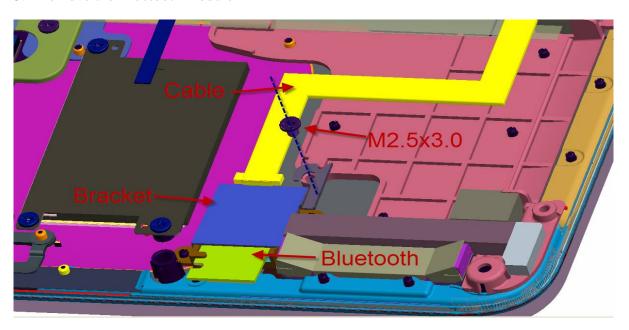


Figure 4-11-1 Remove a Bluetooth module

### Installing a Bluetooth module

The following describes the procedure for installing a Bluetooth module.

- 1. Insert a **Bluetooth** into the connector on the computer.
- 2. Connect the Bluetooth cable to the terminals on a Bluetooth and connect it to the motherboard side.
- 3. Install the Bluetooth bracket and secure it with following screw.
  - 2.5.0 x 3.0B

BIND screw

x1

# 4.12 TV Tuner card

# Removing a TV Tuner card

The following describes the procedure for removing a TV Tuner card (See Figure 4-12-1).

- 1. Remove the following **screw** of TOP cover securing and remove it. And remove screw of TV tuner card
  - 2.5.0 x 3.0B BIND screw x2
- 2. Disconnect the TV antenna cable from the connectors on a TV tuner card
- 3. Open the left and right latches holding a TV tuner card and remove a **TV tuner card** from the **connector** on the system board.

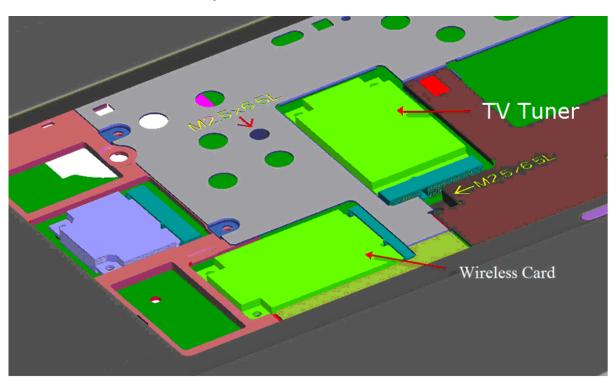


Figure 4-12-1 TV Tuner card

# **Installing a TV Tuner card**

The following describes the procedure for installing a TV tuner card.

- 1. Insert a **TV tuner card** terminals slantwise into the connector on the computer and press a TV tuner card and lock the secure screws.
- 2. Connect the **TV** antenna cable to the terminals on a TV tuner card.
- 3. Put the **TV antenna cable** on the right location from the guide(see Figure 4-10-3)
- 4. Secure **TV tuner card** with the following **screws**

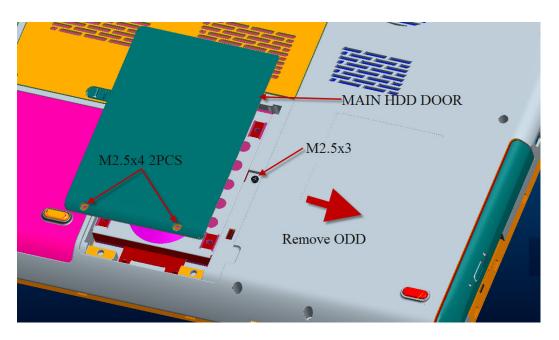
2.5.0 x 3.0B BIND screw x2

# 4.13 Display assembly

#### Removing the display assembly

The following describes the procedure for removing the display assembly (See Figure 4-13-1 to 4-13-5).

- 1. Close the display and turn the computer upside down.
- 2. Remove the battery pack (See Figure 4-2-1)
- 3. Remove the Main HDD door screws and open the MAIN HDD Door, remove Optical Drive Disk.
  - M2.5×4.0 FLAT BIND screw x2
  - M2.5×3.0 FLAT BIND screw x1



*Figure 4-13-1 Remove the screws (securing display assembly)* 

- 4. Open the SECOND HDD Door.
- 5. Remove the screws from the bottom side.

• M2.5×6.5 FLAT BINI	O screw x1	1
• M2.5×8.0 FLAT BINI	O screw x6	
• M2.5×4.0 FLAT BINI	D screw x2	
• M2.5X3.0 FLAT BINE	O screw x1	
• M2.5×2.0 FLAT BINI	O screw x5	

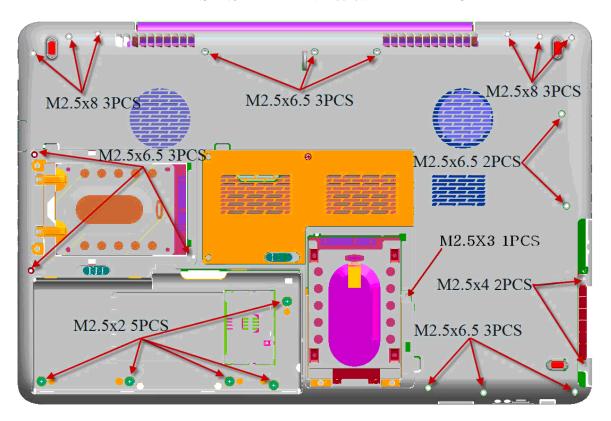


Figure 4-13-2 Remove the screws (from bottom side)

- 6. Disassemble **KBD Holder** and **Keyboard** screw (See Figure 4-9-1)
  - M2.5x3.0 Flat BIND screws x4
- 7. Remove the screws from the top side and remove the cover.
  - M2.5x6.5 Flat BIND screws x7
  - M2.5x3.0 Flat BIND screws x2



Figure 4-13-3 Remove the screws (from top side)

- 8. Disconnect the FFC and cables.
- 9. Disassembly TOP cover.
- 10. Pull out the wireless LAN antenna and LCD cables from the guide.

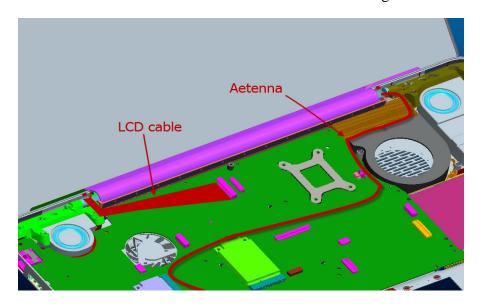


Figure 4-13-4 Remove the Wireless Antenna and LCD cable

Opening the display to 135degree, and remove the hinge screw.

• M2.5×6.5 FLAT BIND screw x6 (Locktight)

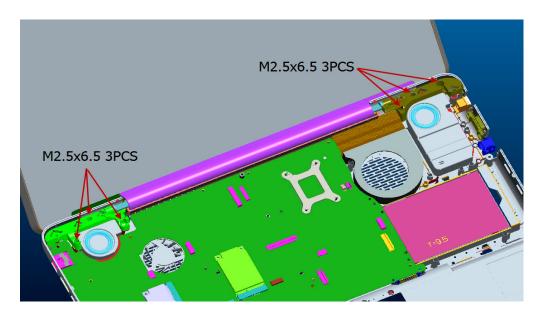


Figure 4-13-5 Remove the hinge screws

11. Pulling out the **pole of hinge** from the **hole** of hinge assembly, remove the **display assembly** from the base assembly.

### Installing display assembly

The following describes the procedure for installing the display assembly.

- 1. Inserting the **pole of hinge** to the **hole** of hinge assembly, set the **display assembly** on the base assembly.
- 2. Secure the **hinges** with the following **screws** secure the **display mask** with the following **screws** and stick the **mask seal** on them.
  - M2.5×6.5 FLAT BIND screw x6 (Locktight)

**NOTE**: Be sure to apply the locktight to the screws instructed in the figure above.

3. Connect the **LCD harness** to the connector on the system board.

- 4. Arrange the wireless antenna cables along the guide (front) and secure them with **guide**.
- 5. Pass the cables to the back of computer through the **slot**.
- 6. Arrange the wireless LAN antenna along the guide and contact with the connector.
- 7. Install the LAN board and cover ASSY of the system, secure it with the screws
  - M2.5x6.5 Flat BIND screws x7
- 8. Install the KBD **Holder** and **Keyboard** with screws
  - M2.5x3.0 Flat BIND screws x4
- 9. Turn the computer downside and Secure the bottom with screws
  - M2.5×6.5 FLAT BIND screw x11
  - M2.5 $\times$ 8.0 FLAT BIND screw x6
  - M2.5×4.0 FLAT BIND screw x2
  - M2.5×3.0 FLAT BIND screw x1
  - M2.5×2.0 FLAT BIND screw x5
- 10. Install battery pack, HDD door and Optical Drive Disk with screws
  - M2.5×4.0 FLAT BIND screw x2
  - M2.5×3.0 FLAT BIND screw x1

**NOTE**: If Fingerprint or Dust left on LCD screen during disassembly and assembly LCD units, please follow Appendix A to clean it.

# 4.14 Top Cover assembly

## Removing the Top cover assembly

The following describes the procedure for removing the top cover assembly (See Figure 4-14-1 to 4-14-3).

- 1. Turn over the computer.
- 2. Remove the following **screws** securing the top cover assembly from the back and bottom of computer.

•	M2.5×2.0	FLAT BIND screw Back	x5
•	M2.5×6.5	FLAT BIND screw Back	x11
•	M2.5×8.0	FLAT BIND screw Back	x6
•	M2.5×4.0	FLAT BIND screw Back	x2
•	M2.5×3.0	FLAT BIND screw Back	x1

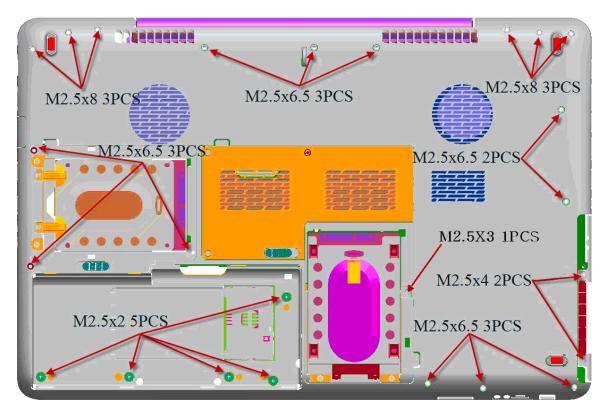


Figure 4-14-1 Remove the screws (back)

- 3. Remove the following **screws** securing the top cover assembly from the front of computer. Pull up and remove the **top cover assembly** from the **base assembly**.
  - M2.5x6.5 Flat BIND screws x7

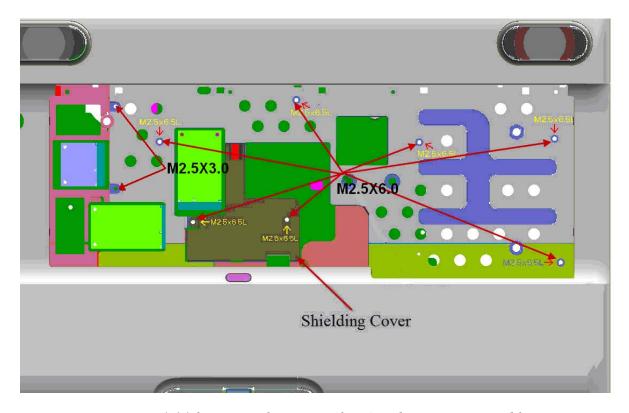


Figure 4-14-2 Remove the screws (front) and top cover assembly

4. Disconnect the **touch pad flat cable/Fingerprint cable** from the connector on the system board.

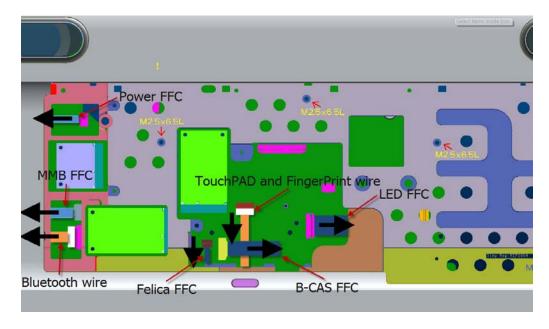


Figure 4-14-3 Disconnect the touch pad flat cable/Fingerprint cable

## **Installing Top Cover assembly**

The following describes the procedure for installing the top cover assembly.

1. Install the top **cover assembly** to the base assembly.

**NOTE**: Be careful not to catch the cables between top cover assembly and base assembly.

- 2. Connect the **touch pad flat cable** to the connector on the system board.
- 3. Secure the top cover assembly with following screws from the front of computer.
  - M2.5x6.5 Flat BIND screws x7
  - M2.5x3.0 Flat BIND screws x2
- 4. Secure the top cover assembly with the following **screws** from the back and bottom of computer.
- M2.5×2.0 FLAT BIND screw x5
   M2.5×6.5 FLAT BIND screw x11
- M2.5×8.0 FLAT BIND screw x6 M2.5×4.0 FLAT BIND screw x2
- M2.5×3.0 FLAT BIND screw x1
- 5. Free the cable from cable-drain when through the antenna cable to PCB hole.

# 4.15 Touch pad

## Removing the touch pad

The following describes the procedure for removing the touch pad (See Figure 4-15-1 to 4-15-3).

- 1. Peel off the **glass tape** and disconnect the **touch pad flat cable**, **Fingerprint cable** from the connector on the touch pad.
- 2. Remove the following **screws** securing the touch pad plate.
  - M2.0×3.0B SUPER THIN HEAD screw x10
- 3. Remove the **touch pad board and touch pad plate**.
- 4. Peel off and remove the **touch pad** from the top cover assembly.

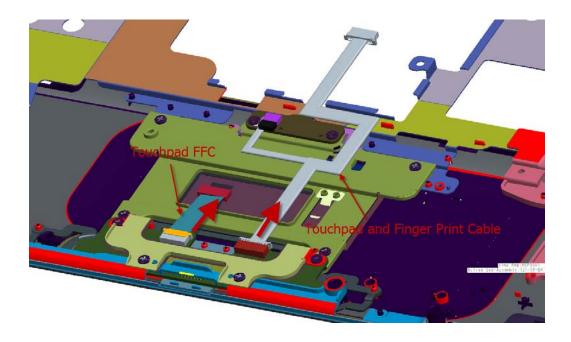


Figure 4-15-1 Remove the touch FFC and Fingerprint cable

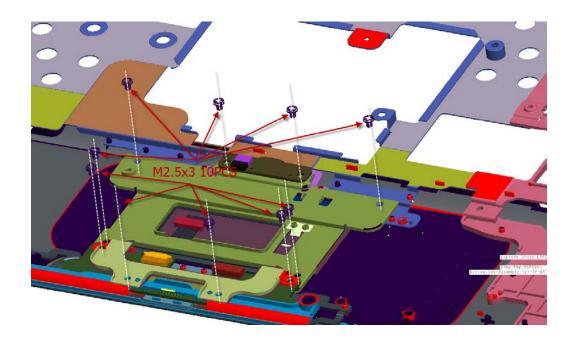


Figure 4-15-2 Loose the M2.5x3 screw

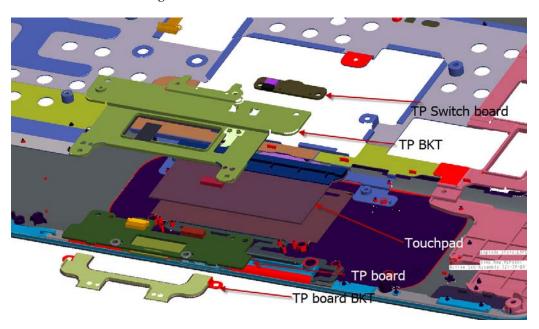


Figure 4-15-3 Remove the touchpad and touchpad board

### Installing the touch pad

The following describes the procedure for installing the touch pad.

1. Peel off the separator covering on the sensor portion of a new touch pad.

**NOTE**: Do not reuse the touch pad so that it can not be used after peeling off from the computer. Be sure to stick a new touch pad.

When sticking the touch pad, be careful not to get the bubbles under the touch pad.

- 2. Stick and install the **touch pad** on the top cover assembly.
- 3. Install the **touch pad plate** and secure it with the following **screws**.
  - M2.5×3.0 SUPER THIN HEAD screw x10
- 4. Stick the **insulator** on the touch pad plate.
- 5. Connect the **touch pad flat cable** to the connector on the touch pad and stick the **glass tape** on the connector.

# 4.16 USB Board

The following describes for removing the USB board (See Figure 4-16-1).

### Removing the USB Board

- 1. Pull out the **USB cable**, **Audio cable**, from USB board connector.
- 2. Loose the below screws and then incline pull out USB board.
  - M2.5x6.5 FLAT BIND screw x2

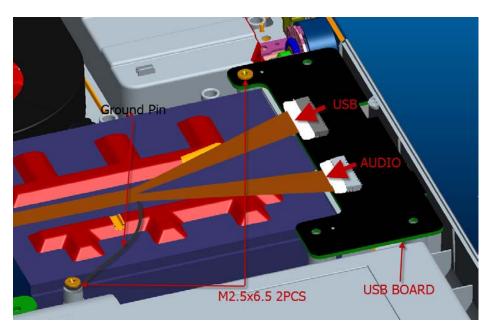


Figure 4-16-1 Remove the USB board

### Installing the USB Board

The following describes the procedure for installing the USB board.

- 1. Insert the USB board into base case and connect USB board cable, Modem cable
- 2. Fix the below **screws**

M2.5x6.5 FLAT BIND screw x2

**NOTE**: Be careful not to catch the cables between top cover assembly and base assembly.

# 4.17 B CAS Board

The following describes for removing the B CAS Board (See Figure 4-17-1).

# Removing the B CAS Board

- 1. Pull out the **B CAS FFC** from USB board connector.
- 2. Loose the below screws and then incline pull out B CAS board.
  - M2.5x3 FLAT BIND screw x4

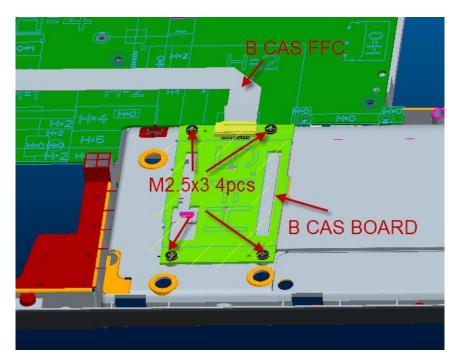


Figure 4-17-1 Remove the B CAS Board

## Installing the B CAS Board

The following describes the procedure for installing the B CAS board.

- 1. Insert the **B CAS board** into base case and connect B CAS board FFC.
- 2. Fix the below **screws**

M2.5x3 FLAT BIND screw x4

# 4.18 System Board

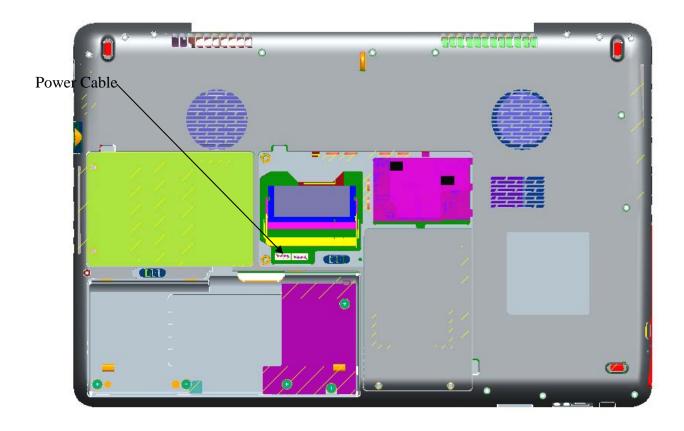
**CAUTION:** 1. when handling the system board, always hold by the edges. Do not touch the printed circuit face.

2. if replacing with a new system board, execute the subtest01 Initial configuration in section 3.3 "Setting of the hardware configuration". Also update with the latest BIOS

# **Removing the System Board**

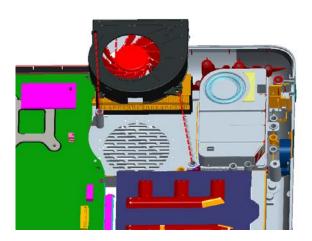
The following describes the procedure for removing the system board (See Figure 4-18-1 to 4-18-2).

1. Disconnect the power cable from the system board.



*Figure 4-18-1 Disconnect the power cable* 

- 2. Disconnect the **speaker cable, LCD CABLE, WIRELESS ANTENNA, CRT cable, USB cable, FM CABLE, MDC CABLE, and TV-F ANTENNA** from the connector on the system board.
- 3. Remove the following **screws** securing the fan and the system board and remove the **system board**.
  - M2.5×6.5 screw x2



• M2.5×6.5 screw x3

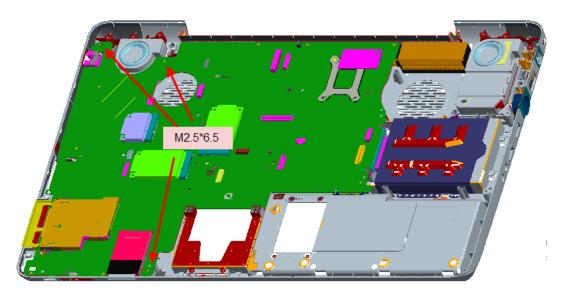


Figure 4-18-2 Remove the system board

# **Removing RTC battery**

The following describes the procedure for removing the RTC battery unit (See Figure 4-18-3 to 4-18-4).

1. Pull the away the socket of RTC battery and use a clamp to hold RTC battery tightly.

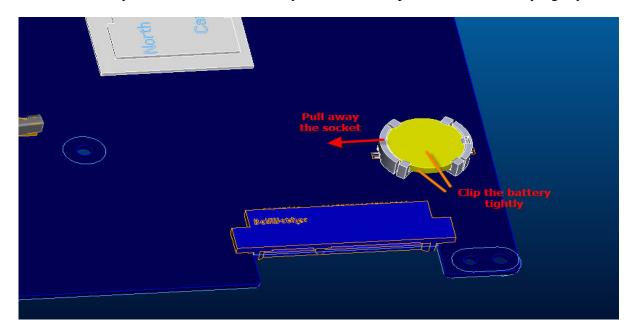


Figure 4-18-3 Pull away from the socket of RTC Battery

2. Rotate battery through the way then remove it.

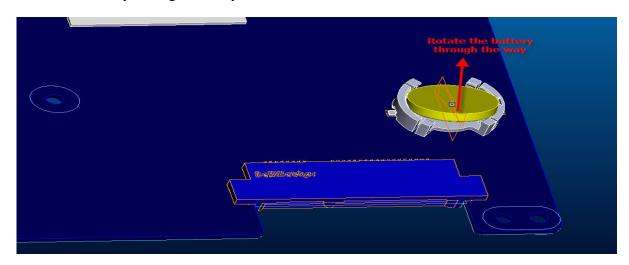


Figure 4-18-4 Rotate the RTC Battery

### **Installing the System Board**

The following describes the procedure for installing the system board.

1. Secure the system board with the following **screws**.

 $M2.5 \times 6.5$  screw x3

2. Secure the fan with the following **screws**.

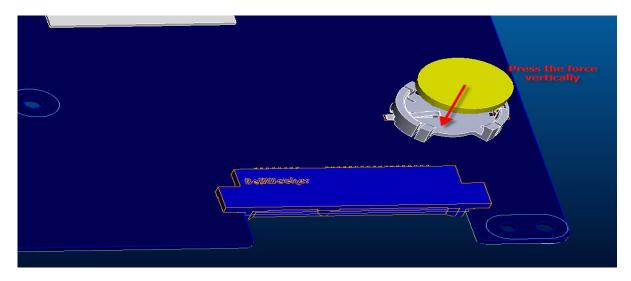
 $M2.5 \times 6.5$  screw x2

- 3. Connect the speaker cable, LCD CABLE, WIRELESS ANTENNA, CRT cable, USB cable, FM CABLE, MDC CABLE, and TV-F ANTENNA to the connector on the system board.
- 4. Connect the power cable to the connector on the system board

### **Installing RTC battery**

The following describes the procedure for installing the RTC battery unit (See Figure 4-18-5).

1. Press the force vertically then lock the RTC battery tightly.



*Figure 4-18-5 Install the RTC battery* 

# 4.19 CPU

# Removing the CPU heat sink

The following describes the procedure for removing the CPU heat sink (See Figure 4-19-1 to 4-19-2).

- 1. Disconnect the **Heat sink cable** from the connector on the system board
- 2. Remove the following **screws** securing the heat sink holder along 1 to 4.
  - M2×2 SPRING screw x4

**NOTE:** When removing the heat sink holder, be sure to remove the screws in the reverse order of the number marked on the holder.

3. Remove the **CPU heat sink**.

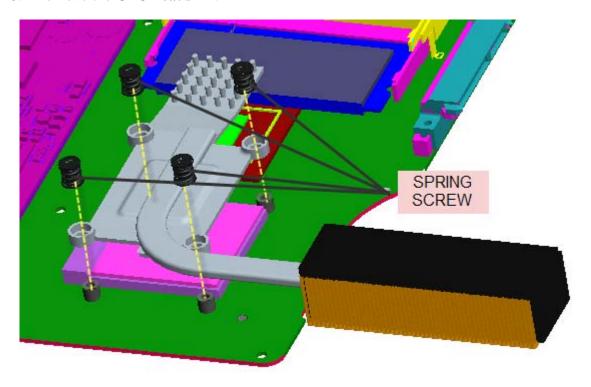


Figure 4-19-1 Remove the CPU heat sink

- 4. Unlock the **CPU** by rotating the **cam** on the CPU socket 120 degrees to the counterclockwise with a flat-blade screwdriver.
- 5. Remove the **CPU**.

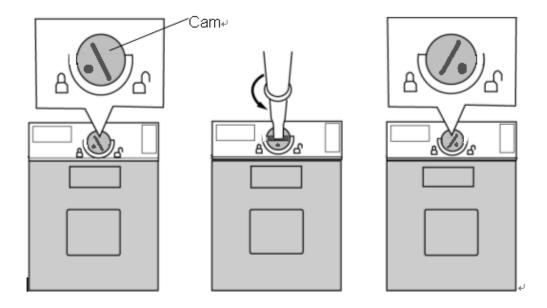


Figure 4-19-2 Remove the CPU

# Installing the CPU

The following describes the procedure for installing the CPU (see Figure 4-19-3)

- 1. Check that the mark of cam is in the unlocking position.
- 2. Attach the **CPU** to the correct position in the **CPU socket**.
- 3. Fix the **CPU** by rotating the cam 120 degrees to the clockwise with a flat-blade screwdriver.
- 4. If there is already silicon grease on the CPU, clean it with a cloth. Using a special applicator, apply silicon grease so that the CPU chip on the CPU is completely covered.
- 5. Please apply 0.1cc silicon grease (Shinetsu 7762) for each repair. And apply

Thermal pad for N-bridge, VGA&V-RAM for each repair

**NOTE:** Apply the silicon grease enough to cover the chip surface using the special applicator. Thermal pad is fixed for each one, no need special applicator.

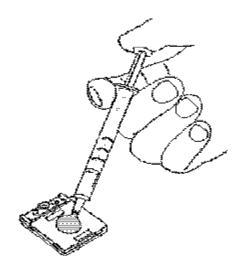


Figure 4-19-3 Apply silicon grease

6. Install the **CPU heat sink** and **heat sink holder** and secure them with the following **screws** along 1 to 4.

M2×2 SPRING screw x4

7. Connect the **Heat sink cable** to the connector on the system board

**NOTE:** When securing the heat sink holder, be sure to secure the screws in the order of the number marked on the holder.

# 4.20 LCD unit / FL inverter

CAUTION: When replacing a LCD, it is required that SVP parameter is set. Update with the latest EC/KBC as described in Appendix H "EC/KBC Rewrite Procedures".

### Removing the LCD unit / FL inverter

The following describes the procedure for removing the LCD unit and FL inverter (See Figure 4-20-1 to 4-20-4).

Remove Screw MYLAR cover X8

1. Remove the following **screws** securing the display mask

M2.5×6.5 screw X8

2. Insert your finger between the edge of the display mask and the **LCD**, and remove the **display mask** while releasing the latches of display mask.

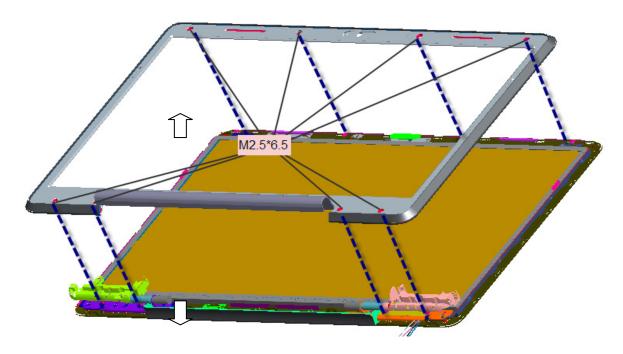


Figure 4-20-1 Remove the display mask

- 3. Pull out one **insulator** and peel off the other one adhered to the inverter.
- 4. Disconnect the **LCD harnesses** from the connectors **CN1** on the inverter.
- 5. Disconnect the **HV harnesses** from the connectors **CN2** on the inverter.
- 6. Remove the **FL inverter** while peeling off the **double-sided tape**.

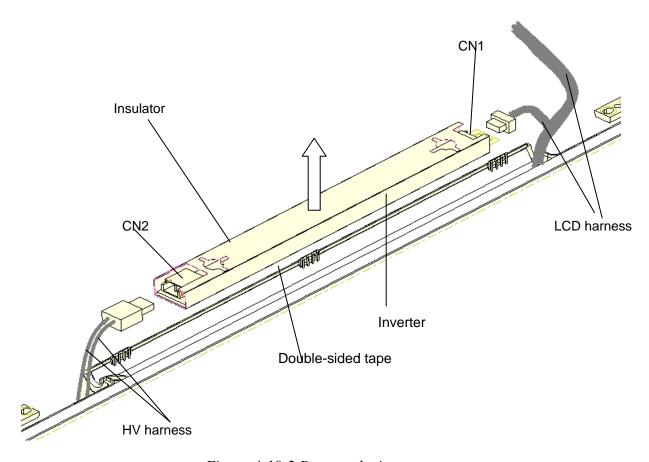


Figure 4-19-2 Remove the inverter

- 7. Remove the following **screws** securing the LCD unit.
  - M2.5x4.0 screw x2
  - M2.5x5.0 screw x8
- 8. With the bottom edge of the LCD unit on the display cover, lift only the top edge of the LCD unit. After peeling off the **CONDUTIVE tape**, disconnect the LCD harness from the connector on the back of the LCD.
- 9. Remove the **LCD unit**.

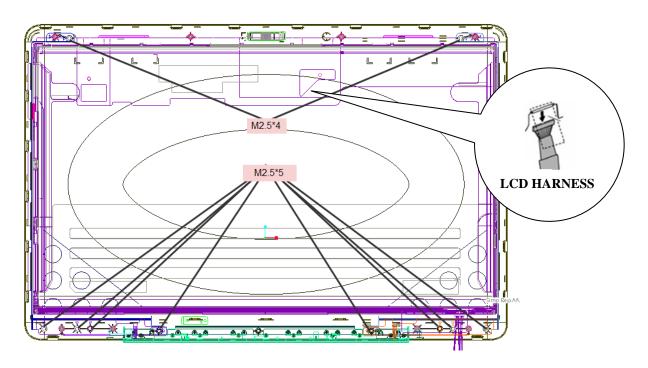


Figure 4-20-3 Remove the LCD unit

- 10. Remove the following **screws** securing the LCD support (LCD unit side) and remove the **hinge** from the LCD unit.
  - M2.0x2.5 screw x8

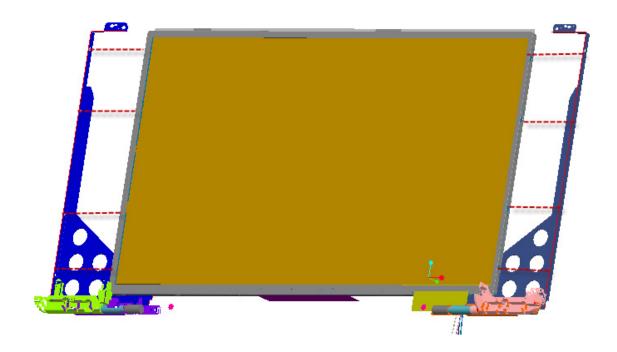


Figure 4-20-4 Remove the LCD hinge

#### Installing the LCD unit/FL Inverter

The following describes the procedure for installing the LCD unit and FL inverter.

Install the LCD supports (LCD unit side) and hinge to the LCD and secure them with the following **screws**.

- $M2.0 \times 2.5$  BINK screw x8
- 1. Stand the **LCD unit** on the display cover and connect the **LCD harness** to the connector on the back of LCD.
- 2. Stick the **conductive tape** on the connector of LCD harness.
- 3. Secure the LCD unit with the following **screws**.
  - M2.5x4.0 screw x2
  - M2.5x5.0 screw x8
- 4. Connect **LCD** harnesses to the connector **CN1** of the inverter.

**CAUTION:** Be careful not to connect the LCD harnesses to the wrong connectors of FL inverter.

- 5. Connect **HV** harnesses to the connector **CN2** of the FL inverter.
- 6. Install the **display mask** while fitting the latches.
- 7. Secure the display mask with following **screws**

8. Cover screws with Screw MYLAR cover X8

**NOTE:** When installing the display mask, make sure there is no gap between the display mask and the display cover.

## 4.21 Web Camera module

## **Removing Web Camera module**

The following describes the procedure for removing the Web Camera module.

(See Figure 4-21-1 to 4-21-2).

1. Pull off the connector of Web Camera module.

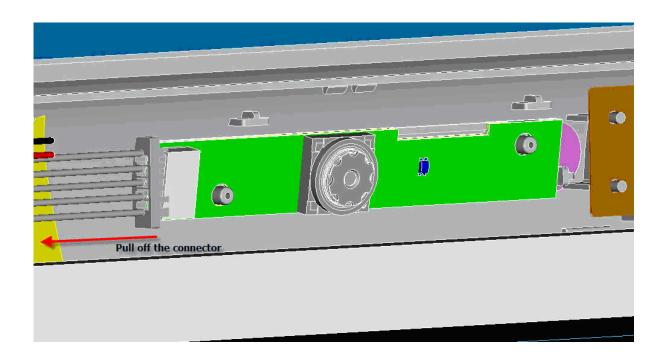


Figure 4-21-1 Remove the connector of Web Camera module

2. Peel off the glue of Web Camera module.

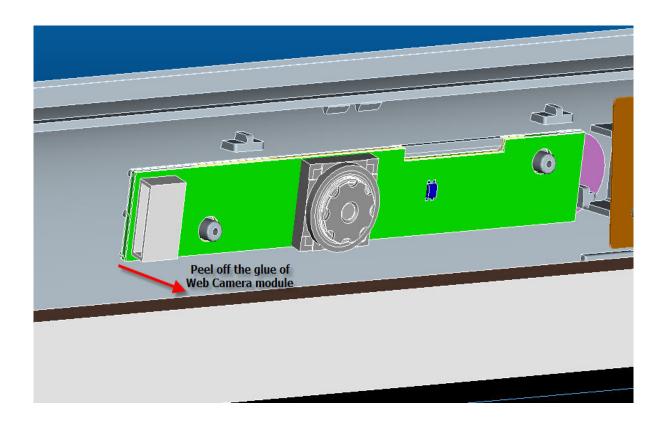


Figure 4-21-2 Peel off the glue of Web Camera module

## **Installing Web Camera module**

The following describes the procedure for installing the Web Camera module.

- 1. Pull in the glue of Web Camera Module.
- 2. Connect the connector of Web Camera module.

## 4.22 Speaker Box

## **Removing Speaker Box**

The following describes the procedure for removing Speaker Box.

(See Figure 4-22-1 to 4-22-3).

- 1. Remove the following **screws** securing Speaker Box.
  - M2.5×2.0 screw x 4

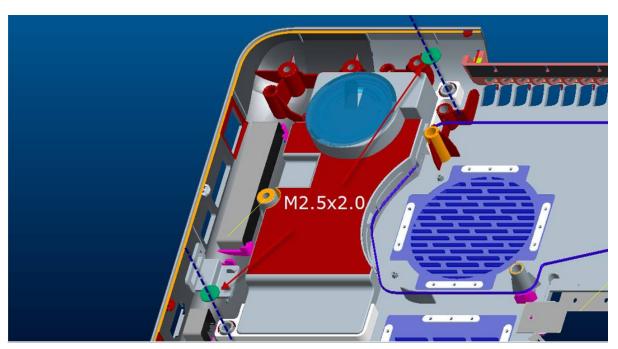


Figure 4-22-1 Removing the securing screws at left side.

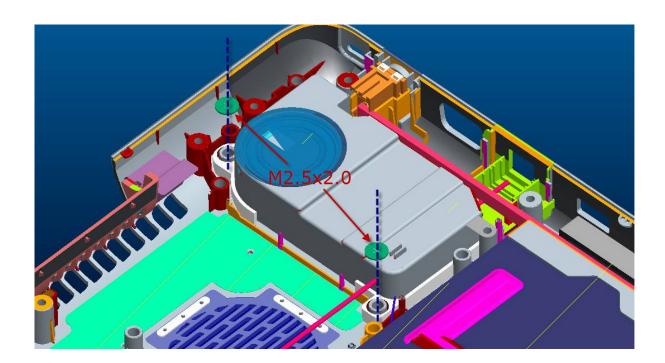


Figure 4-22-2 Removing the securing screws at right side.

## 2. Removing the Speaker Box.

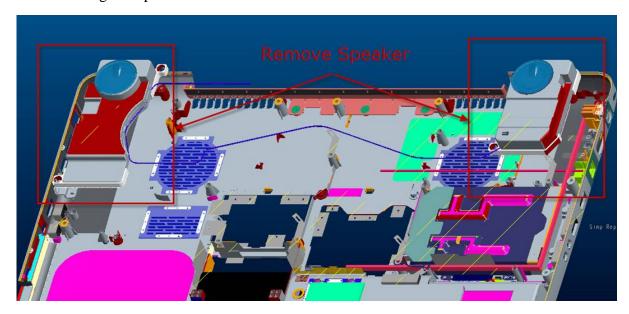


Figure 4-22-3 Removing the Speaker Box.

## **Installing Speaker Box**

The following describes the procedure for installing Speaker Box.

- 1. Installing the Speaker Box.
- 2. Securing Speaker Box of following **screws**.
  - M2.5×2.0 screw x 4

- 4.23 Application for Thermal pad and grease on CPU, North Bridge, and VGA board (see Figure 4-22-1 to 4-22-3)
- I. For Silvis thermal pad on North Bridge and grease on CPU

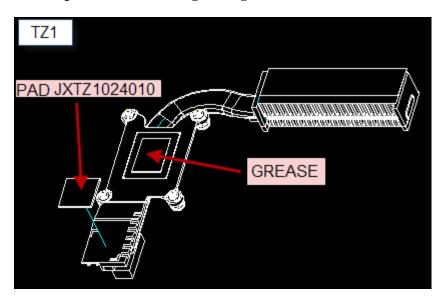


Figure 4-23-1 Intel &AMD Thermal pad on North Bridge

RAW PN	TSB PN	Vendor Description			
JXTZ1024010	A000048640	THERMAL PAD INT NB BS TZ1(JXTZ1024,3A)			
XY0GFCM1000	A000018440	THERMAL GREASE GFC-M1			

#### II. Use grease and Thermal pad on VGA

1. 0.15cc for one repair.

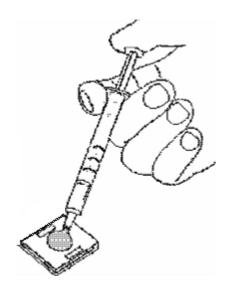


Figure 4-23-2 Apply silicon grease for North Bridge

2. Thermal pad and grease used on VGA thermal module.

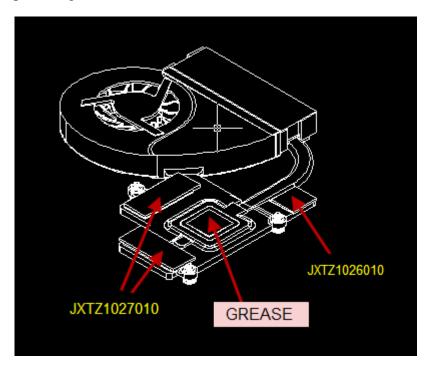


Figure 4-22-3 Thermal pad position

RAW PN	TSB PN	Vendor Description
JXTZ1027010	A000048650	THERMAL PAD VGA V-RAM AD(JXTZ1027,3A)
JXTZ1026010	A000048660	THERMAL PAD VGA CHOKE AD(JXTZ1026,3A)
XY0GFCM1000	A000018440	THERMAL GREASE GFC-M1

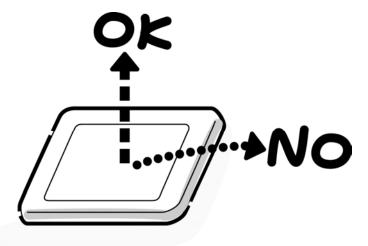
**NOTE:** Thermal pad is fixed for each one, no need special applicator and can re-use.

## Appendix A Handling the LCD Module

## **Precautions for handling the LCD module**

The LCD module can be easily damaged during assembly or disassembly. Observe the following precautions when handling the LCD module:

1. When installing the LCD module in the LCD cover, be sure to seat it so that it is properly aligned and maximum visibility of the display is maintained.



2. Be careful to align the holes at the four corners of the LCD module with the corresponding holes in the LCD cover before securing the module with screws. Do not force the module into place, because stress can affect its performance.

Also, the panel's polarized surface is easily scarred, so be careful when handling it.





3. If the panel's surface gets fingerprint or dust, put on gloves and wipe it with static electricity cloth. If it is still dirty, drop some cleaning alcohol on the surface and wipe it again

If the surface is much more fingerprint or dust, we recommend a CRT cleaning agent. Apply the agent to a cloth and then wipe the panel's surface. Do not apply cleanser directly to the panel.

If dust still exists, please use ionic FAN which can avoid static electricity to deal with it.



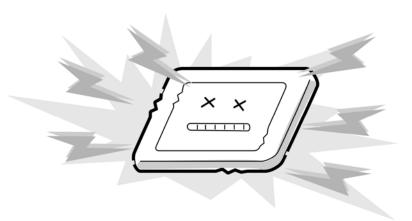
4. If water or other liquid is left on the panel's surface for a long period, it can change the screen's tint or stain it. Be sure to quickly wipe off any liquid with cloth or ionic FAN



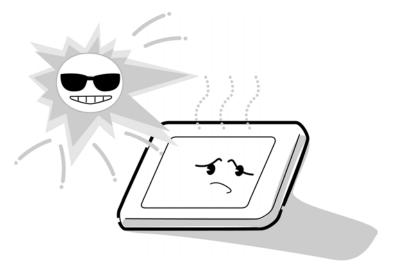
5. Glass is used in the panel, so be careful not to drop it or let it strike a hard object, which could cause breakage or cracks.



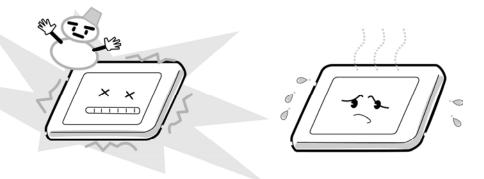
6. CMOS-LSI circuits are used in the module, so guard against damage from electrostatic discharge. Be sure to wear a wrist or ankle ground when handling the module.



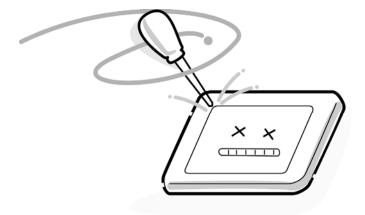
7. Do not expose the module to direct sunlight or strong ultraviolet rays for long periods.



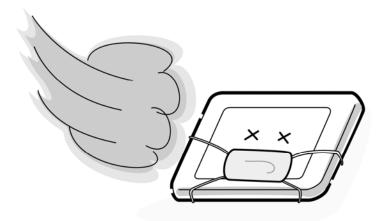
8. Do not store the module at temperatures below specifications. Cold can cause the liquid crystals to freeze, lose their elasticity or otherwise suffer damage.



9. Do not disassemble the LCD module. Disassembly can cause malfunctions.



10. If you transport the module, do not use packing material that contains epoxy resin (amine) or silicon glue (alcohol or oxide). These materials can release gas that can damage the panel's polarization.



# Appendix B Board Layout

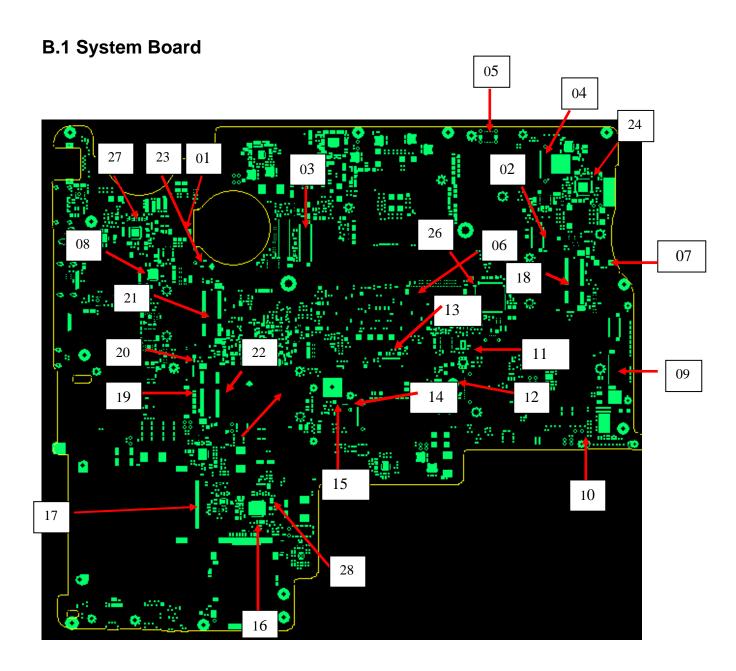


Figure B-1-1 System board layout (front)

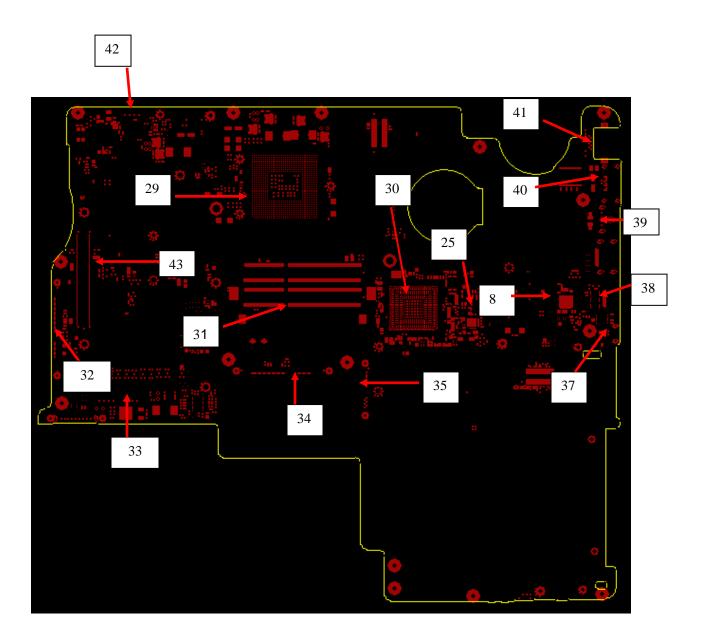


Figure B-1-2 System board layout (Back)

Table B-1-1 System board ICs and connectors

NUM	Location	Function
(01)	CN6	SPDIF CONN
(02)	CN10	Audio&USB CONN
(03)	CN11	LVDS CONN
(04)	CN2	CRT CONN
(05)	CN1	MDC CONN
(06)	CN16	KB CONN
(07)	CN14	FAN CONN
(80)	U50	HDMI IC
(09)	CN22	TMA CONN
(10)	CN48	BATT CONN
(11)	CN20	K/B LED power CONN
(12)	CN25	LED/B CONN
(13)	CN21	TP&FP/B CONN
(14)	CN31	BCAS CONN
(15)	CN29	Felica CONN
(16)	CN33	Cardreader CONN
(17)	CN32	New Card CONN
(18)	CN15	WiFi CONN
(19)	CN27	Bluetooth CONN
(20)	CN24	MMB CONN
(21)	CN17	WUSB CONN
(22)	CN26	TV Tuner CONN

(23)	CN13	Power/B CONN
(24)	U2	Audio IC
(25)	U13	Clock generator
(26)	U4	Embedded Controller IC
(27)	U9	LAN IC
(28)	U27	Card Reader /1394
(29)	U35	CPU
(30)	U47	North Bridge
(31)	CN31	DDR CONN
(32)	CN32	2nd SATA HDD CONN
(33)	PCN1	DC IN CONN
(34)	CN46	Main SATA HDD CONN
(35)	CN47	SATA ODD CONN
(37)	CN44	1394 CONN
(38)	CN41	HDMI CONN
(39)	CN37	USB CONN
(40)	CN36	ESATA CONN
(41)	CN35	RJ45 CONN
(42)	PCN0	VGA Power CONN
(43)	CN39	VGA CONN

## **B.2 Touch Pad Board**

## <Front layout>

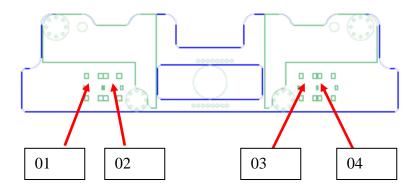


Figure B-2-1 Touch Pad board layout (Front)

Table B-2-2 Touch Pad board connectors

NUM	Location	Function
(01)	SW1	Mouse Button Left key
(02)	SW3	Mouse Button Left key
(03)	SW4	Mouse Button Right key
(04)	SW2	Mouse Button Right key

## <Back layout>

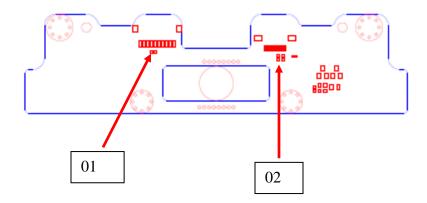


Figure B-2-3 Touch Pad board layout (Back)

Table B-2-2 Touch Pad board connectors

NUM	Location	Function
(01)	CN3	TP Board to TP Module CONN
(02)	CN1	TP Board to M/B CONN

## **B.3 Finger Print Board**

## <Front layout>

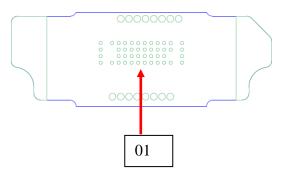


Figure B-3-1 Finger Print Board layout (Front)

Table B-3-2 Finger Print Board connectors

	Location	Function
(01)	U2	Finger Printer IC

## <Back layout>

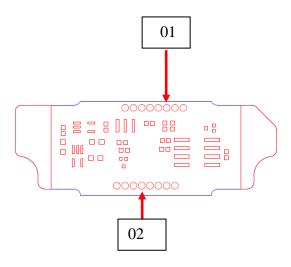


Figure B-3-3 Finger Print Board layout (Back)

Table B-3-4 Finger Print Board connectors

	Location	Function
(01)	CN2	Finger Print Board to TP Board connector
(02)	CN3	Finger Print Board to TP Board connector

## Appendix C Pin Assignment

#### **CN11 LCD Panel Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	VIN		2	LCDVCC	
3	VIN		4	LCDVCC	
5	VIN		6	LCD-EDIDDATA	I/O
7	+3V		8	LCD_EDIDCLK	I/O
9	CCD _POWER		10	LVDS_VADG	I/O
11	MIC_GND		12	GND	
13	INT_MIC_R	I/O	14	USBP3+_LCD	I/O
15	DISPON		16	USBP3LCD	I/O
17	GND		18	GND	
19	LCD_TXLCLKOUT+	I/O	20	LCD_TXUCLKOUT+	I/O
21	LCD_TXLCLKOUT-	I/O	22	LCD_TXUCLKOUT-	I/O
23	GND		24	GND	
25	LCD_TXLOUT0+	I/O	26	LCD_TXUOUT0+	I/O
27	LCD_TXLOUT0-	I/O	28	LCD_TXUOUT0-	I/O
29	GND		30	GND	
31	LCD_TXLOUT1+	I/O	32	LCD_TXUOUT1+	I/O
33	LCD_TXLOUT1-	I/O	34	LCD_TXUOUT1-	I/O
35	GND		36	GND	
37	LCD_TXLOUT2+	I/O	38	LCD_TXUOUT2+	I/O
39	LCD_TXLOUT2-	I/O	40	LCD_TXUOUT2-	I/O
41	GND		42	GND	

<sup>1</sup> Qosmio X500 Maintenance Manual (960-Q08)

#### **CN24 MMB Connector**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	+3VPCU		2	+5VPCU	
3	KEY_INT	I	4	GND	
5	3ND_MBDATA	I/O	6	3ND_MBCLK	I/O

#### **CN20 Keyboard LED Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	+5V		2	BOARD_DI5	0
3	KB_LED_DET#		4	KB_LED	Ι

#### **CN13 Power Board Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	+5VPCU	Ι	2	NBSWON#	Ι
3	PWRLED#	I	4	GND	

#### **CN16 Keyboard Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	K_LED_P		2	MY16	0
3			4	MX17	O
5			6	K_LED_P	

7	MY2	0	8	MY1	О
9	MY0	0	10	MY4	0
11	MY3	О	12	MY5	О
13	MY14	О	14	MY6	О
15	MY7_K	О	16	MY3_K	О
17	MY7	О	18	MY9	О
19	MY10	О	20	MY11	О
21	MY12	О	22	MY15	О
23	MX7	О	24	MX2	О
25	MX3	О	26	MX4	О
27	MX0	О	28	MX5	О
29	MX6	О	30	MX1	О
31	K_LED_P	0	32	CAPSLED	О
33	FN_F10	О	34	NUMLED	О

## **CN21 Touchpad & Fingerprint Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	+5V TP		2	TPDATA	I/O
3	TPCLK	I/O	4	LED_ON#	I/O
5	GND		6	USBP1+	I/O
7	USBP1-	I/O	8	GND	
9	TP_ON_OFF	0	10	+3V	

**CN18 Felica Connectors** 

<sup>&</sup>lt;sup>3</sup> Qosmio X500 Maintenance Manual (960-Q08)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	+5V_Felica		2	USBP4-	I/O
3	USBP4+	I/O	4	GND	
5	NC		6	NC	

#### CN10 Audio&USB Board Connectors

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	USBP11-	I	2	USBP10-	I
3	USBP11+	I	4	USBP10+	Ι
5	USB_EN#2	I/O	6	USBOC#_10_11	0
7	+5VPCU		8	+5VPCU	
9	+5VPCU		10	+5VPCU	
11	+3V		12	HP_JD	Ι
13	Port_B#	0	14	SPDIF/BEEPGAIN#	I
15	GND		16	GND	
17	HPR	0	18	MIC1-R	0
19	HPL	0	20	MIC1-L	0
21	GND	0	22	GND	

#### **CN32 New Card Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O

1	GND		2	USBP9-	I
3	USBP9+	I	4	CPUSB#	I/O
5			6		
7	NEW SMCLK	I	8	NEW SMDATA	I/O
9	+NEW_1.5V	I	10	+NEW_1.5V	I
11	PCIE_WAKE#	I	12	+NEW_3VAUX	О
13	PERST#	I/O	14	+NEW_3V	I
15	+NEW_3V	I	16	NEW_CLKREQ#	О
17	CPPE#_	I/O	18	CLK_PCIE_NEW#	I
19	CLK_PCIE_NEW	I	20	GND	
21	PCIE_RXP2	О	22	PCIE_RXP2	О
23	GND		24	PCIE_TXN2	I
25	PCIE_TXN2	I	26	GND	

#### **CN27 Blue Tooth Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND		2	USBP2+	I/O
3	USBP2-	I/O	4	WCS_CLK	
5	GND		6	BT_RESET	
7	WCS_DAT	О	8	+3V	
9	BT_EN	0	10	GND	

## **CN45 RTC Battery Connectors**

<sup>&</sup>lt;sup>5</sup> Qosmio X500 Maintenance Manual (960-Q08)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	RTC_NO2	I	2	GND	

#### **CN2 CRT Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	+5V		2	NC	
3	GND		4	CRT_R1	
5	GND		6	CRT_G1	
7	GND		8	CRT_B1	
9	GND		10	CRTHSYNC	
11	CRTVSYNC		12	GND	
13	CRTDCLK		14	CRTTDDAT	
15	GND				

#### **CN14 FAN Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	TH_FAN_POWER1		2	GND	
3	FANSIG1	0			

#### **CN48 Battery Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O

1	MBAT+		2	MBAT+	
3	ID	О	4	B/I	
5	TEMP_MBAT	О	6	MBDATA	I/O
7	MBCLK	I/O	8	GND	
9	GND		10	GND	
11	GND		12	GND	
13	GND				

#### **CN15 MINI PCI-E Card WLAN Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	WLAN_WAKE#	О	2	+3V	
3	WCS_DATR		4	GND	
5	WCS_CLKR		6	+1.5V	
7			8	LAD0_PCIE	I/O
9	GND		10	LAD1_PCIE	I/O
11	CLK_PCIEI_MINI#_	I	12	LAD2_PCIE	I/O
13	CLK_PCIEI_MINI	I	14	LAD3_PCIE	I/O
15	GND		16	LFRAME#_PCIE	I
17	NC		18	GND	
19	NC		20	RF_EN_WLAN	I
21	GND		22	PLTRST#	I
23	PCIE_RXN1	О	24	+3V_S5	
25	PCIE_RXP1	О	26	GND	
27	GND		28	+1.5V	
29	GND		30	WL_SMCLK	I/O

<sup>7</sup> Qosmio X500 Maintenance Manual (960-Q08)

31	PCIE_TXN0	Ι	32	WL_SMDATA	I/O
33	PCIE_TXP0	I	34	GND	
35	GND		36	USBP3B	I/O
37	GND		38	USBP3+_B	I/O
39	NC		40	NC	
41	NC		42	NC	
43	GND		44	LED_WLAN#	
45	CL_CLK1_MIN		46	LED_WPAN#	
47	CL DATA1 MIN		48	+1.5V	
49	CL_RST#1_MIN		50	GND	
51	SERIRQ_WLAN	О	52	+3V	

#### **CN26 TV Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND		2	GND	
3	TV-LUMA		4	TV-CHROMA	
5	GND		6	GND	

#### CN33 5 in 1 Card Reader Connectors

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	NC		2	+3.3V	
3	XBCCLK-P3P		4	GND	I/O
5	BCCDET-P3N	I/O	6	NC	I/O

7	NC	I/O	8	NC	
9	GND		10	NC	I
11	NC	I/O	12	NC	
13	NC	I/O	14	NC	I/O
15	GND		16	BCIO-P5P	I/O
17	BCRST-P3N	I/O	18	IVDET-P3P	
19	BCPWON-P3P	I/O	20	NC	I/O
21	GND		22	RESET#	I/O
23	NC	I/O	24	+3.3V	
25	NC	I/O	26	GND	I
27	GND		28	NC	
29	GND	I/O	30	USB D+	I
31	NC	I/O	32	USB D-	I
33	NC		34	GND	
35	GND	I/O	36	USB D-	I/O
37	GND	I/O	38	USB D+	I/O
39	+3.3V		40	GND	
41	+3.3V		42	NV	
43	GND	I/O	44	CPLGP1-P3P	I/O
45	NC	I/O	46	TMPTU1-SXP	I/O
47	TMPTU2-SXP		48	NC	
49	NC	I/O	50	GND	О
51	NC	I/O	52	+3.3V	I

## **CN31 DDR Connectors**

PI N No.	Signal name	I/O	PIN No.	Signal name	I/O
1	+0.9VSMDDR_VREF_ DIMM		2	GND	
3	GND		4	$M\_B\_DQ0$	I/O
5	$M_B_DQ5$	I/O	6	$M\_B\_DQ1$	I/O
7	$M\_B\_DQ4$	I/O	8	GND	
9	GND		10	$M\_B\_DM0$	I
11	$M_B_DQS\#0$	I/O	12	GND	
13	$M_B_DQS0$	I/O	14	$M\_B\_DQ7$	I/O
15	GND		16	$M\_B\_DQ6$	I/O
17	$M_B_DQ2$	I/O	18	GND	
19	$M_B_DQ3$	I/O	20	M_B_DQ12	I/O
21	GND		22	M_B_DQ13	I/O
23	$M\_B\_DQ8$	I/O	24	GND	
25	$M\_B\_DQ9$	I/O	26	$M\_B\_DM1$	I
27	GND		28	GND	
29	$M_B_DQS\#1$	I/O	30	M_CLK_DDR3	I
31	$M_B_DQS1$	I/O	32	M_CLK_DDR#3	I
33	GND		34	GND	
35	M_B_DQ14	I/O	36	M_B_DQ11	I/O
37	M_B_DQ15	I/O	38	M_B_DQ10	I/O
39	GND		40	GND	
41	GND		42	GND	
43	M_B_DQ20	I/O	44	M_B_DQ21	I/O
45	M_B_DQ17	I/O	46	M_B_DQ16	I/O
47	GND		48	GND	
49	M_B_DQS#2	I/O	50	PM_EXTTS#1	0

51	$M_B_DQS2$	I/O	52	<i>M_B_DM2</i>	I
53	GND		54	GND	
55	M_B_DQ23	I/O	56	M_B_DQ18	I/O
57	$M_B_DQ22$	I/O	58	M_B_DQ19	I/O
59	GND		60	GND	
61	M_B_DQ28	I/O	62	M_B_DQ24	I/O
63	M_B_DQ25	I/O	64	M_B_DQ29	I/O
65	GND		66	GND	
67	$M_B_DM3$	I	68	M_B_DQS#3	I/O
69	NC		70	$M_B_DQS3$	I/O
71	GND		72	GND	
73	M_B_DQ30	I/O	74	M_B_DQ26	I/O
75	M_B_DQ31	I/O	76	M_B_DQ27	I/O
77	GND		78	GND	
79	M_CKE3	I	80	M_CKE4	I
81	+1.8VSUS		82	+1.8VSUS	
83	NC		84	NC	
85	<i>M_B_BS#</i> 2	I	86	M_B_A14	
87	+1.8VSUS		88	+1.8VSUS	
89	M_B_A12	I/O	90	M_B_A11	I/O
91	M_B_A9	I/O	92	M_B_A7	I/O
93	$M\_B\_A8$	I/O	94	M_B_A6	I/O
95	+1.8VSUS		96	+1.8VSUS	
97	M_B_A5	I/O	8	$M\_B\_A4$	I/O
99	M_B_A3	I/O	100	$M\_B\_A2$	I/O
101	$M\_B\_A1$	I/O	102	$M\_B\_A0$	I/O

<sup>11</sup> Qosmio X500 Maintenance Manual (960-Q08)

103	+1.8VSUS		104		+1.8VSUS		
105	M_B_A10	I/O		106	M_B_BS#1		I
107	M_B_BS#0	I		108	M_B_RAS#		I
109	$M\_B\_WE\#$	I		110	M_CS#2		I
111	+1.8VSUS			112	+1.8VSUS		
113	M_B_CAS#	I		114	$M\_ODT2$		I
115	M_CS#3	I		116	M_B_A13	I/O	
117	+1.8VSUS			118	+1.8VSUS		
119	M_ODT3	I		120	NC		
121	GND			122	GND		
123	M_B_DQ32	I/O		124	M_B_DQ37	I/O	
125	M_B_DQ36	I/O		126	M_B_DQ38	I/O	
127	GND			128	GND		
129	<i>M_B_DQS#4</i>	I/O		130	$M\_B\_DM4$	I	
131	$M_B_DQS4$	I/O		132	GND		
133	GND			134	M_B_DQ39	I/O	
135	M_B_DQ35	I/O		136	M_B_DQ33	I/O	
137	M_B_DQ34	I/O		138	GND		
139	GND			140	M_B_DQ44	I/O	
141	M_B_DQ41	I/O		142	M_B_DQ45	I/O	
143	M_B_DQ40	I/O		144	GND		
145	GND			146	<i>M_B_DQS#5</i>	I/O	
147	<i>M_B_DM5</i>	I		148	$M_B_DQS5$	I/O	
149	GND			150	GND		
151	M_B_DQ43	I/O		152	M_B_DQ42	I/O	
153	M_B_DQ46	I/O	154		M_B_DQ47	I/O	

155	$\mathit{GND}$		156	GND	
157	M_B_DQ52	I/O	158	M_B_DQ53	I/O
159	M_B_DQ49	I/O	160	M_B_DQ48	I/O
161	GND		162	GND	
163	NC		164	M_CLK_DDR4	I
165	GND		166	M_CLK_DDR#4	I
167	$M_B_DQS\#6$	I/O	168	GND	
169	$M_B_DQS6$	I/O	170	M_B_DM6	I
171	GND		172	GND	
173	M_B_DQ55	I/O	174	M_B_DQ51	I/O
175	M_B_DQ50	I/O	176	M_B_DQ54	I/O
177	GND		178	GND	
179	M_B_DQ56	I/O	180	M_B_DQ60	I/O
181	M_B_DQ57	I/O	182	M_B_DQ61	I/O
183	GND		184	GND	
185	$M\_B\_DM7$	I	186	M_B_DQS#7	I/O
187	GND		188	$M_B_DQS7$	I/O
189	M_B_DQ59	I/O	190	GND	
191	M_B_DQ63	I/O	192	M_B_DQ62	I/O
193	GND		194	M_B_DQ59	I/O
195	$DDRDAT\_SMB$	I/O	196	GND	
197	DDRCLK_SMB	I/O	198	SA0	
199	+3V		200	SA1	

### **CN41 HDMI Connectors**

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PIN No.	Signal name	I/O	PIN No.	Signal name	I/ O
					Ů
1	HDMITX2P_C		2	GND	
3	HDMITX2N_ C		4	HDMITX1P_C	
5	GND		6	HDMITX1N_C	
7	HDMITX0P_C		8	GND	
9	HDMITXON_C	I/O	10	HDMICLK+C	
11	GND		12	HDMICLK-C	
13	CEC		14		
15	HDMI DDCCLK C	I/O	16	HAMI DDCDATA C	
17	GND		18	DDC5V	
19	HDMI HP		20	GND	
21	GND		22	GND	
23	GND				

### **CN47 ODD Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/ O
1	GND		2	SATA_TXP4	
3	SATA_TXN4		4	GND	
5	SATA_RXN4		6	SATA_RXP4	
7	GND		8	GND	
9	+5V_ODD	I/O	10	+5V_ODD	
11	NC		12	GND	
13	GND		14	GND	
15	GND	I/O			

### **CN39 VGA Connectors**

PIN No.	Signal name	PIN No.	Signal name
2	PEG_TXN15	1	PEG_RXN15
4	PEG_TXP15	3	PEG_RXP15
6	GND	5	GND
8	PEG_TXN14	7	PEG_RXN14
10	PEG_TXP14	9	PEG_RXP14
12	GND	11	GND
14	PEG_TXN13	13	PEG_RXN13
16	PEG_TXP13	15	PEG_RXP13
18	GND	17	GND
20	PEG_TXN12	19	PEG_RXN12
22	PEG_TXP12	21	PEG_RXP12
24	GND	23	GND
26	PEG_TXN11	25	PEG_RXN11
28	PEG_TXP11	27	PEG_RXP11
30	GND	29	GND
32	PEG_TXN10	31	PEG_RXN10
34	PEG_TXP10	33	PEG_RXP10
36	GND	35	GND
38	PEG_TXN9	37	PEG_RXN9
40	PEG_TXP9	39	PEG_RXP9
42	GND	41	GND
44	PEG_TXN8	43	PEG_RXN8
46	PEG_TXP8	45	PEG_RXP8
48	GND	47	GND
50	PEG_TXN7	49	PEG_RXN7
52	PEG_TXP7	51	PEG_RXP7
54	GND	53	GND
56	PEG_TXN6	55	PEG_RXN6
58	PEG_TXP6	57	PEG_RXP6

60	GND	59	GND
62	PEG_TXN5	61	PEG_RXN5
64	PEG_TXP5	63	PEG_RXP5
66	GND	65	GND
68	PEG_TXN4	67	PEG_RXN4
70	PEG_TXP4	69	PEG_RXP4
72	GND	71	GND
74	PEG_TXN3	73	PEG_RXN3
76	PEG_TXP3	75	PEG_RXP3
78	GND	77	GND
80	PEG_TXN2	79	PEG_RXN2
82	PEG_TXP2	81	PEG_RXP2
84	GND	83	GND
86	PEG_TXN1	85	PEG_RXN1
88	PEG_TXP1	87	PEG_RXP1
90	GND	89	GND
92	PEG_TXN0	91	PEG_RXN0
94	PEG_TXP0	93	PEG_RXP0
96	GND	95	GND
98	EXT_CRT_DDCCL K	97	MXM_REFCLKN
100	EXT_CRT_DDCD AT	99	MXM_REFCLKP
102	GND	101	GND
104	EXT_HDMI_DDCC LK	103	PLTRST#
106	EXT_HDMI_DDCD AT	105	SYSFANON#
108	GND	107	MAINON
110	EXT_LVDS_PNLC LK	109	GFXPG
11	2 EXT_LVDS_PNLC	) 11	1 VGA_MBDATA

	AT		
114	GND	113	VGA_MBCLK
116	EXT_VGA_RED	115	EXT_LVDS_BLON
118	GND	117	EXT_DISP_ON
120	EXT_VGA_GRN	119	DP_HPD
122	GND	121	GND
124	EXT_VGA_BLU	123	EXT_HSYNC
126	GND	125	EXT_VSYNC
128	EXT_LVDS_TXL# 2	127	GND
130	EXT_LVDS_TXL2	129	EXT_LVDS_TXU# 2
132	GND	131	EXT_LVDS_TXU2
134	EXT_LVDS_TXL# 1	133	GND
136	EXT_LVDS_TXL1	135	EXT_LVDS_TXU#
138	GND	137	EXT_LVDS_TXU1
140	EXT_LVDS_TXL# 0	139	GND
142	EXT_LVDS_TXL0	141	EXT_LVDS_TXU#
144	GND	143	EXT_LVDS_TXU0
146	EXT_LVDS_TXLC K#	145	GND
148	EXT_LVDS_TXLC K	147	EXT_LVDS_TXUC K#
150	GND	149	EXT_LVDS_TXUC K
152	X	151	GND
154	X	153	X
156	X	155	X

158	5V	157	X
160	5V	159	3V
162	X	161	3V
164	X	163	3V
166	DP_CAD	165	3V
168	CEC	167	3V
170	GND	169	X
172	EXT_DPTX3N	171	X
174	EXT_DPTX3P	173	DVI_HPD
176	GND	175	GND
178	EXT_DPTX2N	177	EXT_HDMICLK-
180	EXT_DPTX2P	179	EXT_HDMICLK+
182	GND	181	GND
184	EXT_DPTX1N	183	EXT_HDMITX2N
186	EXT_DPTX1P	185	EXT_HDMITX2P
188	GND	187	GND
190	EXT_DPTX0N	189	EXT_HDMITX1N
192	EXT_DPTX0P	191	EXT_HDMITX1P
194	GND	193	GND
196	DP_AUX1P	195	EXT_HDMITX0N
198	DP_AUX1N	197	EXT_HDMITX0P
200	GND	199	GND

### **CN35 LAN Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	X-TX0P		2	X-TXON	
3	X-TX1P		4	X-TX2P	
5	X-TX2N		6	X-TX1N	
7	X-TX3P		8	X-TX3N	

9	LAN_VCC4	 10	LAN _ LINKLED#	
11	LAN _ ACTLED	 12	LAN _ GND	

### **CN37 USB Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND		2	BUSBP6+	
3	BUSBP6-		4	USBPWR2	
5	GND		6	GND	
7	GND		8	GND	

### **CN32 2nd SATA HDD Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND		2	SATA_TXP1	0
3	SATA_TXN1	0	4	GND	
5	SATA_RXN1	I	6	SATA_RXP1	I
7	GND		8	+3.3VSATA	
9	+3.3VSATA		10	+3.3VSATA	
11	GND		12	GND	
13	GND		14	+5V	
15	+5V		16	+5V	
17	GND		18		
19	GND		20		
21			22		
23	GND		24	GND	

**CN33 5 in 1 Card Reader Connectors** 

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND		2	XD_CD#C	О
3	XD_R/B#_C	I	4	XD_RE#_C	I/O
5	XD_CE#C	I	6	CD_CLE_C	O
7	XD_ALE_C	I	8	XD_WE# _C	I
9	SD_D2_C	I/O	10	XD_WPO# _C	
11	GND		12	SD_D3_C	
13	VCC_XD		14	SD/MS_CLK_C	
15	SD_CMD_C	I	16	MS_D3/XD_D0_C	I/O
17	GND		18	MS_CD#_C	
19	GND		20	MS_DX/SD_D1_C	I/O
21	VCC_XD		22	MS_D0/ XD_D2_C	I/O
23	MS_D3/XD_D0_C	I/O	24	MS_D1/XD_D7_C	I/O
25	SD_MS_CLK_C	I/O	26	MS_BS/XD_D3_C	I
27	GND		28	GND	
29	MS_D2/XD_D1_C	I/O	30	SD_D0_C	I/O
31	MS_D0/XD_D2_C	I/O	32	SD_D1_C	I/O
33	MS_BS/XD_D3_C	I/O	34	XD_D4_C	I/O
35	XD_D5_C	I/O	36	XD_D6_C	I/O
37	MS_D1/XD_D7_C	I/O	38	VCC_XD	
39	SD_CD#C	I/O	40	GND	
41	SM_WPI#/SD_WP_C	I	42	GND	
43	GND				

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### **CN46 SATA HDD Connectors**

PIN No.	Signal name I/O PIN		PIN No.	Signal name	I/O
1	GND		2	SATA_TXP0	О
3	SATA_TXN0	О	4	GND	
5	SATA_RXN0	I	6	SATA_RXP0	I
7	GND		8	+3.3VSATA	
9	+3.3VSATA		10	+3.3VSATA	
11	GND		12	GND	
13	GND		14	+5V	
15	+5V		16	+5V	
17	GND		18		
19	GND		20		
21			22		
23	GND		24	GND	

### **CN22 TMA Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND		2	PCIE_TXP3	
3	PCIE_TXN3		4	GND	
5	PCIE_RXP3		6	PCIE_RXN3	
7	GND		8	CLK_PCIE_MINI3_TMA	
9	CLK_PCIE_MINI3#_TMA		10	GND	

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11	TMPSPR-GND	12	TMPSPR-SXP	
13	CLKDWN#	14	ALERT	
15	PLTRST#	16	CLKREQ#	
17	NC	18	NC	
19	+3V_TMA_VDD	20	+3V_TMA_VDD	
21	NC	22	NC	
23	NC	24	GND	
25	GND	26	GND	
27	GND	28	GND	
29	GND	29	GND	
31	GND	30	GND	

### **CN17 Mini Card Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	WAKE#	О	2	+3V	
3	BT_DATA		4	GND	
5	BT_CHCLK		6	+1.5V	
7			8	NC	
9	GND		10	NC	
11	CLK_PCIE_ MINI3#	I	12	NC	
13	CLK_PCIE_ MINI3	I	14	NC	
15	GND		16	NC	
17	NC		18	GND	
19	NC		20	RF_EN_WLAN	I
21	GND		22	PLTRST#	I

23	PCIE_RXN5	О	24	+3V_S5	
25	PCIE_RXP5	О	26	GND	
27	GND		28	+1.5V	
29	GND		30	MINI3_SMCLK	I/O
31	PCIE_TXN5	I	32	MINI3_SMDATA	I/O
33	PCIE_TXP5	I	34	GND	
35	GND		36	USBD-	I/O
37	GND		38	USBD+	I/O
39			40	NC	
41			42		
43	GND		44		
45	C_LINK_CLK		46		
47	C_LINK_DAT		48	+1.5V	
49	C_LINK_RST		50	GND	
51	NC		52	+3V	

### CN47 1394 Port

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	L1394_TPB0-	O	2	L1394_TPB0+	O
3	L1394_TPA0-	O	4	L1394_TPA0+	O
5	GND		6	GND	

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### **CN6 SPDIF Connectors**

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND		2	BOARD_ID2	
3	SPK_L-		4	SPK_L+	
5	SPK_R-		6	SPK_R+	

# Appendix D Display Codes

## D.1 Display Codes

*Table D-1-1 Scan codes (set 1 and set 2) (1/4)* 

Сар	Keytop	Code	set 1	C	ode set 2	2	Note
No.	Reylop	Make	Break	Make	Bre	ak	Note
01	· ~	29	A9	0E	F0	0E	
02	1 !	02	82	16	F0	16	
03	2 @	03	83	1E	F0	1E	
04	3 #	04	84	26	F0	26	
05	4 \$	05	85	25	F0	25	
06	5 %	06	86	2E	F0	2E	
07	6 ^	07	87	36	F0	36	
08	7 &	08	88	3D	F0	3D	*2
09	8 *	09	89	3E	F0	3E	*2
10	9 (	0A	8A	46	F0	46	*2
11	0 )	0B	8B	45	F0	45	
12		0C	8C	4E	F0	4E	
13	= +	0D	8D	55	F0	55	
15	BkSp	0E	8E	66	F0	66	
16	Tab	0F	8F	0D	F0	0D	
17	Q	10	90	15	F0	15	
18	W	11	91	1D	F0	1D	
19	Е	12	92	24	F0	24	
20	R	13	93	2D	F0	2D	
21	Т	14	94	2C	F0	2C	
22	Υ	15	95	35	F0	35	
23	U	16	96	3C	F0	3C	*2
24	I	17	97	43	F0	43	*2
25	0	13	98	44	F0	44	*2
26	Р	19	99	4D	F0	4D	*2
27	} ]	1A	9A	54	F0	54	
28	] }	1B	9B	5B	F0	5B	

*Table D-1-2 Scan codes (set 1 and set 2) (2/4)* 

Сар	Kautan	Code	set 1	C	ode set 2	2	Note
No.	Keytop	Make	Break	Make	Bre	ak	Note
29	\	2B	AB	5D	F0	5D	*5
30	Caps Lock	3A	ВА	58	F0	58	
31	Α	1E	9E	1C	F0	1C	
32	S	1F	9F	1B	F0	1B	
33	D	20	A0	23	F0	23	
34	F	21	A1	2B	F0	2B	
35	G	22	A2	34	F0	34	
36	Н	23	А3	33	F0	33	
37	J	24	A4	3B	F0	3B	*2
38	K	25	A5	42	F0	42	*2
39	L	26	A6	4B	F0	4B	*2
40	; :	27	A7	4C	F0	4C	*2
41		28	A8	52	F0	52	
43	Enter	1C	9C	5A	F0	5A	*3
44	Shift (L)	2A	AA	12	F0	12	
45	No.102 key	56	D6	61	F0	61	
46	Z	2C	AC	1A	F0	1A	
47	Х	2D	AD	22	F0	22	
48	С	2E	AE	21	F0	21	
49	V	2F	AF	2A	F0	2A	
50	В	30	В0	32	F0	32	
51	N	31	B1	31	F0	31	
52	М	32	B2	3A	F0	ЗА	*2
53	, <	33	В3	41	F0	41	*2
54	. >	34	B4	49	F0	49	*2
55	/ ?	35	B5	4A	F0	4A	*2
57	Shift (R)	36	В6	59	F0	59	

Table D-1-3 Scan codes (set 1 and set 2) (3/4)

Сар	Kautan		Code	set 1			C	ode s	et 2		Note
No.	Keytop	Ma	ake	Br	eak	Ma	ake		Brea	k	Note
58	Ctrl	1	D	g	)D	14		F0		14	*3
60	Alt (L)		38		38		11	FC		11	*3
61	Space		39		39		29	FC		29	
62	ALT (R)	E0	38	E0	B8	E0	11	E0	F0	11	
75	Ins	E0	52	E0	D2	E0	70	E0	F0	70	*1
76	Del	E0	53	E0	D3	E0	71	E0	F0	71	*1
79	<b>←</b>	E0	4B	E0	СВ	E0	6B	E0	F0	6B	*1
80	Home	E0	47	E0	C7	E0	6C	E0	F0	6C	*1
81	End	E0	4F	E0	CF	E0	69	E0	F0	69	*1
83	<b>↑</b>	E0	48	E0	C8	E0	75	E0	F0	75	*1
84	<b>\</b>	E0	50	E0	D0	E0	72	E0	F0	72	*1
85		E0	49	E0	C9	E0	7D	E0	F0	7D	*1
86	PgDn	E0	49 51	E0	D1	E0	7D 7A	E0	F0	7D 7A	*1
00	Руын		31		וט		7.4	E0	го	/A	'
89	$\rightarrow$	E0	4D	E0	CD	E0	74	E0	F0	74	*1
110	Esc		01		81		76	F0		76	
112	F1	;	3B	1	ВВ		05	F0		05	
113	F2	;	3C	ı	вс		06	F0		06	
114	F3	;	3D	I	BD		04	F0		04	
115	F4	:	3E		BE	(	0C	F0		0C	
116	F5		3F		BF		03	F0		03	
117	F6		40		C0		0B	F0		0B	
118	F7		41		C1		83	F0		83	
119	F8		42		C2		0A	F0		0A	
120	F9		43		C3		01	F0		01	
121	F10		44		C4		09	F0		09	*3

Table D-1-4 Scan codes (set 1 and set 2) (4/4)

Сар	Kouton	Co	Code set 1			C	odes	set 2		Note
No.	Keytop	Make Break		Ma	ake	Break			Note	
122	F11	57	D7	,	78		F0	78	1	*3
123	F12	58	D8	3	07		F0	07	•	*3
124	PrintSc	*6	*6		*6		*6			*6
126	Pause	*7	*7		*7		*7			*7
202	Fn	_	_		_		_			*4
203	Win	E0 5	B EC	DB	E0	1F	E0	F0	1F	
204	Арр	E0 5	) Ed	DD DD	E0	2F	E0	F0	2F	

#### **Notes:**

- 1. \* Scan codes differ by mode.
- 2. \* Scan codes differ by overlay function.
- 3. \* Combined with the **Fn** key makes different codes.
- 4. \* **Fn** key does not generate a code by itself.
- 5. \* This key corresponds to key No. 42 in a 102-key model.
- 6. \* Refer to Table D-6, No. 124 key scan code.
- 7. \* Refer to Table D-7, No. 126 key scan code.

Table D-1-5 Scan codes with left Shift key

Сар	Key			C	Code	set '	1			Code set 2									
No.	top	Make				Break				Make					Break				
55	/	E0	AA	E0	35	E0	B5	E0	2A	E0	F0	12	E0	4A	E0	F0	4A	E0	12
75	INS	E0	AA	E0	52	E0	D2	E0	2A	E0	F0	12	E0	70	E0	F0	70	E0	12
76	DEL	E0	AA	E0	53	E0	D3	E0	2A	E0	F0	12	E0	71	E0	F0	71	E0	12
79	←	E0	AA	E0	4B	E0	СВ	E0	2A	E0	F0	12	E0	6B	E0	F0	6B	E0	12
80	Home	E0	AA	E0	47	E0	C7	E0	2A	E0	F0	12	E0	6C	E0	F0	6C	E0	12
81	End	E0	AA	E0	4F	E0	CF	E0	2A	E0	F0	12	E0	69	E0	F0	69	E0	12
83	<b>↑</b>	E0	AA	E0	48	E0	C8	E0	2A	E0	F0	12	E0	75	E0	F0	75	E0	12
84	$\downarrow$	E0	AA	E0	50	E0	D0	E0	2A	E0	F0	12	E0	72	E0	F0	72	E0	12
85	PgUp	E0	AA	E0	49	E0	C9	E0	2A	E0	F0	12	E0	7D	E0	F0	7D	E0	12
86	PgDn	E0	AA	E0	51	E0	D1	E0	2A	E0	F0	12	E0	7A	E0	F0	7A	E0	12
89	$\rightarrow$	ΕO	AA	E0	4D	E0	CD	E0	2A	E0	F0	12	E0	74	E0	F0	74	E0	12
203	Win	E0	AA	E0	5B	E0	DB	E0	2A	E0	F0	12	E0	1F	E0	F0	1F	E0	12
204	Арр	ΕO	AA	E0	5D	ΕO	DD	E0	2A	E0	F0	12	E0	2F	E0	F0	2F	E0	12

**Note:** The table above shows scan codes with the left **Shift** key. In combination with the right **Shift** key, scan codes are changed as listed below:

	With left <b>Shift</b>	With right <b>Shift</b>
Set 1	E0 AA	E0 B6
	E0 2A	E0 36
Set 2	E0 F0 12	E0 F0 59
	E0 12	E0 59

Table D-1-6 Scan codes in Numlock mode

Сар	Key		Code set 1									Code set 2									
No.	top	Make				Break					Ma	ake		Break							
75	INS	E0	2A	E0	52	E0	D2	E0	AA	E0	12	E0	70	E0	F0	70	E0	F0	12		
76	DEL	E0	2A	E0	53	E0	D3	E0	AA	E0	12	E0	71	E0	F0	71	E0	F0	12		
79	←	E0	2A	E0	4B	E0	СВ	E0	AA	E0	12	E0	6B	E0	F0	6B	E0	F0	12		
80	Home	E0	2A	E0	47	E0	C7	E0	AA	E0	12	E0	6C	E0	F0	6C	E0	F0	12		
81	End	E0	2A	E0	4F	E0	CF	E0	AA	E0	12	E0	69	E0	F0	69	E0	F0	12		
83	$\uparrow$	E0	2A	E0	48	E0	C8	E0	AA	E0	12	E0	75	E0	F0	75	E0	F0	12		
84	$\downarrow$	E0	2A	E0	50	E0	D0	E0	AA	E0	12	E0	72	E0	F0	72	E0	F0	12		
85	PgUp	E0	2A	E0	49	E0	C9	E0	AA	E0	12	E0	7D	E0	F0	7D	E0	F0	12		
86	PgDn	E0	2A	E0	51	E0	D1	E0	AA	E0	12	E0	7A	E0	F0	7A	E0	F0	12		
89	$\rightarrow$	E0	2A	E0	4D	E0	CD	E0	AA	E0	12	E0	74	E0	F0	74	E0	F0	12		
203	Win	E0	2A	E0	5B	E0	DB	E0	AA	E0	12	E0	1F	E0	F0	1F	E0	F0	12		
204	Арр	E0	2A	E0	5D	E0	DD	E0	AA	E0	12	E0	2F	E0	F0	2F	E0	F0	12		

Table D-1-7 Scan codes with Fn key

Сар			Code	set 1		Code set 2							
No.	Keytop	N	lake	В	reak	М	ake	Break					
43	ENT	E0 1C		E0	9C	E0	5A	E0	F0	5A			
58	CTRL	E0	E0 1D		9D	E0	14	E0	F0	14			
60	LALT	E0	38	E0	B8	E0	11	E0	F0	11			
121	ARROW		45		C5		77		) 7	77			
122	NUMERIC	45		C5		77		F	) 7	77			
123	Scrl		46	C5		7E		F	) 7	Έ			

Table D-1-8 Scan codes in overlay mode

Сар	Ko	ytop		Cod	e set 1			C	ode se	2		
No.	Ne	ytop	Ma	ake	Br	eak	Ma	ıke		Break		
09	8	(8)	4	18	C8		7	5	F0		75	
10	9	(9)	۷	19	C	C9		7D			7D	
11	0	(*)	3	37	Е	37	7	С	F0		7C	
23	U	(4)	4	ŀΒ	C	В	6	В	F0		6B	
24	I	(5)	4	4C		CC		73			73	
25	0	(6)	4	4D		CD		4	F0	F0		
26	Р	(–)	4	4A		CA		В	F0		7B	
37	J	(1)	2	ŀF	CF		6	9	F0		69	
38	K	(2)	5	50	D0		72		F0		72	
39	L	(3)	5	51	D1		7A		F0		7A	
40	;	(+)	4	4E		CE		79		F0		
52	М	(0)	5	52		D2		70			70	
54		(.)	5	53		D3		71			71	
55	/	(/)	E0	E0 35		E0 B5		4A	E0	F0	4A	

Table D-1-9 No.124 key scan code

Key	Shift	Code set 1									Code set 2								
top	Silit	Make			Break			Make				Break							
Prt Sc	Common	E0	2A	E0	37	E0	В7	E0	AA	E0	12	E0	7C	E0	F0	7C	E0	F0	12
	Ctrl +		E0	37			E0	В7			E0	7C			E0	F0	7C		
	Shift +		E0	37			E0	В7			E0	7C			E0	F0	7C		
	Alt +			54			D4					84			F0	B4			

Table D-1-10 No.126 key scan code

Key	Shift	Code set 1						Code set 2									
top				M	ake			Make									
Pause	Common*	E1	1D	45	E1	9D	C5	E1	14	77	E1	F0	14	F0	77		
	Ctrl*	E0	46	E0	C6			E0	7E	E0	F0	7E					

<sup>\*:</sup> This key generates only make codes.

### **Appendix E Key Layout**

### 1. United Status (US) Keyboard



Figure US keyboard

### 2. United Status (US) Keyboard (Backlight)



Figure US keyboard (Backlight)

### 3. United Kingdom (UK) Keyboard



Figure UK keyboard

### 3. United Kingdom (UK) Keyboard (Backlight)



Figure UK keyboard (Backlight)

## **Appendix F** Wiring Diagrams

## F.1 RGB Monitor ID Wraparound connector

(1) RED	RED	(1)
(2) GREEN———	GREEN	(2)
(3) BLUE	BLUE	(3)
(4) NC —	NC	(4)
(5) GND —	GND	(5)
(6) GND —	GND	(6)
(7) GND	GND	(7)
(8) GND	GND	(8)
(9) 5V	- 5V	(9)
(10) GND	GND	(10)
(11) NC	- NC	(11)
(12) SDA —	SDA	(12)
(13) HSYNC—	HSYNC	(13)
(14) VSYNC —	VSYNC	(14)
(15) SDL —	- SCL	(15)

Figure F-1-1 RGB Monitor ID Wraparound connector (15PIN to 15PIN)

### F.2 LAN Loopback Connector

```
(1) BIBAP '(TX+) (3) BIDBP (RX+)
(2) BIDAN (TX-) (4) BIDBN (RX-)
```

Figure F-2-1 LAN loopback connector